





Amphenol Aerospace

YOUR SOURCE FOR INTERCONNECT PRODUCTS

CONTACT US:

Amphenol Aerospace 40-60 Delaware Avenue Sidney, NY 13838-1395 Customer Service: Mon.-Friday 8 am - 5 pm

Phone: (800)678-0141 Fax: (607)563-5157

Online: www.amphenol-aerospace.com



ABOUT AMPHENOL AEROSPACE:

Amphenol Aerospace, a Division of Amphenol Corporation, is one of the largest manufacturers of interconnect products in the world for the Military, Commercial Aerospace and Industrial markets. Amphenol designs, manufactures and markets circular and rectangular, electronic, fiber optic, EMI/EMP filter, and a variety of special applications connectors and interconnect systems.

Our 675,000 square foot facility is nestled at the foothills of the Catskill Mountains in Sidney NY. The Amphenol complex houses state-of-the-art manufacturing technologies including CNC machining, die-casting, molding, impact and extruding, plating, screw machining and process controls. Our fully equipped material evaluation lab and engineering organization utilize the latest in computer aided design software and analysis tools, allowing us to design, test, and qualify advanced interconnect systems.

Amphenol's interconnect products are supplied to thousands of OEMs worldwide and are supported by our worldwide sales and engineering force, including the largest global network of electronic distributors.



Amphenol Aerospace, Amphenol Commercial Air and Amphenol Industrial Operations Main Facility in Sidney, N.Y. USA



Amphenol Canada Corp. (ACC) facility in Toronto, ON

Offers a comprehensive range of filtered and rectangular connector products for commercial, military and aerospace applications.



Amphenol Backplane Systems (ABS) facility in Nashua, NH

Houses the manufacturing, design and engineering of backplane systems.



Amphenol Printed Circuits, (APC) facility in Nashua, NH

Manufactures, designs and engineers flex circuit products and printed circuit boards.



Amphenol facility in Nogales, Mexico

Houses the manufacture of several industrial and aerospace product lines.



Amphenol Nexus Technologies in Stamford, CT

Designs and manufactures audio connectors for military, aviation, medical, telecommunications, auto racing, power boats & farm equipment.



Amphenol Borisch in Grand Rapids, MI

A full service electronics manufacturer specializing in defense contractors with wiring harnesses, circuit boards and other electrical hardware.



AMPHENOL AEROSPACE'S PHILOSOPHY

As a basic business philosophy, Amphenol Aerospace is dedicated to concentrating on those advanced and challenging market segments that demand an extraordinary level of supplier support and reaction. Our approach to implement this strategy is based on the following key principles:

FOCUS: Concentrate all resources on serving a limited number of tightly defined markets, and understanding the needs of those markets.

INNOVATION: Provide these markets new, creative solutions in both products and services.

RESPONSIVENESS: Identify and respond to the market and product needs more rapidly than any other supplier.

QUALITY ASSURANCE:

Amphenol Aerospace has been awarded both AS9100 - Revision B and ISO9001:2000 Quality Assurance Certifications.

Performance is the sum of these principles. It is the measure of how well we continually and consistently implement our basic strategy and key principles.



LRM (Line Keplace Staggered/|Hybrids - Fiber GEN-X Hi Speed/RF/

ceable Modules) ber Optics/| Options/ tF/Power | Accessories

Ruggedized VME 64x/ VITA 60, 66

HDB3 | HSB3 | Hi Speed

ndard | Hybrids - Signal/Power/ |

Coax/Fiber Optics

Brush

LMD/LMS Rectangular Interconnect



Board Level and Rectangular Interconnects Introduction

QUICK REFERENCE TO THIS CATALOG BY TECHNOLOGY

Introduction/ Pkg. Solutions/ Brush Contact

> / | Staggered | | GEN-X

is/ Hybrids - Fiber Optivies Hispeed/RF/Pow

VME64x/ VITA 60, 66

HSB3 | HDB; Hi Spæd |

Low Mating Force MIL-DTL-55302 ng Conn./ |Hybrids-Signal/Power/|Standar nice Install Conv (Elea Optice Bush

> Brush Ruggedized

LMD/LMS Rectangular Interconnects

Omer Rectangular Interconnects Amphenol interconnects are the chosen connector for major aircraft systems. Amphenol Corporation continually strives to meet the evolving needs for interconnect products in today's aviation, like higher speed transmission, higher density packaging, and ruggedization features. This page reference listing is to help design engineers find our products in this catalog by technology and capability perimeters and also by COTS availability. Amphenol is the technology leader for interconnects and stays in the forefront of designer's needs. Give us a call for further assistance on how we can meet your specific interconnect requirements*.

High Speed Products

| | Pages | 3 |
|-----|----------------------------|-------|
| LR | M with Fiber Optics 27, 28 | |
| HS | B ³ 48, 49, | 54-59 |
| Dig | giStak31-35 | -1980 |
| Giç | gaStak LG31-35 | 1 |
| Giç | gaStak31-35 | 36 |
| V۱٦ | TA 6644 | |
| V۱٦ | TA 60 (VIPER) | |
| Brι | ısh Hybrids | |
| Qu | adrax Connectors123 | |
| | | |

High Density Products

| | Pages | |
|------------------|------------|-------|
| LRM GEN-X | 10, 12-14, | 22-2 |
| HSB ³ | 48-53 | |
| Micro-D | 116 | P DEE |

Products for Rugged Environments

| | Pages | |
|-------------------------------------|---------|---|
| Green Brush | 61-84 | |
| HDB ³ & HSB ³ | 48-59 | |
| LRM | 10-41 | d |
| DigiStak | 31-35 | 1 |
| GigaStak LG | 31-35 | |
| GigaStak | 31-35 | |
| Ruggedized VME64x | 43 | |
| VITA 60 (VIPER) | 44 | |
| Brush Rack & Panel | 97, 98 | |
| UHD | 118 | |
| NAFI | 119 | |
| ARINC | 114, 11 | 5 |
| R39 | 115 | |

COTS Products

| | Pages | |
|-------------------------------------|-------------|----|
| VITA 66 | . 44 | |
| VITA 60 | . 45 | 1 |
| HDB ³ & HSB ³ | . 48-59 | 4 |
| Green Brush | . 61-84 | |
| Brush Docking Connectors | . 89 | |
| Small Form Factor Brush | . 85, 86, 8 | 38 |

*For product assistance call Amphenol Aerospace at 800-678-0141 or 607-563-5011.

See this catalog on-line, complete or by sections: www.amphenol-aerospace.com

Board Level and Rectangular Interconnects Introduction



QUICK REFERENCE TO THIS CATALOG BY PRODUCTS

| QUICK REFERENCE TO THIS C | ATALOG DI PRODUCIS |
|--|--|
| Later destina (Destara Calations) | Pages |
| Introduction/Package Solutions/ | 1-3 Introduction, Table of Contents/Quick Reference |
| Brush Contact Technology | 4, 5 Customized Package Solutions and Integrated |
| | Systems 6New/Featured Products |
| | 7, 8 Brush Contact - The Superior Choice |
| | for Board Level Interconnects |
| | Pages |
| LRM (Line Replaceable Modules) | 9-12LRM Styles, Design Flexibility/ LRM Product Evolution |
| with Brush Contacts/ LRM Hybrids/ | 13, 14LRM Design Engineering, Manufacturing |
| Options/Accessories | 15-25 Staggered Grid LRMs |
| | 25, 26GEN-X Grid LRMs |
| | 27-30LRM Hybrids: Fiber Optics/Hi Speed Contacts/RF/High Power |
| | 31-35 New Hi Speed Gigastak & Digistak |
| | 36 Hi Speed Modeling/Testing |
| | 37-40LRM Options: Flex, Compliant Pins, PC Tails, ESD Protection/Accessories & Tools |
| | 41Aid in Selection/Ordering of LRM/LRU Interconnects |
| | 41 Aid in Selection/Ordering of Entity/End interconnects |
| VALAVITA Interconnects | Pages |
| VME/VITA Interconnects | 42Introduction |
| | 43VME64x Interconnects |
| | 44-46 VME PO/J0, VITA-66.1, |
| | VIPER™ (VITA compatible) Interconnects |
| High Density HDB ³ & HSB ³ (High | Pages |
| Speed) with Brush Connectors | 47-49 HDB³/HSB³ High Density Features, Options, Performance |
| opeca) with Brasil conficctors | |
| | 50-53 HDB³ Connectors: Styles & How to Order 54-58 HSB³ Connectors: Styles & How to Order |
| | 59 Hardware for HDB ³ & HSB ³ |
| | So Halawaio for FIDE at FIDE |
| Low Moting Force Connectors | Pages |
| Low Mating Force Connectors | 60-62Low Mating Force Connector Features, |
| with Brush Contacts & Hybrids/ | Performance, Materials, Design Flexibility |
| Accessories/Installation | 63-84 4 Body Styles: How to Order/Contact Arrangements |
| | 85, 86 Smaller Sizes with .100 X .100 sq. inch grid 87, 88 Hybrids: Brush Contacts in Combination |
| | with Other Contact Types/ |
| | Small Color-Coded Brush Connectors |
| | 89 Docking Connectors with Brush Contacts |
| | 90-95Low Mating Force Connector Accessories & Installation |
| | |
| Ruggedized Brush Rack & | Pages |
| Panel Connectors | 96, 97 Ruggedized, Non-Floating Brush |
| Parier Connectors | Rack & Panel Connectors Features & Options |
| | 98Performance Data/ Hybrids with RADSOK® |
| | _ |
| LMD/LMS Modular Rectangular | Pages |
| Interconnects | 99-101 LMD & LMS Connector Features, Benefits & Performance |
| Interconnects | 102-106 Housings How to Order and Module Arrangements |
| | 107-109 Accessories and Assembly Instructions |
| | 110LMS In-Line Splice Connector |
| | |

Pages

111. Introduction

112-113 .. Heat Sink/Metal Manufacturing

114, 115..ARNC Rack & Panel, R27, R39, R58, R393 Connectors

116.ARINC Filter Rectangulars, Micro-D,

117. Backplane Systems & Enclosures

118, 119..UHD & NAFI Interconnects

Circuitry

120, 121.. Printed Circuit Boards & Flex

Microminiature & D-Sub Connectors

Other Board Level &

Rectangular Interconnects

Brush
Ruggedizec

LMD/LMS
Rectangular
Interconnects

Other
Rectangular
Interconnects

Pages

122. Integrated Systems

123. Quadrax Hi Speed Contacts

for High Power

128. Amphenol's Broad Product

for PCB Attachment

124, 125.. RADSOK® Interconnect Solutions

..RF High Frequency Contacts for LRM Interconnects

Printed Circuit Board Attachment

Offering of Circular Interconnects

.. Cylindrical Connectors for



Customized Interconnect Package Solutions and Integrated Systems

EVERYTHING YOU NEED. INSIDE & OUTSIDE THE BOX

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/ Speed/RF/ Ξ

VME64x/ 60,

High Density HSB3

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Fiber Optics

Docking Conn./

Amphenol Corporation's broad technical, product and manufacturing resources enable Amphenol Aerospace to provide exceptional performance in the area of customized system development-application specific packaging which blends both Corporate and Amphenol Aerospace products and design innovations. We provide customers with rapid, well engineered and cost-effective custom interconnect solutions.

I/O FRONT PANEL **CIRCULAR CONNECTORS**

Rugged, environmentally sealed I/O connectors, filtered and non-filtered. Available in a variety of styles and classes including threaded and bayonet coupling.



RF, Coax, Triax, Twinax, Quadrax and new 10-G high speed contacts available.

FIBER OPTICS FOR HARSH ENVIRONMENTS Very high densities can be achieved with MT Ferrule

METAL MACHINING

Termini.

Faceplates, enclosures, bus bars, heat sinks and stiffener machining capabilities. Multiple plating options available.



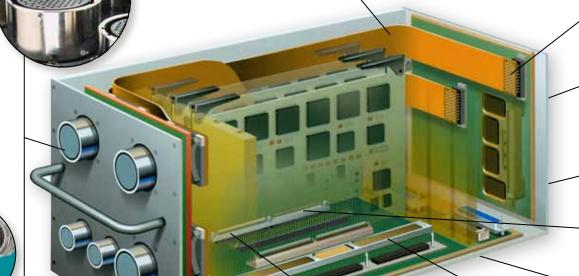
Fabrication capabilities include a wide variety of materials to enable increasing signal speeds, deep microvias,

buried, blind and back-drilled vias, sequential, lamination, panel sizes from 18" x 24" up to 24" x 54", and layer counts up to 60 with a board thickness of 0.400". Multiple plating options available.

The products shown on this page and the next represent some of the broad offerings from the divisions of: Amphenol Aerospace, Amphenol Backplane Systems, Amphenol Printed Circuits and Amphenol Canada; who work together as a systemlevel team to work with customers for their enclosure integration of interconnects.



Rigid-Flex circuit interconnects featuring blind and buried vias, microvias, bookbinder and other cutting-edge technologies including large format panels.



Designed to meet the high-density needs of today's integrated electronic modules, this straddle-mount connector uses the Bristle Brush contact, a proven military avionics solutions that meets MIL-DTL-55302 requirements. The low mating force, extended service life and stable electrical performance of the Brush contact enables the performance demanded by Line Replacable Module (LRM) applications. Hybrids available with fiber optics and high power RADSOK®.

Customized Interconnect Package Solutions and Integrated Systems, cont.

Amphenol Aerospace

A BROAD OFFERING OF INTERCONNECTS

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60,

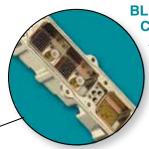
Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install Docking Conn.

ectangular

MIL-83513 MICRO D

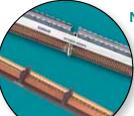
Assembled to flex I/O transition to outside or take signals off the backplane.



BLINDMATE RACK & PANEL CONNECTORS:

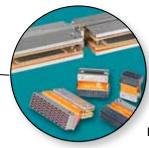
ARINC 600, 404 & 83527

Designed per ARINC 600 or ARINC 400 specifications. Single double, triple or quad bay insert styles available. Customize insert arrangements to include signal, power, coax, and quadrax contacts, or fiber optic termini.



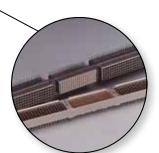
NAFI & UHD

Medium to high density connectors with fork and blade contacts. Module card with straddle-mount and through hole termination and solderless press-fit backplane contacts. EMI shielding, coax, fiber optic, and power contacts available



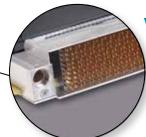
GIGASTAK, GIGASTAK-LG & **DIGISTAK**

The highly reliable LRM Brush connector with cStack[™] termination technology - giving the user hi-speed signal options up to 6.25 Gb/s and a solderless termination to their CCA. Designed for 100 ohm differential impedance. Provides optimized cross-talk.



RUGGEDIZED VME64X

Ruggedized replacement for standard VME connectors. Improved reliability and performance to meet avionic environmental packaging requirements.



VITA 60/64 VIPER

High density, modular 6+ Gbps, high vibration performing, ESD shielded connector meeting the specifications for VITA 46 and 48 in both 3U and 6U configurations. Developed using proven mechanical and signal integrity with unmatched performance in the industry.

Shown right is another Amphenol integrated system box that includes both circular and rectangular interconnects, flex and backplanes in a custom metal enclosure. See more information on Integrated Systems and Package Solutions from Amphenol in the Other Rectangular Board Level & Rectangular Interconnect Section of this catalog, page 122.

Board Level and Rectangular Interconnects

NEW/FEATURED PRODUCTS

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/ Speed/RF/ Ξ

VME64x 60,

High Density HSB3

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Docking

Amphenol has become the leader in interconnection products through its long history of engineering expertise for product solution solving.

New and innovative solutions are under development every day within our highly skilled engineering departments who are teamed with marketing product managers and production specialists. They are always striving to meet new customer requirements in ever changing markets.

The teams have a customer-driven approach to produce the end result: quality interconnect products that meet or exceed customer demands.

Below are some of the newer product solutions that have been developed in response to our customers' ever evolving requirements for board level and rectangular interconnects.

New/Featured Product

HDB³ High Density Brush Connector Series Page 47

Tighter .070 inch X .060 inch staggered grid spacing provides higher density in a compact-height board level

Solution:

Higher contact density plus lower mated height thus maximimzing board space.



New/Featured Product

High Speed GigaStak™, Gigastak-LG™, DigiStak™ and DigiStak-X™ LRM Connectors

Pages 31-36

High speed inserts provide data transference of up to 6.25 Gb/s.



Solution:

Hi Speed performance in a ruggedized connector. Utilizes new cStack™ termination - solderless interconnection between flex and board.



New/Featured Product

LRM Connectors with High Power RADSOK® Contacts

Page 30

High Amperage RADSOK® socket contacts are designed into LRM connectors for higher power applications. The RADSOK® socket imparts high current flow across the connection with minimal voltage loss with its hyperbolic, stamped grid configuration.

Solution:

High Amperage RADSOK® socket contacts allow for passing of larger amounts of current with lower mating forces than standard contacts.



New/Featured Product

VITA-66.1 Fiber Optic Interconnects

Page 44

A reliable high speed connection for the most extreme commercial and military environments. This ruggedized interconnect is among the highest density of connector products on the market.

Solution:

Higher Density in a rectangular board level connector package.



New/Featured Product

VIPER® High-Speed Interconnects

Pages 45 & 46

A shielded, high density, hi-speed modular interconnect with press-fit termination. VITA 46, VITA 48 and VITA 60 foot-print

compatability. Designed for 10 + Gb/s data rate performance.

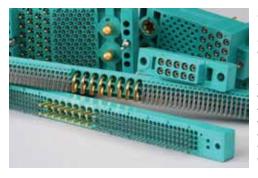
For assistance with your specific interconnection requirements, give a call to the Amphenol sales representative in your area, (go online to amphenol-aerospace.com) or call for product assitance at

Amphenol Aerospace, 800-678-0141 or 607-563-5011.





A SUPERIOR CHOICE FOR BOARD LEVEL INTERCONNECTS



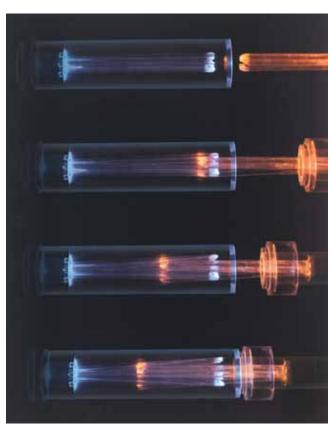
Low Mating Force Connectors with Bristle Brush contact technology.

Manv styles are available, including styles that have arrangements of brush, fiber optic, coax and other contact types.

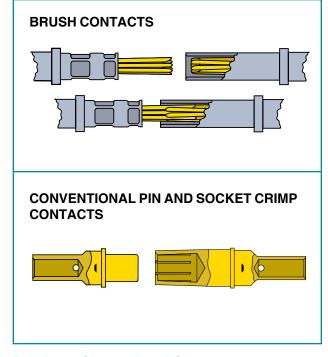
The Amphenol® Brush Contact Technology has proven advantages over standard pin & socket contacts and Amphenol has a very broad family of brush contact products which are shown in this catalog.

The Bristle Brush contact is used in military avionics packages and meets the requirements of MIL-DTL-55302. It provides high density in tight spacing, low mating/inmating forces, proven durability and long contact life. Applications for Amphenol connectors with brush contacts include:

- Medical equipment
- IC chip testers
- Telecommunications
- Military and Commercial Aviation
- Military Ground Vehicles
- **GPS** systems



Multiple strands of high tensile strength wires bundled together. provide superior electrical connection with low mating force.



Brush vs. Conventional Contacts

- **Brush Contact Innovation**
- Multiple contact interfaces Strands of high tensile wire are bundled together to form brush-like contacts. By intermeshing two multi-strand wire bundles, an electrical connection is made.
- Provides redundant current paths, 14-70 (points of contact) per mated contact with a gas tight junction
- Very smooth (low friction) interface

Conventional Pin/Socket

- Machined surface finish on both parts
- Higher friction and wear
- Limited number of contact sites

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60, 66

Hi Speed

Brush

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics Accessories/Install

ectangula



FEATURES & BENEFITS, AMPHENOL'S CAPABILITIES

Hybrids - Fiber Optics/ | Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/Power

90

HSB3

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Coax/Fiber Optics

Docking Conn./

Amphenol® B3 Bristle Brush Contact **Advantages:**

Low Mating & Unmating Forces

- Smooth, low friction interfaces
- 70% to 90% reduction in mating/unmating forces from conventional pin-socket contacts
- 1.5 oz. maximum forces per contact pair (one ounce typical)
- Easy mating/unmating makes high circuit counts practical (25 lbs. typical for 400 contacts)
- Mechanical mating aids not required
- No need for external board support structures for connectors up to 7 inches long. A center support is recommended for Mother Board Connectors over 7 inches.

Proven Durability and Long Contact Life

- 100,000 mating cycles even when hot swapped
- Documented intermittency free performance no 10 nano second discontinuities during 50m cycles of 0.010 displacement
- Overall cost effectiveness (reduced life cycle

Multiple Points of Contact Provide Superior Electrical Capability

- 14-70 points of contact per mated contact
- Stable, low resistance 20 milliohms max.
- Redundant current paths results in lower total resistance
- Proven electrical and gas tight contact sites



Amphenol offers configurations of LRM connectors that combine the brush contact in some inserts along with other types of contacts in other inserts.



Amphenol rectangular products group, including low mating force PCB connectors, LRM connectors and the OBIS Backplane with brush contacts and MT ferrule fiber optics.



High technology production centers at the Amphenol home facility and its satellite facilities create volume runs that are cost effective and meet on-time delivery demands.

Amphenol Line Replaceable Module (LRM)



| | LE C | | | |
|--|------|--|--|--|

| TABLE OF CONTENTS |
|---|
| Amphenol LRM Interconnects |
| Table of Contents |
| Amphenol Leads in Board Level Technology 13, 14 LRM Module Connector General Information 15 LRM Backplane Connector General Information 16 |
| Staggered Grid LRM Staggered Grid LRM and Staggered Grid Airflow-thru Contact Patterns/Comparison 17, 18 Staggered Grid Arrangements 19, 20 Staggered Grid Airflow-thru Arrangements and Custom Shells 21 Staggered Grid Termination Options 22 Staggered Grid Performance, Materials 23 |
| GEN-X Grid LRM • Comparison of Staggered Grid LRM vs GEN-X LRM |
| LRM Interconnect Options - Fiber Optics / High Speed / RF / High Power |
| Fiber Optics |
| LRM Options, Accessories, Tools • Flex Circuitry, Backplanes with Compliant Pins, I/O Modules with PC Tails |

Aid in Selection/Ordering of LRM/LRU



LRM Typical Markets:

- Military & Commercial Avionics
- Military Vehicles
- Missiles/Ordnance
- Missile Defense

- C4ISR
- Space (Satellites)
- Radar





Amphenol® Line Replaceable Module (LRM) High Performance Board Level Interconnects

INTRODUCTION - LRM STYLES & DESIGN FLEXIBILITY

(Line Replaceable Modules)

90

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Docking

Staggered Grid LRM



GEN-X Grid LRM

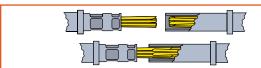


High Speed LRM



Inserts with 3.125 Gb/s and 6.25 Gb/s data rate capability, with flex termination. Can be added to existing LRM configurations.

LRM INTERCONNECTS FEATURE AMPHENOL'S BRUSH CONTACT TECHNOLOGY



Multiple strands of high tensile strength wire bundled together to form brush-like contacts. See the Introduction & Brush Contact Technology section of this catalog for further description.

- With its low mating force, stable electrical performance and extended service life, the B3 Brush contact is the standard contact for the LRM.
- Digital (Brush) inserts can be combined with each other or with inserts for power, RF, fiber optic and high speed contacts.

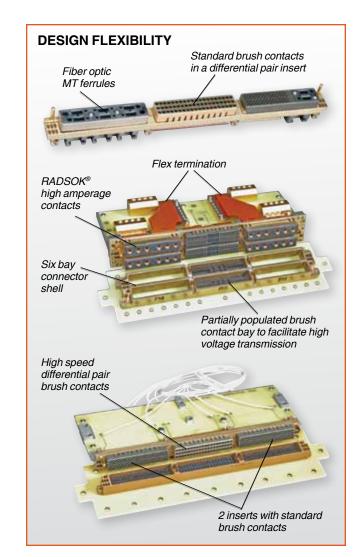
Amphenol® LRM Surface Mount Connectors meet the high density needs of today's integrated electronic

Amphenol goes beyond the usual board level product offering: and that is what you would expect from a worldwide interconnect product leader.

MODULAR AVIONICS ARCHITECTURAL POSSIBILITIES

With its flexibility in design, Amphenol LRM interconnects are capable of meeting the wide variety of user requirements for a board mount connector.

- Thousands of combinations of inserts are possible tailored to meet user needs
- LRM interconnects can be designed in 1, 2, 3 (and more) bay configurations with many shell designs available
- LRM digital (brush) inserts can be combined with inserts for power, fiber optics, RF, high speed and high amperage RADSOK® contacts



NOTE: This catalog section supersedes Amphenol's older individual catalog on LRM products, 12-037.

Amphenol® Line Replaceable Module (LRM) Interconnects

Amphenol Aerospace

LRM PRODUCT EVOLUTION

Amphenol has been committed to keeping pace with the ever-changing demands of the rectangular connector marketplace. Starting with the development of the B3 contact, incorporated into the low mating force PCB connectors, and later with the development of the line replaceable module (LRM), Amphenol has led the way in the avionics packaging industry for high quality rectangular products. This page and the following page give an overview of the rectangular product evolution.

Low Mating Force Connector with Bristle Brush Contacts*

- Developed in the 1980's to provide solutions to problems caused by the high mating and unmating forces of conventional pin and socket contact pairs.
- 4 Body styles: mother board (MB), daughter board (DB), PC connector, input/ output connector
- Molded of thermoplastic material
- 2, 3 and 4 row configurations, 10 to 100 contacts per row in one contact row increments
- 100 inch center to center contact spacing, square grid
- Qualified to MIL-DTL-55302/166, /167, /168, /170

Line Replaceable Module (LRM) Connectors with Chevron Grid**

- Developed to meet the avionics packaging requirements for a surface mount, high contact density PCB connector in a SEM-E form factor.
- Digital insert pattern grid: 6 rows, 0.075" spacing along rows, 0.075" between rows with 0.025" offset.
 - ** This is an older design of the LRM and is typically not used today. Staggered and GEN-X designs have replaced the Chevron design (Consult Amphenol for further details)

LRM Connectors with Staggered Grid

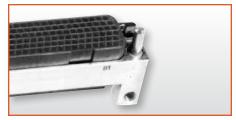
- Advanced design to provide higher contact density for high speed integrated circuitry in SEM-E and custom form factors.
- Digital insert pattern grid is in 8 rows: 0.100 inch spacing along the row with 0.050 inch between rows, rows offset 0.050 inch. Typical standard arrangements would have 80 or 108 or 152 or 180 digital brush contacts.
- Options include various shell designs options to accommodate a wide range of PC board/heat sink combinations
- Surface mount termination on module connectors, PCB or compliant termination on backplane connectors
- Amphenol ESD protection (in module connector)
 - Designed for level 2 (flight line) maintenance
- Provides routing channels for backplane

Amphenol Staggered Grid Connectors are the connector of choice for the F-16 and F-22 Aircraft. The following were the criteria that determined the selection of the connector for the F-16, F-22 and F-35 aircraft:

- Reliability: Impervious to fretting corrosion, Micro-arching
- **ESD Protection**



Low Mating Force Connectors - the first development of rectangulars with Brush contacts.



LRM Chevron Grid (150+180 contact pattern) (Amphenol's first LRM design)



LRM Staggered Grid (180 contact pattern) Amphenol's higher density LRM with more advantages.



Staggered Grid LRM was chosen for the F-16 and F-22 Aircraft

Amphenol LRM Evolution continues on next page.

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Instal

ctangula

11

^{*} See the Brush Contact Technology section, and the Low Mating Force MIL-DTL-55302 section of this catalog.



Amphenol® Line Replaceable Module (LRM) Interconnects

LRM PRODUCT EVOLUTION, CONTINUED

Introduction/ Pkg. Solutions/ Brush Contact

LRM (Line Replaceable Modules)
ppions/ Hybrids - Fiber Optics/ | Staggere
cessories Hi Speed/RF/Power | GEN-X

60,

Docking

Other Rectangular Interconnects Certainly not standing still, and continuing to expand product offering, Amphenol now provides LRMs with higher contact densities, special purpose configurations and high speed inserts.

LRM Connectors with GEN-X Grid

- Higher contact density and improved electrical performance
- All the features of staggered LRM, including ESD protection (module connector)
- Available in SEM-E and custom form factors
- 236 contact pattern grid in 8 rows: 0.075 inch spacing along the row with 0.060 inch between rows, rows offset 0.0375 inch

LRM Staggered Grid Airflow-thru Connectors

 LRM Staggered Airflow-thru inserts are available for wider board packages up to 0.425 in. These accommodate standard B³ tails in staggered pattern, but with increased spacing in the center, to accommodate airflow through heatsinks

LRM Connectors with Fiber Optics

- Custom combinations of digital contacts and fiber optic termini were offered as the product line further developed in the '90's.
- Configurations included:
 - MIL-T-29504/4, /5, /14 & /15 termini
 - MT ferrule arrangements (2-24 fiber lines per ferrule)

LRM Connectors to Accommodate RF Contacts

- LRM inserts are available with RF contacts:
 - Size 16 M39029/79 & /80 shielded contacts
 - Size 12 coax for DC-2 GHz: size 8 coax for DC-32 GHz
 - SMPM coax contacts*

• LRM Power Supply Modules

 Custom designs of LRMs have been developed with 270VDC sections which are capable of providing corona-free operation at 100,000 feet. They utilize size 22D contacts and are available in both crimp and compliant pin terminations.

LRM with High Amperage RADSOK® Contacts

 The RADSOK® contact technology enables high current flow with minimal voltage loss and low insertion force

Board Level Interconnects of 2010 and Beyond -

More and more the customer has demanded a high level of flexibility, with designs that incorporate higher speeds and special features going beyond the standard LRM. Configurations such as:

- High speed GigaStak® LRM connectors

 capable of data rates up to 6.25 Gb/s, and DigiStak® LRM connectors capable of data rates up to 3.125 Gb/s
- High speed shielded contacts data rates of 6.250 Gbps coax, triax, twinax, differential twinax, and quadrax contacts available in inserts of the LRM
- Combinations of power contacts, standard brush, high power, differential pair brush, and fiber optic termini
- · Incorporation of Flex Circuits for more versatility of PC board terminations
- Custom shells with multiple bay configurations, special keying components or special guide/ground pins
- Compliant pin contacts for press-fit termination to circuit boards.

Amphenol Backplane Capabilities

Amphenol backplanes incorporate a wide range of our interconnects. See Other Rectangular Interconnects Section of this catalog, page 117, for more information on Amphenol backplanes.



LRM GEN-X Grid (236 contact pattern) Even higher densities with all the benefits of the Staggered Grid.



LRM Staggered Grid Airflow-thru



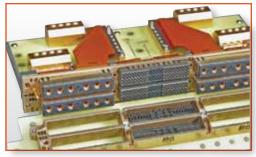




LRM with RF Contacts



LRM backplane (left) and module connector (right) incorporating high amperage RADSOK® contacts (crimp style shown).



LRM special 6 bay design with RADSOK® contacts, standard brush contacts, and flex circuitry termination to module circuit card assemblies

 See Other Rectangular Interconnects Section, page 126 for more information on SMPM contacts.

High Speed GigaStak®, capable of

Amphenol Leads in Board Level **Product Technology**

Amphenol Aerospace

LRM DESIGN ENGINEERING

We take pride that Amphenol Aerospace is the undisputed leader in interconnect systems for aerospace/harsh environment applications. Such applications require a high degree of engineering sophistication and precision manufacturing capability that only a company that has been in the interconnection product design and manufacturing business for over 50 years can offer.

We have earned the reputation as the leader in the military electrical connection arena especially for military cylindrical connectors, and are fast becoming the leader for rectangular and surface mount interconnects.

Our LRM and VME64x* products are used on major programs that include the following and more:

- F-35
- **JTRS**
- EA18G

- F-16
- M1A2 Tank
- EA6B

- F-15
- F-117
- **MEADS**

- F/A-22

- F/A-18
- AH-64 APACHE G/ATOR
- **ASRAAM**
- EQ-36

- B2
- B52

Expert design and applications engineering provides solid modeling and full Pro-Engineer® capabilities to develop new interconnection designs and perform structural analysis. Marketing product managers team with skilled engineers and production specialists in a customer-driven approach to produce the end result: defect-free parts, cost effectiveness, shorter lead and delivery times, and satisfied customers.

The photo top right shows the CST Microwave Studio® signal integrity modeling and simulation software at Amphenol. This state-of-the-art technology allows characterization of current connector designs and rapidly aids in the development of new high speed signal designs. It consists of a 3D, full-wave electromagnetic field solver for simulating electrical performance, producing SPICE models and eye diagrams.

Amphenol's capability for testing of it's wide range of cylindrical and rectangular connector products also

includes vibration and shock testing, humidity, engagement/separation force evaluation, durability testing, as well as salt spray/ fog, corona, ESD, optical performance testing and altitude simulation.



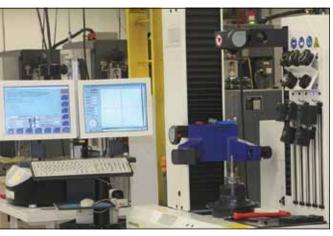
Close-up photo showing vertical machining of heatsink housings done at Amphenol.



Engineers working at the signal integrity modeling and simulation software suite at Amphenol Aerospace Operations. (See page 28 for more information on Amphenol's testing of Hi-Speed LRM



Above and below are production areas for LRM interconnects and heatsinks. Note the orange balls on the machines - these are used as a quick checking device for processes.



Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power Coax/Fiber Optics

Accessories/Instal

ectangula

13

^{*} VME64x products are covered on page 43.



Amphenol Leads in Board Level Technology

LRM MANUFACTURING EXPERTISE

Introduction/ kg. Solutions/ Brush Contact

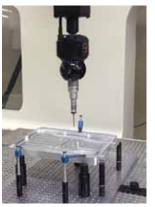
gggered/ Pkg. Solu Brush C

LRM (Line Replaceable Modules) ptions/ | Hybrids - Fiber Optics/ | Stagger cessories | Hi Speed/RF/Power | GBN-

Other Rectangular Interconnects Amphenol Aerospace is highly integrated to design, manufacture, assemble and ship an extensive variety of line replaceable module and backplane connectors. We also supply a wide range of heatsink hardware associated with this type of connector. The photo on right shows several heatsink forms used in the manufacture of LRM interconnects. For more information on heatsinks, see the Other Board Level and Rectangular Interconnects Section, pages 112 & 113. Manufacturing equipment photos shown below demonstrate Amphenol's high technology capability. Focus is always on cost effective production and continuous improvement of processes. Manufacturing capabilities include state-of-the-art robotically controlled milling machines and CNC machining, as well as impact and extruding, plating, screw



Variety of heatsinks and connector shells manufactured by Amphenol.



machining, and process control.



CMM measuring is done to check machined parts.

THE ADVANTAGE OF AMPHENOL'S WIDE DIVISIONAL CAPABILITY

Amphenol divisions work together to provide a very broad manufacturing capability for board level interconnects:

- Amphenol Aerospace (AAO)* has leading expertise in the production of line replaceable module inter-connects, VME64x interconnects and low mating force brush connectors.
- Amphenol Backplane Systems (ABS)** has leading expertise in the manufacture of custom backplane assemblies - high density, ruggedized, board to backplane interconnects.
- Amphenol Printed Circuits (APC)*** has leading expertise in the manufacture of flex circuitry products used in connector-to-board attachment.

These companies of Amphenol Corporation combine to provide design, applications engineering, fabrication, value-added assembly and testing to meet customer requirements as well as to develop products for emerging technologies.

- * This catalog covers the rectangular interconnect products offered by AAO division. Go online at www. amphenol-aerospace to see the wide range of cylindrical and other interconnect products offered by AAO. And see the Other Rectangular Products section at the end of this catalog for other Amphenol divisions offerings of rectangular interconnects.
- ** For more information on backplane assemblies: page 117 and online at www.amphenol-abs.com.
- *** For more information on flex circuit products: page 121 and online at www.amphenolapc.com.



Amphenol's high technology computer driven equipment for manufacturing heatsinks.

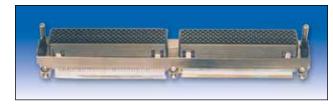


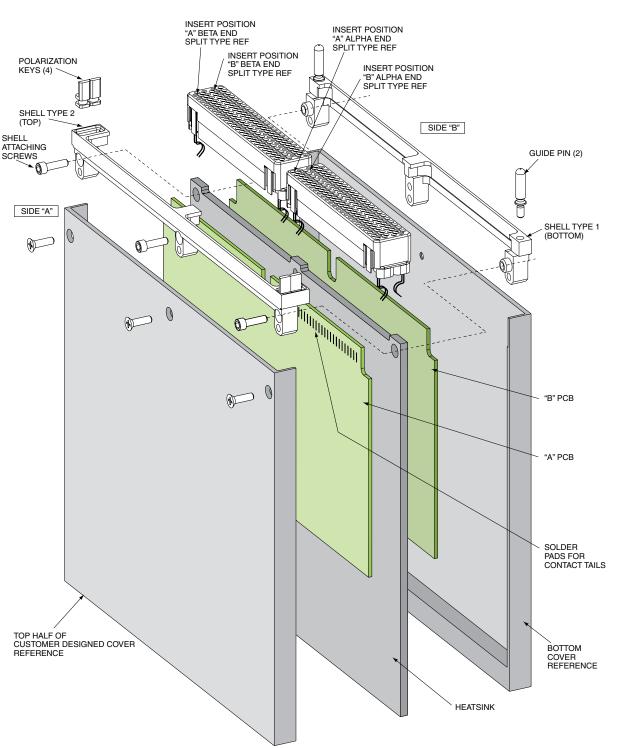
Checking for dimensional accuracy of LRM parts and heatsinks.

Amphenol Aerospace

STAGGERED GRID DOUBLE BAY SHOWN

The following is the LRM Module Connector identification and naming convention. The illustration is a double bay module with a staggered grid pattern.







LRM Backplane Connector General Information

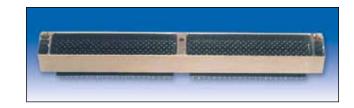
STAGGERED GRID DOUBLE BAY SHOWN

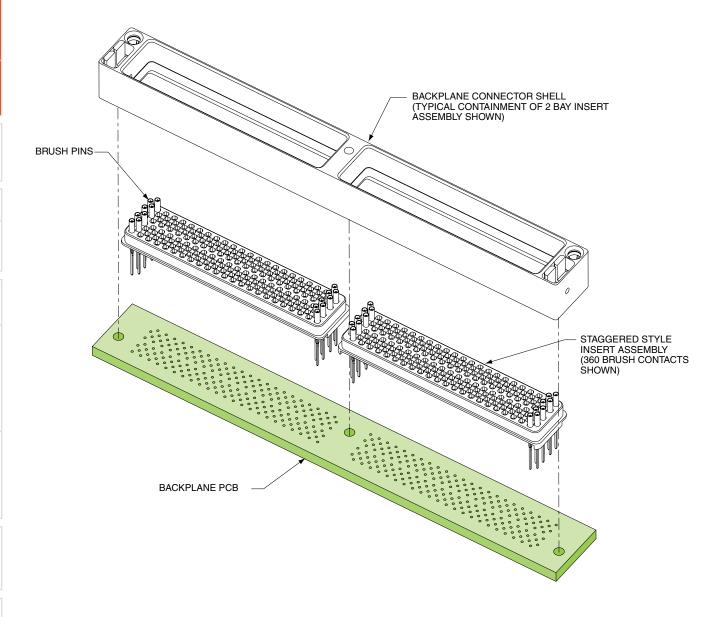
VITA 60,

High Density HSB3

| Hybrids - Signal/Power/ | Standard Low Mating Force MIL-DTL-55302 Docking Conn./

The following diagram shows an exploded view of an LRM staggered grid backplane connector in a two bay configuration.

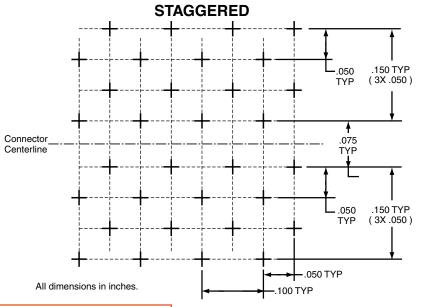




drawings on pages 19 and 20.

The LRM standard staggered grid pattern employs surface mount leads on .025 inch centerlines (pitch). Insert patterns of digital brush contacts are in 80, 108, 152 and 180 contact counts. See typical arrangement

STAGGERED GRID DESCRIPTION

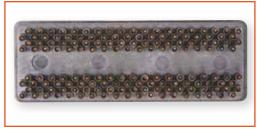




Two bay, 360 contact, module connector with standard staggered grid pattern

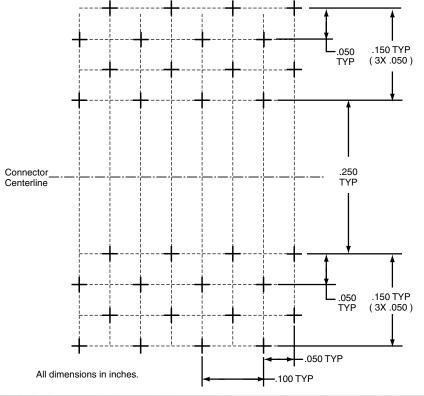
STAGGERED AIRFLOW-THRU GRID **DESCRIPTION**

The staggered grid airflow-thru inserts were designed to accommodate wider board packaging and airflow-thru heatsinks. Insert patterns of digital brush contacts are same as the staggered grid pattern (80, 108, 152 and 180 contact counts). See typical arrangement drawings on page 21.



Staggered grid airflow-thru backplane insert.

STAGGERED AIRFLOW-THRU



VITA 60,

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install

Ruggedized

Interconnects ectangular

Staggered Grid LRM & Staggered Grid Airflow-thru

CONTACT PATTERNS/COMPARISON

Introduction/ Pkg. Solutions/ Brush Contact

| Hybrids - Fiber Optics/ | Staggered

LRM (Line Replaceable Modules)

3 VME64x / VITA 60, 66

High Density
d HSB³ HDB³

Low Mating Force MIL-DTL-55302 ing Conn./ Hybrids - Signal/Power/ | Star ories/Install. Coax/Fiber Optics Br

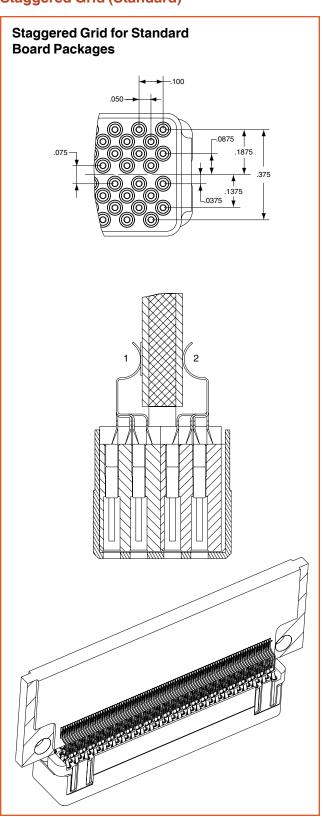
Docking Conn./
Accessories/Install

Rack & Panel Brush Ruggedized

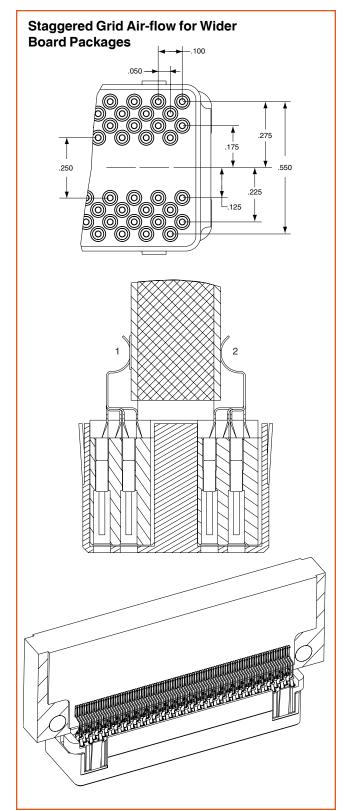
LMD/LMS Rectangular Interconnects

Other Rectangular Interconnects

Staggered Grid (Standard)



Staggered Grid Airflow-Thru

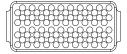


TYPICAL ARRANGEMENTS

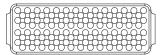


Example of a backplane connector in a 2 bay arrangement with inserts of staggered brush contacts and coax (size 12) contacts.

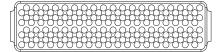
80 brush contacts



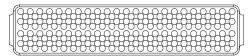
108 brush contacts



152 brush contacts



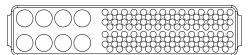
180 brush contacts



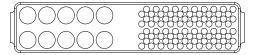
108 brush contacts plus 6 sz. 12 power or coax contacts



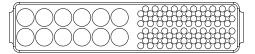
108 brush contacts plus 8 coax contacts



80 brush contacts plus 10 coax contacts

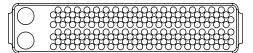


80 brush contacts plus 12 sz. 12 power or coax contacts

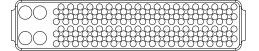


Staggered Grid LRM interconnects can be one, two or three bay configurations, and special additional bay arrangements. The typical arrangements shown here are depicted in one bay drawings. Amphenol's design flexibility also allow for combinations of contact types. These arrangements represent the versatility that can be arrived at by arranging digital (brush) inserts with inserts for power, RF, fiber optic and high speed contacts in various combinations within a typical bay. Consult Amphenol Aerospace for assistance in designing the LRM that best meets your specific application needs. See page 41 for an aid in selection and ordering.

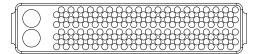
152 brush contacts plus 2 sz. 12 power or coax contacts



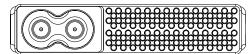
152 brush contacts plus 4 sz. 16 power or coax contacts



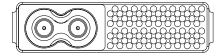
152 brush contacts plus 2 sz. 12 power or coax contacts



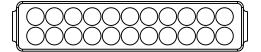
108 brush contacts plus 270 VDC power input



80 brush contacts plus 270 VDC power input



22 sz. 12 power contacts



Staggered Grid LRM

TYPICAL ARRANGEMENTS

LRM (Line Replaceable Modules)





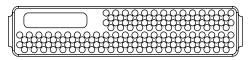




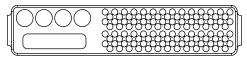




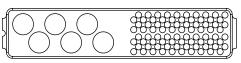
144 brush contacts plus 4 fiber optic termini



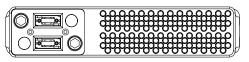
108 brush contacts plus 4 coax contacts and 4 fiber optic termini



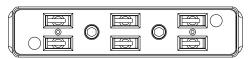
80 brush contacts plus 6 coax contacts



108 brush contacts plus an insert for 2 fiber optic MT ferrules*



6 cavities for fiber optic MT ferrules*



Example of a 3 bay module connector with an insert for MT fiber optic ferrules and inserts for brush LVDs and digital contacts.

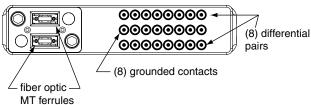


Example of a 2 bay staggered grid module connector.

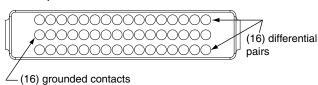


Example of a staggered grid module and backplane with 108 brush contacts and an insert for 7 size 20 crimp contacts for high voltage applications.

8 brush LVDS differential pairs plus an insert for 2 fiber optic MT ferrules*



16 LVD pairs



MT ferrules are not supplied by Amphenol Aerospace. see page 28 for more information on LRMs with MT ferrules.

Amphenol Aerospace

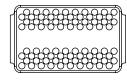
ARRANGEMENTS, CUSTOM SHELLS

The typical Airflow-thru arrangements are with brush contacts. The arrangements shown at left for staggered grid Airflow-thru are typical of what has been developed for customer requirements.

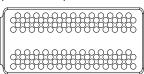


Staggered Grid Airflow-thru pattern - in a module on right, and in a backplane on left. Note the increased spacing in the center. This is designed for wider board packages, and accommodates airflow-thru heatsinks. (See illustration on page 18).

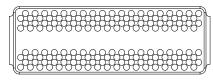
80 brush contacts (airflow-thru)



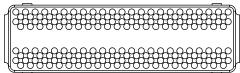
108 brush contacts (airflow-thru)

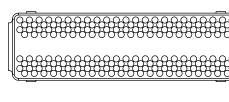


152 brush contacts (airflow-thru)



180 brush contacts (airflow-thru)





LRMs with airflow-thru inserts can be custom designed in combination with power contacts, such as the example below.



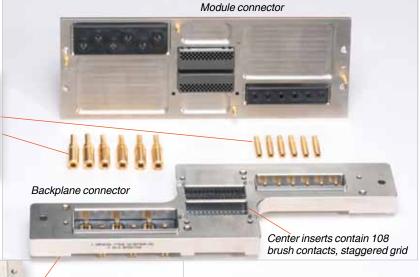
Module and backplane connectors with staggered airflow-thru inserts. Shown are 216 brush contacts and inserts for size 12 RADSOK® crimp contacts.

Amphenol designs and builds custom shell configurations such as the module face plate and its mating backplane connector.

This custom Airflow-thru module contains RADSOK® high amperage socket contacts in sizes 8 and 12.

See more description of RADSOK® contacts, page 124.







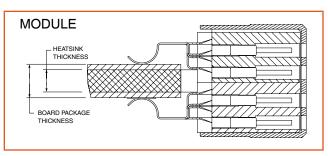


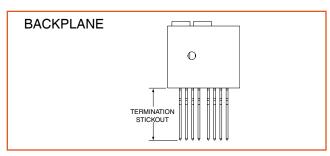
VITA 60,

Low Mating Force MIL-DTL-55302 Accessories/Instal

TERMINATION OPTIONS

The following is a guide to the part number suffixes to be used when ordering LRM Connectors. Due to the complexity and number of variations within the part numbering, it is necessary to consult Amphenol Aerospace for assistance when building these part numbers. See page 41 for an aid in selection and ordering, and call Amphenol at 607-563-5011 for technical support.





An example of a typical Amphenol Module part number is: 10-507XXX-X()()

10-507Designates Amphenol LRM Connectors

XXX-X......Module Insert Arrangement

Number - To be assigned by Amphenol.

().....Heatsink Thickness Suffix for Modules

| Suffix | Description | |
|--------|-------------|--|
| 1 | .125 ±.005 | |
| 2 | .100 ±.005 | |
| 3 | .075 ±.005 | |
| 4 | .062 ±.005 | |

().....Board Package Thickness Suffix for Modules

| Suffix | Description Standard Staggered | Description Airflow-thru Staggered* |
|--------|--|---|
| 1 | Surface Mount / .090 – .130 Package | Surface Mount / .265 – .305 Package |
| 2 | Surface Mount / .130 – .190 Package | Surface Mount / .305 – .365 Package |
| 3 | Surface Mount / .190 – .250 Package | Surface Mount / .365 – .425 Package |
| 4 | Surface Mount / .060 – .100 Package | Surface Mount / .235 – .275 Package |
| 5 | Surface Mount / .100 – .160 Package | Surface Mount / .275 – .335 Package |
| 6 | Surface Mount / .160 – .220 Package | Surface Mount / .335 – .395 Package |

 ^{* .175} is added for increased center spacing in the airflow-thru staggered style

An example of a typical Amphenol Backplane part number is: 10-507XXX-X()()

10-507 Designates Amphenol LRM Connectors

XXX-X......Backplane Insert Arrangement
Number - To be assigned by Amphenol.

().....Termination Style Suffix for Backplanes

| Suffix | Description |
|--------|--------------------------|
| 1 | .021 ±.002 Dia. PCB Tail |
| 2 | .016 ±.002 Dia. PCB Tail |
| 5 | Compliant |

().....Termination Stickout Suffix for Backplanes

| Suffix | Description |
|--------|---------------------------------|
| 1 | .150 ±.020 (PCB) |
| 2 | .200 ±.020 (PCB) |
| 3 | .250 ±.020 (PCB) |
| 4 | .300 ±.020 (PCB) |
| 5 | .350 ±.020 (PCB) |
| 6 | .400 ±.020 (PCB) |
| 7 | .185 ±.020 (PCB) |
| 8 | .450 ±.020 (PCB) |
| 9 | .500 ±.020 (PCB) |
| С | .157 ±.020 (Compliant, No Wrap) |
| D | .217 ±.020 (Compliant, 1 Wrap) |
| E | .317 ±.020 (Compliant, 2 Wrap) |
| F | .417 ±.020 (Compliant, 3 Wrap) |

Ruggedized

TYPICAL PERFORMANCE, MATERIALS LIST

Table 1 below identifies the typical electrical, mechanical and environmental performance of an Amphenol 2 bay LRM connector assembly with 360 brush contacts in staggered grid. This data was program specific and does not reflect actual performance limitations. Table II below provides a materials list for the components of staggered grid LRM connectors.

TABLE I: PERFORMANCE

| ELECTRICAL PERFORMANCE | | | |
|--|--|--|--|
| Electrical Parameters Performance | | | |
| Current carrying capability | 10°C temperature rise at 2A and 30°C rise at 3A | | |
| Contact resistance | 30 milliohms max. per contact, 25 milliohms max. average | | |
| Dielectric withstanding voltage at sea level | 100 VRMS, 60 Hz | | |
| Dielectric withstanding voltage at altitude | 100 VRMS, 60 Hz at 70,000 ft. | | |
| Insulation Resistance | 1000 megohm minimum at 100V d.c. | | |
| Electrostatic Discharge Protection (module only) | ± 25,000 minimum air and direct discharge (see pg. XX for details) | | |

| MECHANICAL PERFORMANCE | |
|--|--|
| Mechanical Parameters | Performance |
| Contact retention (solder type backplane assembly) | Maximum displacement of 0.010" at 1 pound load |
| Mating and unmating forces | Maximum 40.0 pounds mating and unmating |
| Vibration (Sinusoidal, 20g peak max.) | No electrical discontinuity >1 μS |
| Vibration (Random, 11.6g RMS max.) | No electrical discontinuity >1 μS |
| Shock (50g max. shock pulse) | No electrical discontinuity >1 μS |
| Solderability | Minimum 95% solder coverage |
| Resistance to soldering heat | 260°C dip for 10 seconds |

| ENVIRONMENTAL PERFORMANCE | |
|---------------------------------|--|
| Environmental Parameters | Performance |
| Temperature life | 250 hours at 125°C maximum |
| Connector durability | 500 cycles mating and unmating |
| Salt fog exposure | 48 hours maximum direct exposure (5% NaCl) |
| Thermal shock | 500 cycles at +125°C / -65°C |
| Humidity exposure | 240 hours at 90 - 98% |
| Contamination exposure | Sand and dust per MIL-STD-202 Method 110 |
| Resistance to solvents | Boiling Trichloroethylene fumes and solution |

TABLE II: MATERIALS LIST

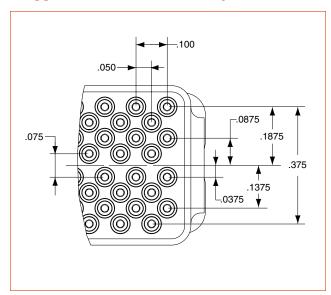
| ENVIRONMENTAL PERFORMANCE | |
|--|--|
| Part | Material / Finish Description |
| Brush wires | Beryllium copper per ASTM B197; finish is gold per ASTM B488 over nickel per AMS-QQ-N-290. (The exposed ends of the brush wires need not be plated). |
| Module contacts | Beryllium copper per ASTM B534 C17500, or C17510 except temper HTC; finish on contact body is matte tin-lead per ASTM B579; finish on termination end is 60/40 or 63/37 tin-lead dip per J-STD-004, -005 and -006. |
| Backplane contacts (Compliant termination) | Contact barrel: brass per ASTM B4531/B453M-01 similar to UNS C33500; finish is tin-lead per SAE-AMS-P-81728 (min. 15% ±5% lead) over nickel. Contact tail: beryllium copper per ASTM B-534 alloy 17510 HT; finish is gold per ASTM B-488 over nickel per AMS-QQ-N-290. Contact sleeve: stainless steel per AMS 5514; finish is black oxide per MIL-DTL-13924 and conformally coated per MIL-I-46058. |
| Backplane contacts (PCB termination) | Contact body: brass similar to UNS C33500; finish is gold over nickel; termination end is 60/40 or 63/37 tin lead dip. Contact sleeve: stainless steel per AMS 5514; finish is black oxide per MIL-DTL-13924 and conformally coated per MIL-I-46058. |
| Insulators | Polyphenylene Sulfide or Liquid Crystal Polymer per MIL-M-24519 |
| Organizer | Polyphenylene Sulfide or Liquid Crystal Polymer per MIL-M-24519 |
| Shells | Aluminum alloy 6061-T6 per AMS 4150; finish is electroless nickel per SAE AMS 2404. |
| ESD shields | Aluminum alloy 6061-T6 per AMS 4150; finish is hardcoat anodize per MIL-A-8625 with epoxy final coat. Ground tabs are chromate treated (irridite). |
| Polarization keys | Stainless steel per AMS 5640; finish is black oxide per MIL-DTL-13924. Key retaining ring is Polyamide (nylon 12) with 50% glass filled fibers. |
| Guide pins | Beryllium copper alloy per ASTM B196, finish is gold per ASTM B 488 over nickel per AMS-QQ-N-290. |

GEN-X PROVIDES HIGHER CONTACT DENSITY

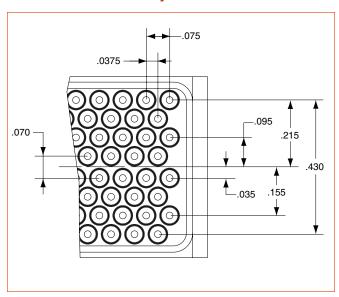
. Solutions/ Pkg. Solutions/ Brush Contact

LRM (Line Replaceable Modules)

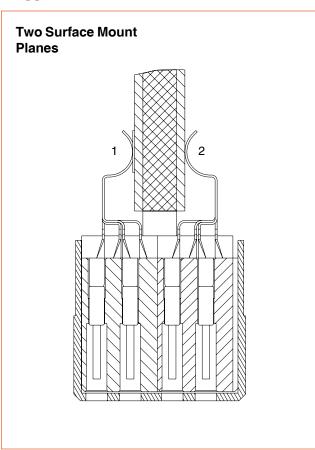
Staggered Grid Contact Density



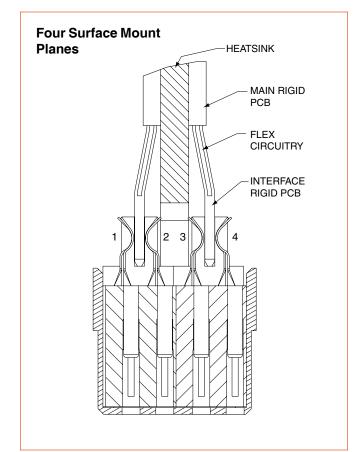
GEN-X Contact Density



Staggered Grid Module Termination



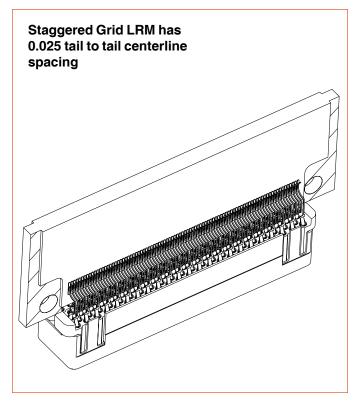
GEN-X Module Termination



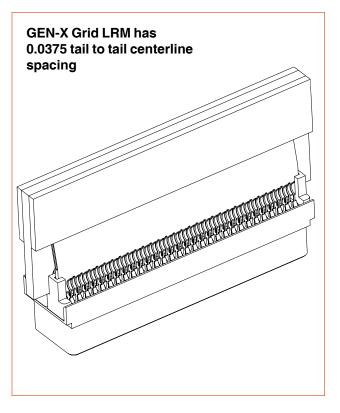


GEN-X PROVIDES HIGHER CONTACT DENSITY

Staggered Grid Tail to Tail Placement



GEN-X Tail to Tail Placement

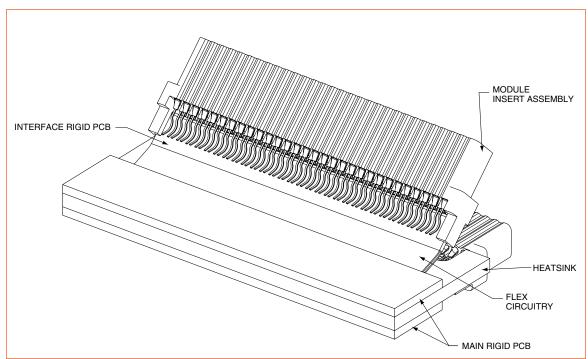


Low Mating Force MIL-DTL-55302

Accessories/Install

Rectangular

GEN-X is Designed to Terminate to Rigid-Flex PCB Attachment





CONTACT PATTERN & ARRANGEMENTS

Introduction/ Pkg. Solutions/ Brush Contact

M (Line Replaceable Modules)
ons/ Hybrids - Fiber Optics/ | Staggered,
cories Hi Speed/RF/Power GEN-X

Ruggedized VME64x/ VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302
ng Conn./ | Hybrids - Signal/Power/ | Standard
pries/Install. | Coax/Fiber Optics | Brush

Low Mati
Docking Conn./
Accessories/Install

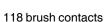
Rack & Panel Brush Ruggedized

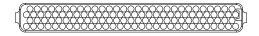
LMD/LMS Rectangular Interconnects

Other Rectangular Interconnects The LRM GEN-X pattern employs surface mount leads on a .0375 inch center line (module connector), yet provides higher contact density than the Staggered grid pattern. GEN-X provides all the same features as the staggered grid LRM:

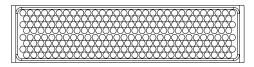
- GEN-X digital (brush) inserts are available in 118 and 236 pin contact counts.
- Digital contacts can also be combined with inserts for fiber optics, RF, poser and high speed contacts.
- Various combinations of inserts can be provided in 1, 2 or 3 bay shell configurations.
- Typical insert arrangements shown here are depicted in one bay drawing.

Consult Amphenol Aerospace for assistance in designing the LRM that best meets your specific application needs. See page 41 for an aid in selection and ordering of LRM and LRU interconnects.

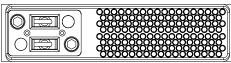




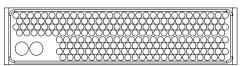
236 brush contacts



140 brush contacts plus an insert for 2 fiber optic MT ferrules*



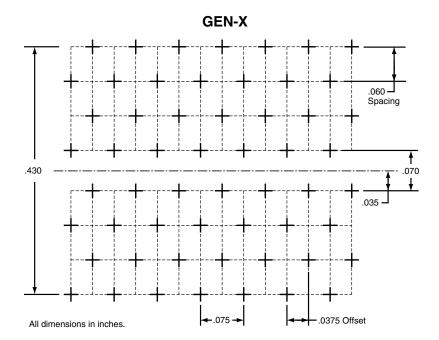
212 brush contacts plus 2 sz. 16 power or coax contacts



* MT ferrules are not supplied by Amphenol Aerospace. see page 28 for more information on LRMs with MT ferrules.



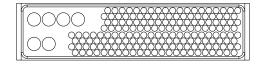
Example of a 3 bay GEN-X backplane connector.



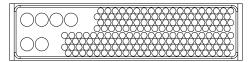


Example of a 2 bay GEN-X module connector.

170 brush contacts plus 6 sz. 16 power or coax contacts



170 brush contacts plus 4 fiber optic termini and 2 sz. 16 contacts



Amphenol Aerospace

LRMS WITH FIBER OPTIC TERMINI

High speed fiber optic transmission is available within LRM connectors for use in advanced avionics systems. Optical performance of fiber optic termini within in LRM connectors are the same as termini used in circular connectors.*

Insertion losses range from .3dB to <1.5dB depending upon launch conditions, fiber NA, fiber size and the type of termination.

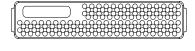
Inserts for MIL-T-29504/1, /2, /14 and /15 can be incorporated. Termini for LRMs can be supplied by Amphenol; consult for ordering information. The termini are determined by insert and shell style of the connector.

LRM interconnects can have hybrid arrangements of fiber optics with Brush contacts, as well as other contact types.

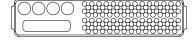


Staggered Grid Patterns with MIL-T-29504 Fiber Optic Termini

(These drawings are also shown with other staggered grid patterns on pages 19 and 20).



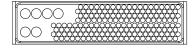
144 brush contacts plus an insert for 4 fiber optic termini



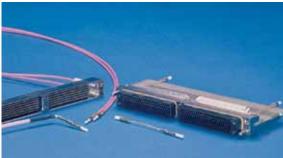
108 brush contacts plus an insert for 4 shielded contacts and an insert for 4 fiber optic termini

GEN-X Patterns with MIL-T-29504 Fiber Optic Termini

(This drawing is also shown with other GEN-X patterns on page 26).



170 brush contacts plus an insert for 4 fiber optic termini plus 2 sz. 16 contacts



Examples of LRM connectors with fiber optic multi-mode termini in combination with brush contacts.

*For more information on Amphenol fiber optic circular connectors, see Amphenol Circular Interconnects Catalog 12-C3, Fiber Optic section

Brush Low Mating Force MIL-DTL-55302

Coax/Fiber Optics Accessories/Install

Rectangular

LRMS WITH INSERTS FOR MT FERRULE FIBER OPTICS

Through Amphenol's LRM design flexibility, inserts are available to house high speed MT ferrules which can have 12 fiber lines per ferrule or 24 fiber lines per ferrule. MT ferrules are not supplied by Amphenol; they must be purchased separately.

Termini for rectangular LRM connectors are determined by insert and shell style of the connector.



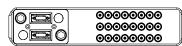
Example of an LRM module connector with MT fiber optic inserts in combination with inserts for brush LVDs and digital contacts.

Staggered Grid Patterns with MT Ferrule Fiber Optics

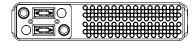
(These drawings are also shown with other staggered grid patterns on pages 19 and 20).



Insert with cavities for 6 fiber optic MT ferrules



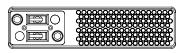
Insert with 8 brush differential pairs plus an insert for 2 fiber optic MT ferrules



Insert for 108 brush contacts plus an insert for 2 fiber optic MT ferrules

GEN-X Patterns with MT Ferrule Fiber Optics

(These drawings are also shown with other GEN-X patterns on page 26).



140 brush contacts plus an insert for 2 fiber optic MT ferrules

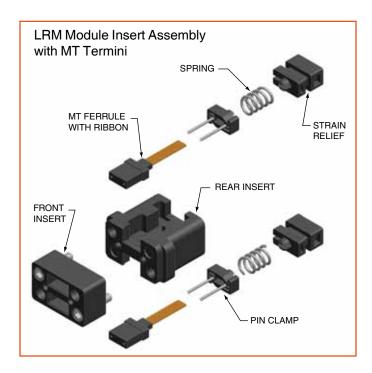
LRM Backplane Insert Assembly
with MT Termini

FRONT
INSERT

REAR
INSERT

MT FERRULE
WITH RIBBON

Amphenol can supply optical backplane assemblies; see more information in the Other Board Level and Rectangular Interconnects Section on page 117.



Amphenol Aerospace

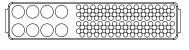
RF MODULES, LRMS WITH HIGH SPEED CONTACTS

LRM inserts have been designed to accommodate the following RF and high speed coaxial contacts:

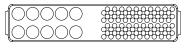
- Size 16 M39029/79 & /80 shielded contacts
- Size 12 coax for DC-65 GHz
- Size 8 coax for DC-32 GHz
- SMPM RF contacts*
- Hybrid arrangements with RF or high speed shielded contacts and brush contact combinations

Staggered Grid Patterns with RF/Coaxial Contacts

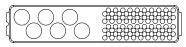
(These drawings are also shown with other staggered grid patterns on pages 19 and 20).



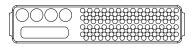
108 brush contacts plus an insert for 8 SMPM* style RF contacts



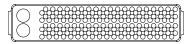
80 brush contacts plus an insert for 10 SMPM* style RF contacts



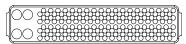
80 brush contacts plus an insert for 6 RF contacts



108 brush contacts plus inserts for 4 shielded contacts and 4 fiber optic termini



152 brush contacts plus an insert for 2 SMPM* style RF contacts

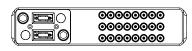


152 brush contacts plus an insert for 4 sz. 16 shielded contacts

Amphenol has also developed inserts with brush differential pair contacts that are 100 ohm matched impedance. These support data rates with excess of 1.2 Gbps.

Staggered Grid Patterns with LVDS Differential Pairs

(These drawings are also shown with other staggered grid patterns on page 20).



8 brush differential pairs plus an insert for 2 fiber optic MT ferrules



16 LVDS differential pairs



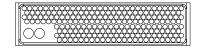
RF module and backplane with size 8 coaxial contacts



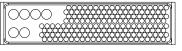
Staggered grid module with cavities for size 12 coaxial contacts

GEN-X Patterns with RF/Coaxial Contacts

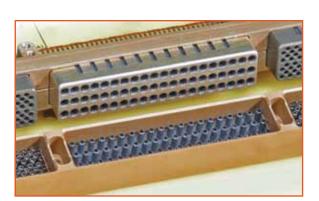
(These drawings are also shown with other GEN-X patterns on page 26).



212 brush contacts plus an insert for 2 sz. 16 shielded contacts



170 brush contacts plus an insert for 6 sz. 16 shielded contacts



Module and backplane with LVDS differential pair brush contacts

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install

ctangular

See more information on SMPM RF contacts in Other Rectangular Interconnects Section, page 126. SMPM RF contacts can be supplied by Amphenol SV Microwave. Phone: 561-840-1800 Website: www.svmicrowave.com

60,

Docking Conn./

LRM Interconnect Options

POWER SUPPLY MODULES, LRMS WITH RADSOK®

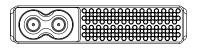
Power Supply Modules

Amphenol Aerospace

Amphenol has designed several custom 270VDC sections which are capable of providing corona-free operation at 75,000 ft. They utilize size 22D contacts and are available in both crimp and compliant pin terminations.

Amphenol has developed the patterns shown below that incorporate 270 VDC power modules.

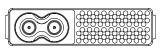
(These drawings are also shown with other staggered grid patterns on page 19).



108 brush contacts plus 270 VDC power input



Power supply modules



80 brush contacts plus 270 VDC power input

LRM Connectors with RADSOK® Contacts



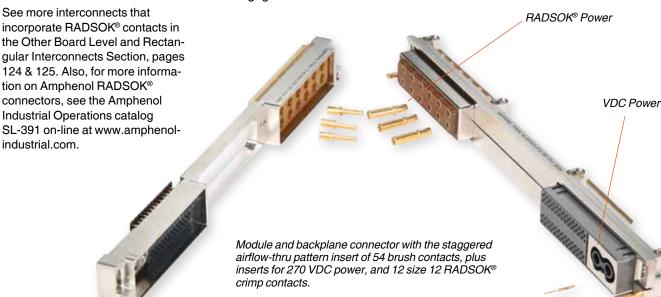
High Amperage RADSOK® socket contacts have been designed into LRM connectors in response to customer needs for passing of larger amounts of current with lower mating forces which standard contacts will not handle. The connector design shown at right has 8 groups of 3 bussed RADSOK 3.6mm sockets (24 contacts total). Each group of 3 is expected to handle a maximum of 140A. Mating pins for the RADSOK® sockets are press-fit into aluminum bus bars behind the motherboard connector.



The RADSOK® socket cylinder within female contact has several equally spaced longitudinal beams twisted into a hyperbolic shape. As the male pin is inserted, axial members in the female half deflect, imparting high current flow across the connection with minimal voltage loss. The hyperbolic, stamped grid configuration ensures a large, coaxial, face-to-face surface area engagement.



LRM inserts with RADSOK® high amperage



Hi-Speed LRM Connectors



NEW LRMS PROVIDE HIGHER SPEED DATA TRANSFERENCE

New/Featured Product

Amphenol's LRM connectors meet today's need for high speed interconnects for harsh environments. Constantly evolving and striving to meet the needs of higher data transfer rates within a board level product, Amphenol has developed LRM's to meet this challenge. These LRMs are designed, or can be configured, to achieve data rates up to 6.25 Gb/s and include all the features of our rugged and reliable staggered grid LRM series:

- Brush contact interface
- ESD protection (Level 2 flight line classification)
- Connector float
- Guide pins and polarization keys
- Metal shells
- Modular design (hybrid configuration available)
- Accepts wide range of board packages
- Accomodations for custom modular offsets

In addition, the new GigaStak $^{\text{TM}}$, GigaStak-LG $^{\text{TM}}$ and DigiStak $^{\text{TM}}$ Series incorporate Amphenol's cStack™ solderless termination technology (see page 35 for details).

Versatility

Unique flex and cStack terminations accommodate a variety of mounting configurations and a wide range of board packages. Connectors can terminate in a variety of ways:

- "traditional" 2 board/heatsink package
- to one or both sides of a single board
- as an offset board package

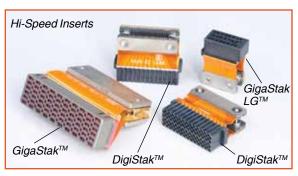
DigiStak module connectors allow mating to existing configurations of backplane connectors (users can upgrade solder termination module connectors to the solderless cStack termination).

The Hi-Speed Family of LRM Connectors and associated data rates includes:

Gigastak[™] - 6.25 Gb/s

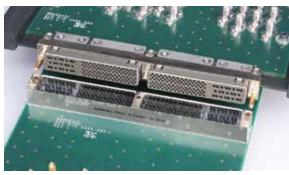
Inserts

- Gigastak LG™ 3.125 Gb/s
- Digistak[™] & Digistak-X[™] 3.125 Gb/s
- Standard Staggered Grid 1.25 Gb/s

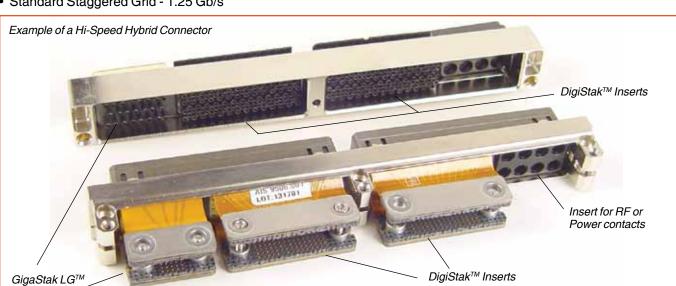




GigaStak™ Hi-Speed Inserts (left & right: 60 Brush differential pairs; middle: 18 Brush differential pairs plus 180 Brush low speed signal contacts)



Hybrid Connector that has GigaStak-LG™ and DigiStak™ Inserts, shown on Testing Boards



VITA 60,

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Instal

Introduction/ Pkg. Solutions/ Brush Contact

GIGASTAK™- THE HIGHEST DENSITY HI-SPEED CONNECTOR

New/Featured Product

Amphenol has taken the proven and highly reliable LRM Brush connector and incorporated the cStack™ termination technology - giving the user hi-speed signal options up to 6.25 Gb/s and a solderless termination to their CCA.

Through strategic placement of signal and ground contacts, each insert arrangement is optimized for the perfect balance of impedance control and cross-talk mitigation for a given data rate.

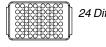
ntacts, alance of

GigaStak™ Backplane Connector

GigaStak Features:

- Hi-Speed connector designed for both single ended and differential signals
- Supports data rates of 6.25 Gb/s
- High density providing 30 differential signals per linear inch
- Designed for 100 ohm differential impedance
- Optimized cross-talk

GigaStak Patterns



24 Differential Pair*



36 Differential Pair*

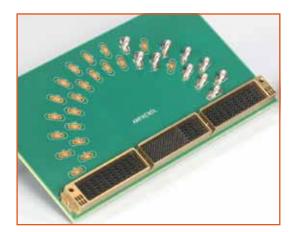


48 Differential Pair*



60 Differential Pair

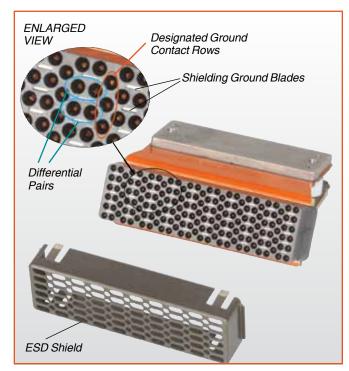
^{*} Consult Amphenol for availability.



Validation testing has been performed through both simulation (CST Microwave Studio) and actual testing of production connectors. Test reports, touchstone fles and hardware are available for review.



GigaStak™ Module Unassembled



GigaStak 60 Differential Pair Insert with ESD Shield Exploded and Enlarged Section



GIGASTAK-LG™

New/Featured Product

The GigaStak-LG™ inserts provide hi-speed data transference, utilzes cStack solderless termination, and can be combined with low speed signal contacts, as shown in the hybrid connector photo below.

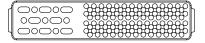
GigaStak LG Features:

- Hi-Speed connector designed for differential signals
- Supports data rates of 3.125 Gb/s
- Current Design has 8 differential pairs
- Provides 11 differential signals per linear inch
- Designed for 100 ohm differential impedance
- Optimized cross-talk

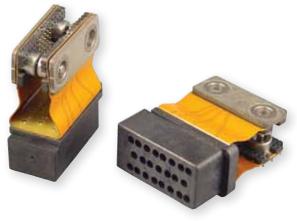
GigaStak LG Patterns



23 Differential Pairs



8 Differential Pairs and 108 Digital Contacts



GigaStak-LG™ Inserts with 8 Hi-Speed Differential Pairs

VITA 60, 66

Hi Speed

Low Mating Force MIL-DTL-55302

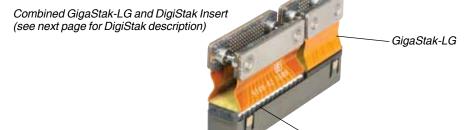
Coax/Fiber Optics

Accessories/Install

Ruggedized

Kectangular





DigiStak

DIGISTAK™ AND DIGISTAK-X™



Brush Contact Pkg. Solutions

LRM (Line Replaceable Modules)

Hybrids - Fiber Optics/ Hi Speed/RF/Power

VME64x 60,

High Density

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Rack & Panel Ruggedized

HSB3

Brush

Accessories/Install Docking Conn./

New/Featured Product

DigiStak™ Hi-Speed LRM Inserts

The DigiStak™ connector provides the standard staggered grid LRM pattern in a hi-speed connector that utilizes cStack solderless termination.

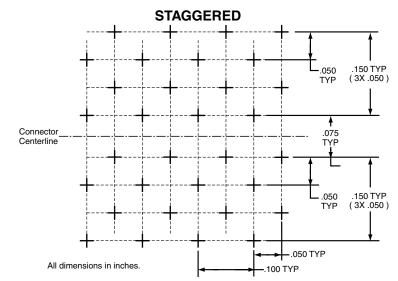
DigiStak Features:

- · Designed to improve data rates in existing staggered grid LRM inserts
- Supports data rates of 3.125 Gb/s
- Configurable for up to 20 differential pairs per linear inch
- Designed for 100 ohm differential impedance
- Optimized cross-talk

The DigiStak uses standard staggered grid insert pattern shown at right. (Pages 19 and 20 show the arrangements of staggered grid connectors which are also available in the Digistak connector).



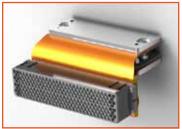
360 Pin DigiStak Module Connector



GEN-X

DigiStak-X™ Hi-Speed LRM Inserts

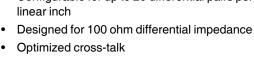
The DigiStak-X[™] connector provides the GEN-X grid LRM pattern in a hi-speed connector that utilizes cStack solderless termination.

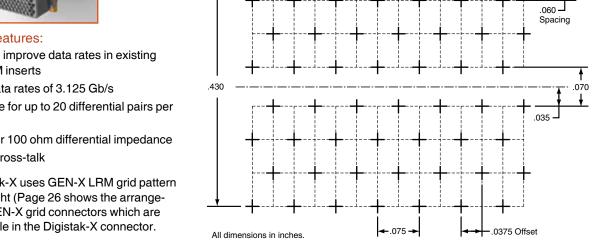


- **GEN-X LRM inserts**
- Configurable for up to 20 differential pairs per

The DigiStak-X uses GEN-X LRM grid pattern shown at right (Page 26 shows the arrangements of GEN-X grid connectors which are also available in the Digistak-X connector.



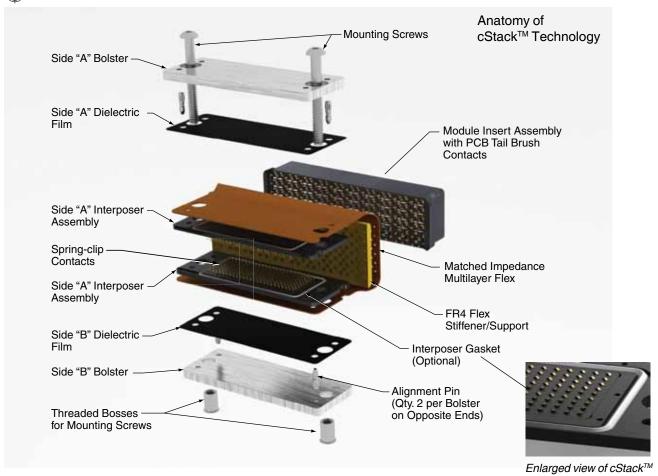




Amphenol Aerospace

CSTACK™ TECHNOLOGY

New/Featured Product



cStack[™] Termination

GigaStak™, GigaStak-LG™, DigiStak™ and DigiStak-X™ series incorporate Amphenol's cStack™ termination which provides the following features and benefits:

- Flex circuit assemblies that provide high speed, impedance controlled performance with high signal integrity.
- Flex can be electrically and mechanically customized to fit system specifications.
- Allows solderless interconnection between flex and board, eliminating a principal reliability problem with traditional flex assemblies.
- Standard and customized hardware are available which allow fast, solderless interconnection with only screw attachment to boards. Hardware uses captive attachment screws, eliminating loose component pieces.

See more information on Flex Circuitry in the Other Rectangular Interconnects Section page 121 of this catalog.

cStack™ Technology for Hi-Speed LRM Connectors



MODELING, SIMULATION, TESTING

(Line Replaceable Modules)

VME64x 60,

HSB3 Brush

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Ruggedized

Docking

Amphenol's Capabilities for Modeling and **Testing Hi-Speed Contacts and Connectors**

Signal Integrity

Amphenol SI engineers apply their expertise at the system level and work hard-in-hand with design engineering

Modeling & Simulation

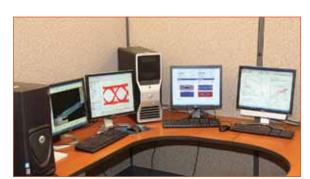
- Amphenol uses powerful modeling, simulation and analysis tools
- **CST Microwave Studio**
- Allows characterization of current designs
- Rapidly aids in development of new, high speed designs
- S-parameter and SPICE analysis

Test Capability

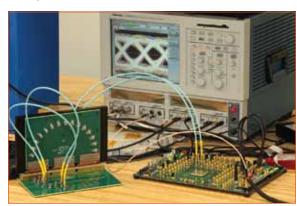
- System level (full thread) and "connector only"
- TDR with iConnect software
 - · Capability for S-parameter to 15 GHz
 - Time domain/eye pattern to 10 Gb/s
- BERT to 6.5 Gb/s

Customer Support

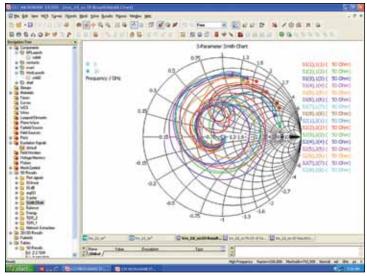
Amphenol SI engineers directly support customers on their specific applications providing S-parameter data and Touchstone files



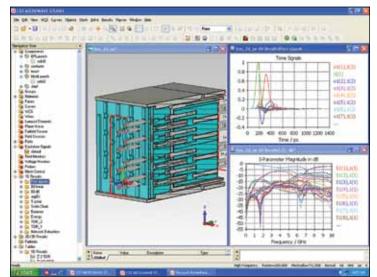
Hi-Speed Simulation Software used at Amphenol Aerospace.



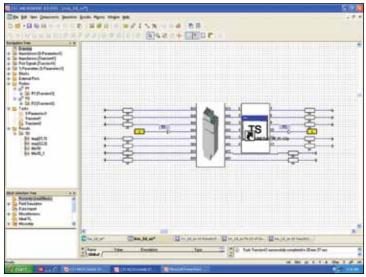
Test bench for LRM connectors. Computer screen shows a pass/fail mask test eye diagram.



Smith Chart



3DEM Model/S-Parameter



Circuit Simulation Schematic

Amphenol Aerospace

FLEX CIRCUITRY, COMPLIANT PINS, PC TAIL CONTACTS

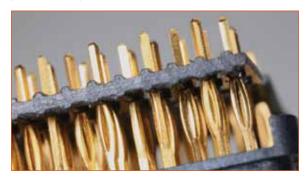
Flex Circuitry Used on LRM Connectors

Flex termination can be an integral part of the LRM connector insert as shown on top right photo or it can be used to attach the connector to the printed circuit board, as shown on next photo below.

When used for attachment to PC boards the flex circuitry is designed to meet specific length, current carrying capacity and to fit the precise geometric shape of the connector to board package. Amphenol APC (Amphenol Printed Circuits) designs and manufactures the flex circuitry. Sculptured® Flexible Circuits have built-in terminations which eliminate the failures associated with crimped or soldered-on contacts, as well as geometrically fitting the tight space requirements within a package. Flex material is strong and rigid, yet highly flexible. See page 121 in the Other Rectangular Products section for more information on Flex circuitry.



Compliant pin contacts are available for LRM backplane connectors. These are a press fit type contact which provide reliable, reduced cost, solderless mounting to printed circuit boards. Connectors are sold completely assembled with compliant pins and they accommodate boards with minimum of 0.125 inch thickness and 0.025 ±.002 plated through holes.



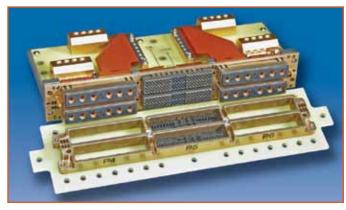
LRM backplane insert with compliant pins



LRM backplane insert with compliant pins for power contact termination



LRM module inserts with flex termination



Flex circuitry used to attach to PC boards - designed to fit specific board requirements

PC Tail Contacts

LRM modules can be designed with PC tail contacts for solder mounting on printed circuit boards or flex circuits. These are called I/O (input-output) LRM modules and have staggered grid pattern.



LRM module inserts (showing front and back of inserts) with PC tails in staggered grid pattern

Low Mating Force MIL-DTL-55302

ELECTROSTATIC DISCHARGE (ESD) PROTECTION

Introduction/ Pkg. Solutions/ Brush Contact

Ruggedized

VME64x /
VITA 60, 66

High Density
HSB3 HDB
Hi Speed

Low Mating Force MIL-DTL-55302

Docking Conn./ | Hybrids - Signal/Power/ | Standard
Accessories/Install. | Coax/Fiber Optics | Brush

Rack & Panel Brush Ruggedized

LMD/LMS Rectangular Interconnects

Other Rectangular Interconnects Amphenol has developed cylindrical and rectangular connectors which protect sensitive components from Electrostatic Discharge (ESD) without diodes, varistors, gas tubes, or "experimental" semiconductive materials.

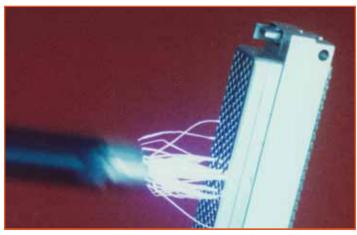
These connectors utilize the Faraday Cage principal to shunt electrostatic discharge events to the conductive enclosure on which the connector is mounted, thus never allowing the high voltage, high current discharge event to reside on any contacts.

The ESD protected connectors have the same physical envelope as their standard counterparts, and do not require special mounting or terminating techniques. All of the contacts remain fully functional, and electrical characteristics such as capacitance are not affected.

- LRM Connectors with ESD protection have the following features and benefits:
- Connector envelope is identical to unprotected design for most applications
- Exceeds protection requirements of IEC 801-2 and MIL-STD-1686:
 - Ensures that all components within a conductive enclosure are not subjected to more than 10V during electrostatic discharges between –26 KV and +26 KV
- Voltage observed on contacts during ESD events:
 <10V (at 1 megohm)
- Current observed on contacts during ESD events:
 < 100 milliamperes (at 2 ohms)
- Response time is instantaneous (voltage and current are maximum values)
- Maximum ESD voltage tested to ±26KV
- No capacitive loading
- Eliminates the need for discrete components (such as diodes) and maximizes printed circuit board real estate for equipment housed in conductive enclosures which require ESD protection as freestanding units
- Operating voltage of connectors not effected for most designs
- Pulse life infinite

ESD protection is standard on the Amphenol Ruggedized VME64x connectors (see page 43) and offers all the above features and benefits.

There are many drop-in replacement ESD protected connectors for retrofitting existing programs which have a conductive enclosure and require ESD protection as free-standing equipment.



ESD testing on LRM rectangular connector (actual photo)

What is Electrostatic Discharge (ESD)?

Electrostatic Discharge is the rapid transfer of a static electric charge from one body to another. A static electric charge consists of either a surplus or depletion of electrons on a body, which gives that body a potential or voltage relative to ground (or another body). The discharge is extremely fast (less than 1 nanosecond risetime) and the current flow may exceed 100 amps!

Static electricity is normally the result of two materials transfer-

Static electricity is normally the result of two materials transferring charges when rubbed or separated, such as shoes scuffing across a dry carpet, or sheets of untreated plastic being separated. This phenomena is commonly referred to as the triboelectric effect.

The voltage developed due to the triboelectric effect depends on the materials involved, the quantity and type of contact, and relative humidity. In a dry environment a person can accumulate a charge of up to 25 KV. In a moist environment a person's potential is reduced due to the effect of moisture on the insulating properties of materials.

What is a Faraday Cage?

A Farady cage is a conductive enclosure. It may be solid in form such as a sheet-metal encloser, or it may be full of apertures, such as a wire cloth box. When a charge is placed on a faraday cage the electrons which make up the charge, having like polarity, try to position themselves as far as possible from each other. This places the electrons on the outer surface of the enclosure, leaving the inner surface uncharged. The charge on the outer surface does not induce a charge on any neutral object inside of the faraday cage, and therefore does not try to transfer itself onto the internal object. Neutral objects (such as IC's) inside of a faraday cage are thereby protected from ESD activity external to the faraday cage.

The voltage and current observed on neutral objects within a faraday cage during ESD events are due to the secondary effects of ESD. These include Electromagnetic Interference (EMI), magnetic and electrical field coupling. The faraday cage of the Amphenol ESD protected connectors has been designed to minimize these effects.

The Faraday cage on Amphenol ESD protected connectors intercepts electrostatic discharges from the contacts in the unmated state, while maintaining each contact's isolation when the connector is mated.

Publication L-2075, "ESD Attenuation Test Procedure for Connectors with Faraday Cage Protective Structures" is available as a reference document. Contact Amphenol Aerospace for any further information on ESD protection connectors.

Amphenol Aerospace

TEST PROBE KITS

Test Probe Kit - For use with Amphenol Brush Contacts in LRM Connectors

Amphenol supplies a test probe kit especially designed for probing brush contacts to insure that they are properly wired within a connector. It consists of a plastic holder, insert, and two contacts which are usable for either the backplane or module connector. It is suggested that the user buy two kits if they are using connectors of two genders. The kits are not convertible after assembly. Instructions for use of Backplane Test Probe -

Slide the insert back over the wire, and crimp contact on. Follow crimping procedure below. Then snap the insert contact assembly into the holder.

Instructions for use of Module Test Probe -

Slide holder over wire, and then crimp contact. Follow crimping procedure below. Slide the insert on the contact and seat it against the shoulder. Slide the holder forward and snap it onto the insert.

Crimping Procedure -

Using accepted industry procedures, strip wire end to be terminated 1/8 to 5/32 inches. Care should be taken not to nick wire strands. Assemble the M22520/2-01 crimp tool and M22520/2-27 positioner and place tool selector in correct setting for wire size. Selected wire size must not have an insulation diameter greater than .062 for the module probe and not greater than .038 for the backplane probe.

| AWG | 22 | 24 | 26 | 28 |
|-----|----|----|----|----|
| SEL | 5 | 4 | 3 | 2 |

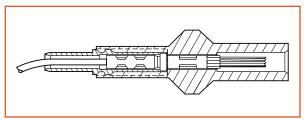
Insert stripped wire end into contact wire well. Strands should be visible in wire well inspection hole. Bottom contact and wire assembly in positioner and close handles of crimp tool to complete crimp. Handles will not open unless full crimping cycle has been completed. Part number for ordering test probe kit is 11-10400-23.

ATTENTION:

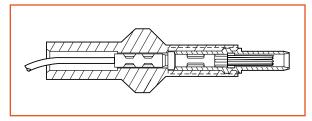
Probing brush contacts with anything other than a brush contact may damage or degrade the brush contact performance.



Test probe kit 11-10400-23 components



Test probe for brush contact in LRM backplane



Test probe for brush contact in LRM module

VITA 60,

Brush

Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power/ Coax/Fiber Optics

Accessories/Install

ectangular

REMOVAL, REPLACEMENT & INSERTION TOOLS

Docking Conn./

Brush Contact Removal, Replacement and Insertion for Backplane Staggered Grid Connectors

Contacts with solder tails within backplane LRM connectors with staggered grid are not removable or replaceable. User must replace the insert assembly.

Compliant tail type contacts within backplane LRM connectors with staggered grid are removable and replaceable.

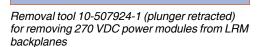
Instructions for removal of compliant contacts: From the back of PC board side, push contact out through the front of the connector assembly with contact removal tool #10-507941-1.

Instruction for replacement/insertion of compliant contacts: Using tweezers or fingers, carefully place the replacement contact, tail first, into the appropriate contact cavity in the front of the connector. Tweezer tip must not enter sleeve. Push contact into the cavity with a flat edged rod of suitable diameter to cover entire contact sleeve circumference until contact sleeve is flush with adjacent contacts. Do not push against wires or bend sleeve.



Removal tool 10-507941-1 for removing compliant contacts from LRM backplanes





270 VDC Power Module Removal, Replacement and Insertion for Backplane Staggered Grid Connectors

270 VDC power modules can be removed and replaced within the power insert of an LRM connector.

Instructions: Using removal tool #10507924-1 with plunger retracted, push tool down over the power module from the mating end until retention tines are released. Use plunger end of tool to push power module out of the rear the connector.

The power module may be re-installed by hand by pushing it from the rear of the connector. Push it forward until the retention clips snap into the power insert cavity of the shell.

The size 22D power contacts within the power modules are installed and removed with tool M81969/14-01.



Exploded view - tool 10-507924-1 has removed power module from backplane. (size 22D contacts shown removed)

For Module Staggered Grid Connectors:

Contacts within module LRM connectors with staggered grid are not removable or replaceable. User must replace the insert assembly.

Amphenol Aerospace

Interconnects from Amphenol A FORM THAT CAN BE COPIED AND FAXED TO AMPHENOL

Aid in Selection and Ordering of LRM and LRU

The following are questions to be considered when inquiring about Amphenol LRM/LRU Interconnects. The answers to these questions will help the Amphenol marketing and engineering team to determine the best board level interconnect to meet your particular needs.

You can copy this page and write your comments on it, and then fax it back to Amphenol Aerospace, Sidney, NY. Include your name and company information at the bottom. Fax number: 607-563-5351, Attn: LRM product marketing. Or call Amphenol at 607-563-5011 and ask for technical information on LRM products.

| Footprint Required: Staggered, GEN-X, NAFI, UHI | D, Chevron, VME or other | : | | | |
|--|---------------------------------|--------------------------------|-----------------------------|-----------|--|
| Contacts Required: | | | | | |
| Digital: | | | | | |
| Fiber Optic: | | | | | |
| Power: | | | | | |
| RF: | | | | | |
| LVDS: | | | | | |
| Module Requirements: | | | | | |
| Heatsink Thickness: | | | | | |
| Total Board Package Thic | | | | | |
| Pitch (module to module): | | | | | |
| Straddle Mount, Clamshel | l or Right Angle: | | | | |
| Cover Attachment: | | | | | |
| Keying: | | | | | |
| Backplane Requirements: | | | | | |
| Termination Style: | | | | | |
| Termination Stickout (Con | | | | | |
| Shell Grounding: | • | | | | |
| Function Requirements: | | | equirements: | | |
| Operating Voltage: | | Level of Corrosion Resistance: | | | |
| Operating Temperature: _ | | | | | |
| Current Rating: | | | uirements: | | |
| Ambient Temperature: | | | | | |
| Mating Cycles: | | | | | |
| ESD: Yes or No | | | | | |
| Float: Yes or No | | | | | |
| Humidity Conditions: | | - | | | |
| Please fill out information below. T | hank you for writing clearly. F | Fax to 607-563-535 | , attention: LRM product ma | arketing. | |
| First Name | Last Name | | Phone Number | Date | |
| Title | Dept./Mail Stop | | Fax Number | | |
| Company Name | | Address | | | |
| City | State | Zin Code | Fmail Address | | |

Amphenol Ruggedized VME64x, VITA 60, 66 Interconnects



TABLE OF CONTENTS

Amphenol Ruggedized VME64x & VITA 60/ VITA 66 Interconnects

| м | Table 01 Contents |
|---|--|
| | Ruggedized VME64x Features & Benefits, |
| | Ruggedized VME64x Adapter43 |
| | VME P0/J0 Fiber Optic Interconnects |
| | VITA-66.1 Fiber Optic Interconnects44 |
| | VIPER® Interconnects (Compatable with |
| | VITA 46 & VITA 48 |
| | |



VME & VITA Typical Markets:

- Military & Commercial Avionics
- Military Vehicles
- Missiles/Ordnance

- Missile Defense
- C4ISR
- Radar



Ruggedized VME64x Interconnects



FOR ATTACHMENT TO VME64X PRINTED CIRCUIT BOARDS

Amphenol Aerospace developed the Ruggedized VME64x in response to the military trend towards VME64x and the utilization of COTS Boards and Chassis.

Many different companies manufacture "Ruggedized VME cards", but they still use the standard VME

COTS (Commercial Off The Shelf) connector interface. In a harsh militaryenvironment the COTS VME connector interface can fail, negating the ruggedization of the cards.

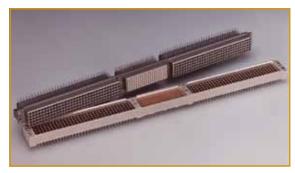
The Amphenol Ruggedized VME64x interconnect has a more rugged interface than standard connectors for improved vibration durability. It meets the needs for a harsh environment connector requiring Level 2 maintenance. Military and commercial aviation, military vehicles and GPS systems are examples of markets that need the ruggedized VME64x connector solution from Amphenol. The Amphenol Ruggedized VME64x connector mounts to

standard VME64x cards and backplanes, but it does not mate to other types of VME commercial connectors.

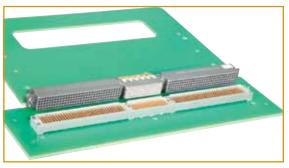
Features and benefits include:

- Metal shells mount directly to the standard VME card mounting holes, providing support and protection to the inserts in the module and additional stiffness to the backplane
- The metal shells create a faraday cage around the contacts, preventing ESD (Electrostatic Discharge) into the contacts (module only)
- Robust contact system
- 3 module inserts in one unified shell; each can have different interconnect combinations:
 - P1. P2 and 2mm electrical P0
 - P1 and P2 combination
 - P1, P2 and fiber optic MT ferrules in the P0 position
- Inserts are designed to customer specifications
- Thru-hole solder tail or solderless termination is available on the backplane connector.





Amphenol's ruggedized VME64x module and backplane connectors were developed to meet more rugged harsh environment applications.

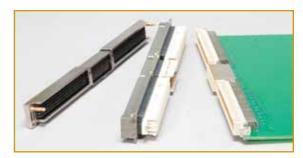


Ruggedized VME64x module and backplane connectors on a circuit board.

Ruggedized VME64x Adapter with Brush Contacts

"Cocooning" of COTS components has been successful in military applications. Amphenol supplies an adapter interconnect system for "cocooning" of COTS VME64x daughtercards.

The ruggedized VME64x adapter system provides the durable brush contact as the primary interface, and integrates the three connectors into a singular metal shell, providing passive ESD protection to the module connector. The back of the module connector mates to standard COTS VME64x daughtercards, isolating them from harsh environments.



Ruggedized VME64x backplane (left), and module adapter (center) and a typical COTS VME64x circuit board (right).

LRM (Line Replaceable Modules Hi Speed/RF/Power

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install

ectangular



VME P0/J0 Interconnects, VITA Type Interconnects

WITH MT FERRULE FIBER OPTICS

Brush Contact Solutions

> |Hybrids - Fiber Optics | Staggered | Hi Speed/RF/

LRM (Line Replaceable Modules)

New/Featured Product VME P0/J0 Fiber Optic Interconnects

Amphenol provides a fiber optic interconnect for attachment to standard VME-64x cards and backplanes for the P0 and J0 locations of the boards. It uses "MT" ferrules and it is used in place of P0/J0 electrical applicable connectors. MT ferrules are not supplied by Amphenol; they must be purchased separately. Performance features include:

- Tested to IEEE 1156.1-1993
- Operating temperature from -55°C to +125°C
- Shock: 100g, 6ms, 1/2 sine, 18 pulses Shock: 30g, 6ms, 1/2 sine, 18 pulses
- Sine vibration: 10g, 40 min./axis, 3 axis
- Random vibration: 0.15g2 Hz, 40 min./axis, 2 axis
- ESD: 15KV/150 pF

Amphenol's VME P0/J0 fiber optic connectors are used in military and commercial aviation, military vehicles and GPS systems. They are designed to customer specifications. Consult Amphenol Aerospace for further information.



VME P0/J0 Connectors with MT ferrule fiber optics

| VME P0/J0 | VME P0/J0 | |
|---------------|---------------|--|
| Module MT | Backplane MT | |
| Connector | Connector | |
| Part Number | Part Number | |
| 10-509050-011 | 10-509050-041 | |

VITA-66.1 Fiber Optic Interconnects

Amphenol's proposed VITA-66.1* MT connector provides a reliable high speed connection for the most extreme commercial and military environments.

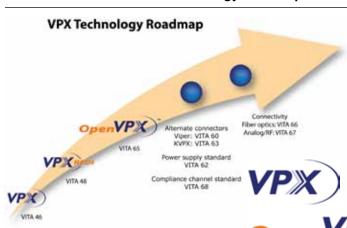
This ruggedized interconnect is among the highest density of connector products on the market.

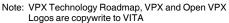
MT ferrules can be accommodated as follows:

- Up to 24 fiber optic channels per MT ferrule
- Up to 48 channels per connector

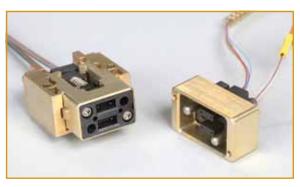
MT ferrules are not supplied by Amphenol; they must be purchased separately.

Amphenol's VITA 66.1 Interconnect is Designed in accordance with the VPX Technology Roadmap





* VITA-66 supersedes VITA-46.



VITA-66.1 Connectors with MT ferrule fiber optics

| VITA-66 Connectors with 2mm Dual Spring | | | |
|--|---------------|--|--|
| Module MT Backplane MT Connector Connector Part Number Part Number | | | |
| 10-504637-002 | 10-504639-002 | | |

| VITA-66 Connectors | | | | |
|---------------------------------------|--|--|--|--|
| Module MT Connector Part Number | Backplane MT Connector Part Number | | | |
| 10-504637-004 | 10-504639-002 | | | |

VIPER® Hi-Speed, High Density Modular Interconnects

Amphenol Aerospace

VITA 46, VITA 48 & VITA 60 FOOTPRINT COMPATIBLE

New/Featured Product

The VIPER® Connector is a shielded, high-density, high speed modular interconnect with press-fit termination.

Amphenol Backplane Systems* developed the VIPER interconnect platform to meet or exceed future avionic high-level requirements such as:

· High-level vibration and mechanical shock protection

Condensing moisture resistance

Ruggedization in packaging that can scale to higher bandwidths without costly and timeconsuming chassis redesigns. The VIPER connector platform offers the ability to scale from 80 Mbps to over 10 Gb/s while retaining the same Vita 46 platform slot pitch at 20.3mm to 25.4mm.

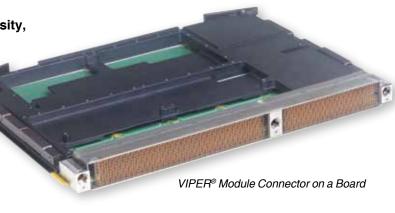
Key Features of VIPER®

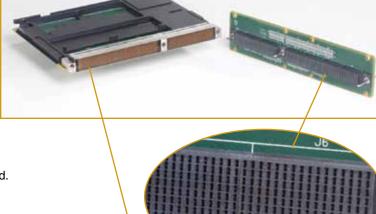
- Fully footprint-compatible with VITA 46 and VITA 48 standards
- Hi-Speed: the VIPER is designed for 10 + Gb/s data rate performance
- 100 ohm impedance for differential pair configuration
- The daughtercard assembly is optimized for differential pair architecture on a 1.8mm x 1.35mm grid.
- The daughtercard is waferized, and provides singleended and power wafer options integrated onto a stainless steel stiffener with stainless steel frame** and keying elements
- The backplane has signal contacts that incorporate a highly reliable 4-point-of-contact beam design, and ground contacts which are robust compliant pin & contact fork design
- ±0.52mm nom. translation in fully mated condition
- ESD protection supports 2-level maintenance designs
- Flexible modular design is ideal for standard 3U and 6U applications, as well as unique custom configurations incorporating RF and fiber optic MT solutions

Amphenol's VIPER® Interconnect is Designed in accordance with the VPX Technology Roadmap



- Consult Amphenol Backplane Systems for more information on VIPER® Interconnects:
 - Amphenol Backplane Systems, 18 Celina Avenue, Nashua, NH 03063 Phone: 603-883-5100. Website: www.amphenol-abs.com
- ** Light-weight alternative available; consult Amphenol Backplane Systems.

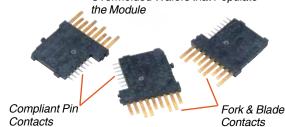




VIPER® Backplane Closeup



Overmolded Wafers that Populate



LRM (Line Replaceable Modules Hi Speed/RF/Power

Low Mating Force MIL-DTL-55302

Accessories/Instal



VIPER® Hi-Speed, High Density Modular Interconnects (VITA 60)

SPECIFICATIONS

Brush Contact

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/ Hi Speed/RF/

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Accessories/Install

Ruggedized

Docking

New/Featured Product **VIPER® Electrical Specifications**

Data Rate: 10 Gbps

Differential Impedance: 100 ohms

- Differential Insertion Loss: -5 dB up to 5 GHz (10 Gbps)
- Differential Return Loss: -5 dB up to 5 GHz (10 Gbps)
- Far End Crosstalk: -35 dB up to 8 GHz
- Near End Crosstalk: -33 dB up to 8 GHz
- Signal Contacts: 1 amp
- Power Wafer: 12 amps per wafer at 30° C T-Rise
- Compliant Pin to Plated Through Hole Resistance: 1 milliohm max
- Dielectric Withstanding Voltage: 500 volts RMS
- Insulation Resistance: 1000 megohms



- Signal and Ground Contact:
- Normal Force: 85 grams per
- Engagement force: 45 grams max, 35 grams typical
- Separation force: 30 grams max, 25 grams typical
- Durability: 500 cycles minimum
- Backplane Signal and Ground Compliant Pin:
 - Insertion Force: 4.9 kilograms maximum: 1.5 kilograms to 4.9 kilograms depending on the surface finish of PCB
 - Retention Force: 1.4 kilograms minimum
- Daughtercard Wafer Compliant Pin:
 - Insertion Force: 1.8 kilograms to 3.6 kilograms depending on the surface finish of PCB
 - Retention Force: 1.6 kilograms minimum
- Radial hole wall deformation: 0.04mm per side measured from drilled hole
- Axial hole wall deformation: 0.03mm measured in the vertical plane
- Translation: ±0.52mm nom. fully mated
- Slot Pitch: 20.30mm

VIPER® Environmental Specifications

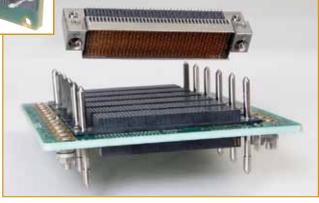
- Temperature: >55°C to 125°C
- Random Vibration: 90 minutes per X, Y and Z axis at 0.6 G²/Hz
- Mechanical Shock: 50 G'rms in Y axis, 80 G'rms in X and Z axis, 11 milliseconds, half sine
- Temperature Life: 1000 hours at 125°C

Printed Circuit Board Specifications

- Minimum Backplane and Daughtercard thickness: 1.85mm and 1.53mm
- Daughtercard pattern primary drilled hole size: 0.55mm
- Daughtercard pattern finished hole size: 0.46 ±0.05mm
- Backplane pattern primary drilled hole size: 0.65mm
- Backplane pattern finished hole size: 0.56 ±0.05mm
- See pages 96-98 for Amphenol Rack and Panel Connectors with Brush







Six VIPER® Backplane Connectors on a Board and one Mating Viper® Module above

VIPER® Materials and Finishes

Backplane Signal and Ground Contacts: C7025 copper alloy, 0.23mm. Finish is 0.00127mm nickel minimum all over per SAE-AMS-QQ-N-290, Class I. Selective 0.00127mm gold minimum per ASTM-B488, Type II, Grade C, Class 1.27 in the mating area. 0.0076mm 60/40 reflowed tin/lead minimum selectively plated in the compliant pin area.

Differential, Power, and Single-ended Daughtercard Wafer Leadframes: C7025 copper alloy, 0.38mm. Finish is 0.00127mm nickel minimum all over per SAEAMS-QQ-N-290, class I. Selective 0.00127 gold minimum per ASTM-B488, Type II, Grade C, Class 1.27 in the mating area. 0.0076mm 60/40 reflowed tin/lead minimum selectively plated in the compliant pin area.

Backplane Insulators and Daughtercard Wafer Insert Mold Material: Glass reinforced polyester (Liquid Crystal Polymer), UL 94V-0, color black.

Front and Rear Stiffeners: Stainless steel, 0.6mm, Type 301, 1/2 Hard. finish per Mill 2B.

Backplane Guide Pin: Stainless steel, Type 303, passivated. Daughtercard Connector Header** and Keying Components: Stainless steel, Type 440, passivated.

Light-weight aluminum header version is available. Consult Amphenol Backplane Systems.

AmphenolHigh Density HDB3/HSB3 Connectors

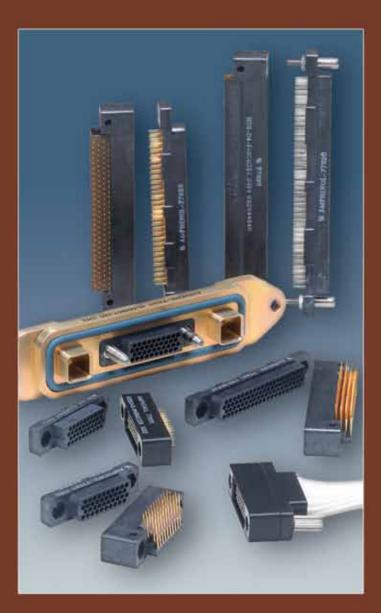


TABLE OF CONTENTS

Amphenol High Density HDB³ and HSB³ Connectors

| • | Table of Contents |
|---|-----------------------------------|
| • | Introduction - Features, Options, |
| | Performance |

HDB³

| • | HDB ³ Mother Board Connector | 50 |
|---|---|----|
| • | HDB ³ Daughter Board Connector | 51 |
| • | HDB ³ I/O Connector | 52 |
| • | HDB ³ Stacker Connector | 53 |

HSB

| H2B, |
|---|
| HSB ³ Mother Board Connector |
| HSB ³ Daughter Board Connector |
| • HSB ³ Arrangements |
| Recommended Board Layout - |
| HSB ³ Daughter Board |
| Recommended Board Layout - |
| HSB ³ Mother Board |
| |

| Hardware for both HDB ³ and HSB ³ | |
|---|----|
| Connectors | 59 |







HDB³ and HSB³ Typical Markets:

Transportation

- UAVs
- Medical Equipment
- Naval
- Military & Commercial Avionics
- High Definition Cameras

C4ISR





Amphenol® High Density HDB³ and HSB³ Connectors

INTRODUCTION: FEATURES & OPTIONS

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Ξ

60,

Brush

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Docking

New/Featured Product

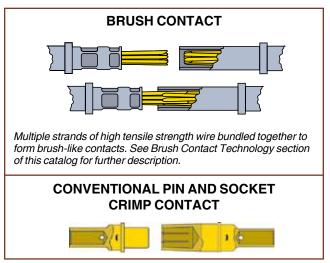
Amphenol's HDB3 High Density Brush Series with Tighter (.070 inch X .060 inch) **Staggered Grid Spacing**

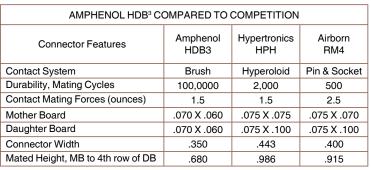
This new connector series of brush connectors incorporates a higher density contact pattern and lower mated height than Amphenol's standard low mating force rectangular connectors. HDB3 connectors utilize the same durable and reliable B3 brush contact in a tighter .070" X .060" staggered grid pattern.

HDB³ Advantages over Competitive **Connectors:**

- Higher density contact pattern
- Uses less board space
- Allows for shorter mated height
- Provides the durability and performance of the Brush contact
- Low cost

AMPHENOL'S BRUSH CONTACT - THE SUPERIOR CHOICE FOR BOARD LEVEL INTERCONNECTS







HIGH DENSITY STYLES

HDB³ Daughter Board/Mother Board



HDB³ Stacker



HDB³ I/O Connector



HSB³ High Speed

HSB³ High Speed Connectors are Capable of 3.125 **Gbps**



Amphenol® High Density HDB³ and HSB³ Connectors

INTRODUCTION: FEATURES & PERFORMANCE



VITA 60,

Low Mating Force MIL-DTL-55302 Accessories/Install



HBD3 120 pin Mother Board and Daughter Board

HDB3 & HSB3 HIGH DENSITY CONNECTOR **PERFORMANCE:**

100,000 mating cycles Durability Insertion/Extraction Force: 1.5 ounce typical per contact

Operating Temperature: -65° to 125°C

Current Rating: 2 amperes Hot swap 1 ampere

maximum (load dependent)

Insulation Resistance: 5 gigaohms minimum

Dielectric Withstanding

750 volts, 60 hertz, rms @ Sea Voltage:

Level, 250 volts, 60 hertz, rms @ 70,000 feet elevation

Solderability: MIL-STD-202, Method 208 Salt Fog: 48 Hours IAW MIL-STD-1344,

method 1001, test condition B

IAW MIL-STD-1344, method Humidity: 1002, type II

Vibration: 4 hours in each of 3 mutually perpendicular axes IAW MIL

STD-1344, method 2005, test

condition V, letter H

Shock: 1 shock along each of three

> mutually perpendicular axes IAW MIL-STD-1344, method

2004, test condition G

Data Rate (HSB3): Capable of 3.125 Gbps (consult

Amphenol for arrangement)

HDB³ Mother Board and Daughter Board Mated

FEATURES:

HDB3 & HSB3 HIGH DENSITY CONNECTOR

Polarization: "D" shaped design

Keying: Optional keys offer 36 unique

keying combinations

Guide Pins Optional guide pins provide

additional alignment

Radial Misalignment:

Capable of correcting up to a 020" initial radial misalignment

Angular Misalignment:

Capable of mating with up to a 2° initial angular misalignment

CUSTOM DESIGN AVAILABILITY:



and RF Contacts supplied by SV Microwave*

MATERIALS:

Insulator: Liquid crystal polymer, 30% glass

Contact: Wire: Beryllium copper per ASTM B197;

finish is gold per ASTM B488 over

nickel per AMS-QQ-N-290

Brass similar to UNS C33500; Holder: available finishes include gold per

MIL-G-45204, tin-lead per MIL-P-81728 or tin per MIL-T-10727 (RoHS

Compliant)

Stainless steel per AMS-5514, Sleeve:

passivated IAW QQ-P-35 (Daughter-

board, I/O and Stacker connector)

See more information on SMPM RF contacts in Other Rectangular Interconnects Section, page 126. SMPM RF contacts can be supplied by Amphenol SV Microwave. Phone: 561-840-1800 Website: www.svmicrowave.com



Amphenol® High Density HDB3 **Mother Board Connector**

DIMENSIONAL DRAWING & HOW TO ORDER

.335 MAX. .150 ±.005

E ±.020

.016 ±.001 TYP.

Brush Contact Solutions

| Hybrids - Fiber Opiics | Staggered | Hybrids - Fiber Opiics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

VME64x 60,

Hybrids - Signal/Power/ | Standard Brush Low Mating Force MIL-DTL-55302 Coax/Fiber Optics Accessories/Install Docking Conn./

Rack & Panel Ruggedized Brush

HDB3 MOTHER BOARD - HOW TO ORDER

Mates with:

- **Daughter Board**
- I/O
- Stacker

| 1. Connector Type | | | |
|--|--|--|--|
| HDB-M4 | | | |
| Designates HDB ³ Mother Board | | | |

| 1. | 2. | 3. | 4. | 5. | 6. |
|--------|-----------------------|-----------------------|-------------|-------------------------------|---|
| | Number of Contacts | Brush Wire Plating | Termination | Contact Termination Finish | Less Hardware (Purchased separately see pg XX for hardware options) |
| HDB-M4 | -040 | M | 24 | 2 | X |

Mother Board

Daughter Board

.086 MIN. DIA. THRU HOLE (USE NO. 2 SCREW)

.070 MIN DEEP (USE 3/16 HEX HEAD)

.350

.090 TYP. .030 TYP. →

2. Number of Contacts

| | Number of Contacts | Dimension A | Dimension C |
|-----|-----------------------|----------------|----------------|
| 040 | 40 | 1.375 | 1.075 |
| 060 | 60 | 1.725 | 1.425 |
| 080 | 80 | 2.075 | 1.775 |
| 120 | 120 | 2.775 | 2.475 |
| 160 | 160 | 3.475 | 3.175 |

3. Brush Wire Plating

| M | 0.000050 Au Min. thick over Nickel |
|---|------------------------------------|
| С | 0.000020 Au Min. thick over Nickel |

4. Termination

| | Туре | Stickout (Dim. E) |
|----|-------------------------|----------------------|
| 22 | PCB, Straight, .016 Dia | 0.120 |
| 23 | PCB, Straight, .016 Dia | 0.150 |
| 24 | PCB, Straight, .016 Dia | 0.180 |
| 26 | PCB, Straight, .016 Dia | 0.240 |
| 28 | PCB, Straight, .016 Dia | 0.300 |

5. Contact Termination Finish

| 2 | Gold plated in accordance with MIL-G-45204, Type II, .000030 Min. thick Gold over .000050 Min. thick Nickel | |
|---|--|---------|
| 5 | Tin plated in accordance with ASTM B545, .00010 Min. thick Matte Tin over .00010 Min. thick Nickel | |
| 6 | Tin-Lead plated in accordance with SAE-AMS-P-81728, .00010 Min. thick Tin-Lead over .00010 Min. thick Copper | |

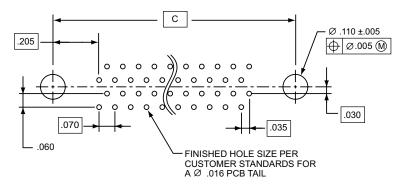
6. Hardware

Less Hardware

hardware options).

Hardware is purchased separately (see page 59 for

Mother Board Layout



Amphenol Aerospace

.086 MIN. DIA. THRU HOLE

(USE NO. 2 SCREW)

DIMENSIONAL DRAWING & HOW TO ORDER

HDB3 DAUGHTER BOARD - HOW TO ORDER

Mates with:

Mother Board

| | 1. | 2. | 3. | 4. | 5. | |
|-------------------|--------|-----------------------|-----------------------|-------------|-------------------------------|--|
| 1. Connector Type | | Number of Contacts | Brush Wire Plating | Termination | Contact Termination Finish | Less Hardware (Purchased separately see pg X for hardware options) |
| HDB-D4 | HDB-D4 | 040 | M | 01 | 2 | X |
| דטיטעח | | 0.0 | | • • | _ | 24 |

E ±.020 TYP PIN 1

Designates HDB3 Daughter Board

2. Number of Contacts

| | Number of Contacts | Dimen- sion A | Dimension C |
|-----|-----------------------|------------------|----------------|
| 040 | 40 | 1.375 | 1.075 |
| 060 | 60 | 1.725 | 1.425 |
| 080 | 80 | 2.075 | 1.775 |
| 120 | 120 | 2.775 | 2.475 |
| 160 | 160 | 3.475 | 3.175 |

3. Brush Wire Plating

| M | 0.000050 Au Min. thick over Nickel |
|---|------------------------------------|
| С | 0.000020 Au Min, thick over Nickel |

4. Termination

| | Туре | Stickout (Dim. E) |
|----|-----------------------------|----------------------|
| 01 | PCB, Right Angle, .016 Dia. | 0.090 |
| 02 | PCB, Right Angle, .016 Dia. | 0.120 |
| 03 | PCB, Right Angle, .016 Dia. | 0.150 |
| 04 | PCB, Right Angle, .016 Dia. | 0.180 |
| 06 | PCB, Right Angle, .016 Dia. | 0.300 |

5. Contact Termination Finish

| 2 | Gold plated in accordance with MIL-G-45204, Type II, .000030 Min. thick Gold over .000050 Min. thick Nickel | |
|---|---|--|
| 5 | Tin plated in accordance with ASTM B545, .00010 Min. thick Matte Tin over .00010 Min. thick Nickel | |
| 6 | Tin-Lead plated in accordance with SAE-AMS-P-81728, .00010 Min. | |

.060

0 0 0

0 0 0 0

0 0

thick Tin-Lead over .00010 Min.

.035

thick Copper

Ø .110 ±.005

⊕ Ø.005 M

BOARD

EDGE

Daughter Board Layout

6. Hardware

|--|

ORGANIZER (TO MAINTAIN PIN ALIGNMENT

INSTALLATION)

Hardware is purchased separately (see page 59 for hardware options).

Pkg. Solutions

GEN-X

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60, VME 64x/

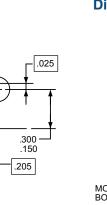
Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power/ Coax/Fiber Optics

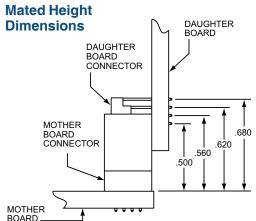
Accessories/Install **Docking Conn.**

Rack & Pane Ruggedized

LMD/LMS ectangular

Interconnects Kectangular





FINISHED HOLE SIZE PER — CUSTOMER STANDARDS FOR A Ø .016 PCB TAIL

С

9

0) 0 0 0 0 0

> 0 0 0

> > 0

.070

0 0 0

CONNECTOR MOUNTING SURFACE

±.020 TYP

.350

410

.530



Amphenol® High Density HDB3 I/O Connector

DIMENSIONAL DRAWING & HOW TO ORDER

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/

VME64x

,09

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Ruggedized Brush

Docking (



- Cable to board applications
- Crimp termination
- Uses wire well size 22D

HDB3 I/O - HOW TO ORDER

Mates with:

Standard Mother Board

1. Connector Type HDB-D4C

Designates HDB3 I/O Connector

I/O Connector Mother Board 2-Piece Construction

2-56 THREAD LOCKING SCREW SUPPLIED

Contact Termination Number of **Brush Wire** Contacts **Plating** Finish HDB-D4C -120

PIN

2. Number of Contacts

| Number of Contacts | Dimension A | Dimension C |
|--------------------|-------------|-------------|
| 040 | 1.375 | 1.075 |
| 060 | 1.725 | 1.425 |
| 080 | 2.075 | 1.775 |
| 120 | 2.775 | 2.475 |
| 160 | 3.475 | 3.175 |

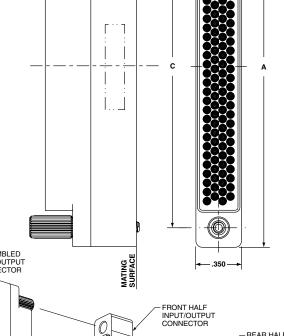
3. Brush Wire Plating

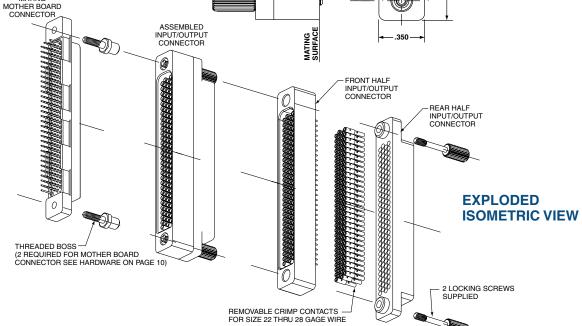
| M | 0.000050 Au Min. thick over Nickel |
|---|------------------------------------|
| C | 0.000020 Au Min, thick over Nickel |

4. Contact Termination Finish

MATING

Gold plated in accordance with MIL-G-45204, Type II, .000030 Min. thick Gold over .000050 Min. thick Nickel





Amphenol® High Density HDB³ **Stacker Connector**

Amphenol Aerospace

Mother Board

DIMENSIONAL DRAWING & HOW TO ORDER

HDB³ STACKER APPLICATIONS

For applications that need or demand parallel boards

HDB3 STACKER - HOW TO ORDER

Stacker Connector

Mates with:

HDB-D4S

Standard Mother Board

2. 3. 6. 1. Less Hardware Number of **Brush Wire Contact Termination** Termination (Purchased separately see **Plating** Contacts Finish pg XX for hardware options) HDB-D4S 120 22 2

.350

Designates HDB³ Stacker Connector

1. Connector Type

2. Number of Contacts

| Number Diff Signals | Number of Contacts | Dimension A | Dimension C |
|------------------------|-----------------------|----------------|----------------|
| 040 | 40 | 1.375 | 1.075 |
| 060 | 60 | 1.725 | 1.425 |
| 080 | 80 | 2.075 | 1.775 |
| 120 | 120 | 2.775 | 2.475 |
| 160 | 160 | 3.475 | 3.175 |

3. Brush Wire Plating

| M | 0.000050 Au Min. thick over Nickel |
|---|------------------------------------|
| С | 0.000020 Au Min. thick over Nickel |

4. Termination

| | Туре | Stickout (Dim. E) |
|----|-------------------------|----------------------|
| 22 | PCB, Straight, .016 Dia | 0.120 |
| 23 | PCB, Straight, .016 Dia | 0.150 |
| 24 | PCB, Straight, .016 Dia | 0.180 |
| 28 | PCB, Straight, .016 Dia | 0.300 |

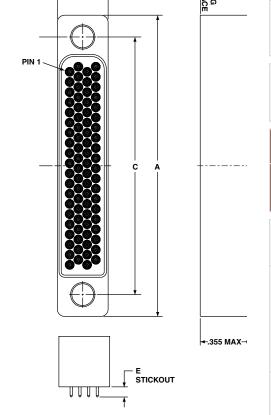
5. Contact Termination Finish

Gold plated in accordance with MIL-G-45204, Type II, .000030 Min. thick Gold over .000050 Min. thick Nickel

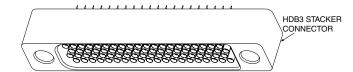
6. Hardware

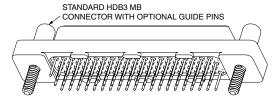
| X | Less Hardware |
|--------|---------------|
| Llord. | |

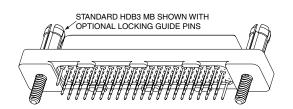
Hardware is purchased separately (see page 59 for hardware options).



EXPLODED ISOMETRIC VIEW







LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60,

Low Mating Force MIL-DTL-55302

Accessories/Instal



Amphenol® High Density & High Speed HSB³ Mother Board Connector

DIMENSIONAL DRAWING & HOW TO ORDER

Brush Contact Pkg. Solutions

| Hybrids - Fiber Optics/ | Staggered/ Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

VME64x/ ,09

| Hybrids - Signal/Power/ | Standard Brush

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics Accessories/Install. Docking Conn./

Ruggedized

HSB3 - HIGH SPEED SERIES 3.125 GBS

High speed configuration available that allows data rates up to 3.125 Gb/s via 100 ohm matched impedance differential pairs.

- Partially populated standard HDB3 mother board and daugher board bodies
- Contact an Amphenol sales engineer for validation results

HSB3 HIGH SPEED MOTHER BOARD - HOW TO ORDER Mates with: 2. 3. 4. 5. 6. · High Speed Daughter Board Contact Less Hardware

Differential

Signal

D

Brush Wire

Plating

Number of

Differential Pairs

-03

HSB-M4

1. Connector Type

HSB-M4

Designates High Speed HDB3 I/O Connector

2. Number of Contacts

| Number Differential Pairs | No. Low Speed Signals | Dimension A | Dimension C |
|---------------------------------|-----------------------------|----------------|----------------|
| 03 | 20 | 1.375 | 1.075 |
| 05 | 30 | 1.725 | 1.425 |
| 07 | 40 | 2.075 | 1.775 |
| 10 | 60 | 2.775 | 2.475 |
| 13 | 80 | 3.475 | 3.175 |

3. Differential Signal

D Standard

4. Brush Wire Plating

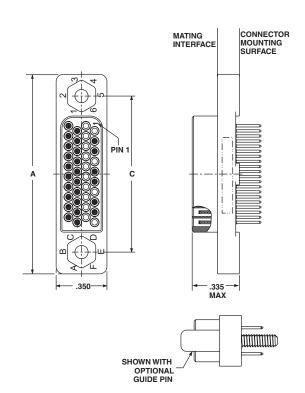
| M | 0.000050 Au Min. thick over Nickel |
|---|------------------------------------|
| С | 0.000020 Au Min, thick over Nickel |

5. Termination

| | Туре | Stickout (Dim. E) |
|----|-------------------------|----------------------|
| 22 | PCB, Straight, .016 Dia | 0.120 |
| 23 | PCB, Straight, .016 Dia | 0.150 |
| 24 | PCB, Straight, .016 Dia | 0.180 |
| 26 | PCB, Straight, .016 Dia | 0.240 |
| 28 | PCB, Straight, .016 Dia | 0.300 |

6. Contact Termination Finish

| 2 | Gold plated in accordance with MIL-G-45204, Type II, .000030 Min. thick Gold over .000050 Min. thick Nickel | ② |
|---|--|----------|
| 5 | Tin plated in accordance with ASTM B545, .00010 Min. thick Matte Tin over .00010 Min. thick Nickel | ② |
| 6 | Tin-Lead plated in accordance with SAE-AMS-P-81728, .00010 Min. thick Tin-Lead over .00010 Min. thick Copper | |



Termination

24

Termination

Finish

2

(Purchased separately see

pg XX for hardware options)

7. Hardware

Less Hardware

Hardware is purchased separately (see page 59 for hardware options).

Amphenol® High Density & High Speed HSB³ Daughter Board Connector



.086 MIN. DIA. THRU HOLE

D

(USE NO. 2 SCREW)

325

CONNECTOR MOUNTING SURFACE

±.020 TYP

.350 .410

470

DIMENSIONAL DRAWING & HOW TO ORDER

HSB3 HIGH SPEED DAUGHTER BOARD - HOW TO ORDER

Mates with:

High Speed Mother Board

| 1. | 2. | 3. | 4. | 5. | 6. | 7. |
|--------|---------------------------------|-------------------------|-----------------------|-------------|-------------------------------|---|
| | Number of Differential Pairs | Differential Signals | Brush Wire Plating | Termination | Contact Termination Finish | Less Hardware (Purchased separately see pg 10 for hardware options) |
| HSB-D4 | -03 | D | M | 02 | 2 | X |

1. Connector Type

HSB-D4

Designates High Speed HSB3 Daughter Board

2. Number of Contacts

| Number Diff Pairs | No. Low Speed Signals | Dimension A | Dimension D |
|----------------------|-----------------------------|----------------|----------------|
| 03 | 20 | 1.375 | 1.075 |
| 05 | 30 | 1.725 | 1.425 |
| 07 | 40 | 2.075 | 1.775 |
| 10 | 60 | 2.775 | 2.475 |
| 13 | 80 | 3.475 | 3.175 |

3. Differential Signals

D Standard

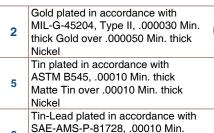
4. Brush Wire Plating

| M | 0.000050 Au Min. thick over Nickel |
|---|------------------------------------|
| С | 0.000020 Au Min. thick over Nickel |

5. Termination

| | Туре | Stickout (Dim. E) |
|----|----------------------------|----------------------|
| 01 | PCB, Right Angle, .016 Dia | 0.090 |
| 02 | PCB, Right Angle, .016 Dia | 0.120 |
| 03 | PCB, Right Angle, .016 Dia | 0.150 |
| 04 | PCB, Right Angle, .016 Dia | 0.180 |
| 06 | PCB, Right Angle, .016 Dia | 0.300 |

6. Contact Termination Finish



thick Tin-Lead over .00010 Min.

thick Copper

7. Hardware



ORGANIZER (TO AID IN PIN ALIGNMENT)

CAVITIES

Hardware is purchased separately (see page 59 for hardware options).

okg. Solutions

GEN-X

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60,

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install Docking Conn.

Rack & Pane Ruggedized

LMD/LMS

Rectangular

55



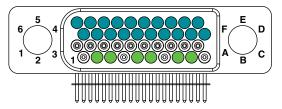
Amphenol® High Density & High Speed

ARRANGEMENTS

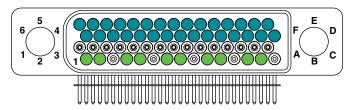
Pkg. Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/Power

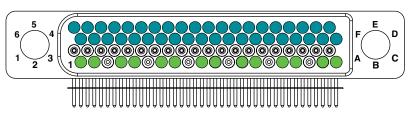
,09



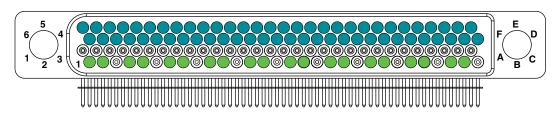
40 Pin Body with 3 Differential Pair, 20 Signal Contacts



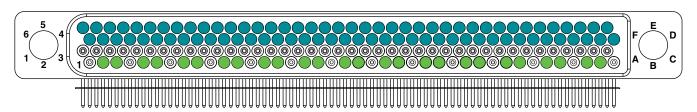
60 Pin Body with 5 Differential Pair, 30 Signal Contacts



80 Pin Body with 7 Differential Pair, 40 Signal Contacts



120 Pin Body with 10 Differential Pair, 60 Signal Contacts



160 Pin Body with 13 Differential Pair, 80 Signal Contacts

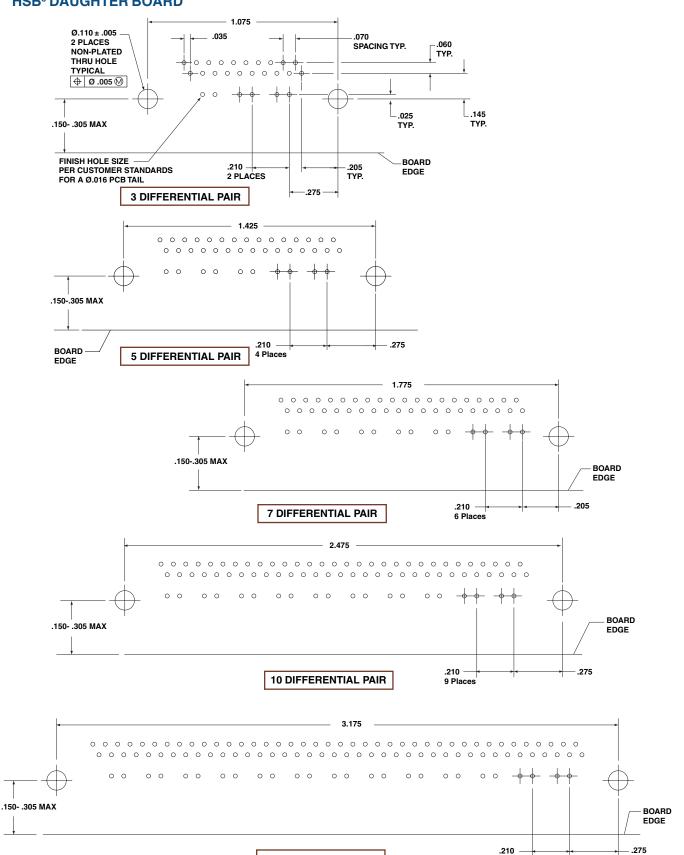
As viewed from front of daughter board connector



Amphenol Aerospace

RECOMMENDED BOARD LAYOUT - HSB3 DAUGHTER BOARD

HSB³ DAUGHTER BOARD



13 DIFFERENTIAL PAIR

HSB³ MOTHER BOARD

.205 TYP.

Amphenol® High Density & High Speed HSB³

FINISH HOLE SIZE PER CUSTOMER STANDARDS FOR A Ø.016 PCB TAIL

RECOMMENDED BOARD LAYOUT - HSB3 MOTHER BOARD

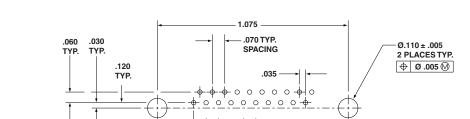
Brush Contact Solutions Pkg

LRM (Line Replaceable Modules) Ξ

VME64x/ 60,

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Docking Conn./

Rack & Panel

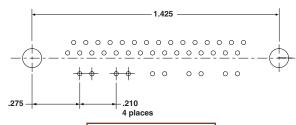


.275

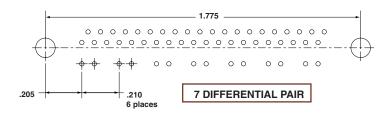
3 DIFFERENTIAL PAIR

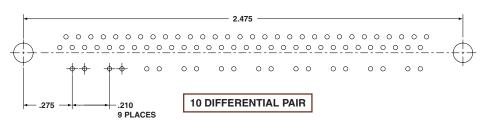
.210

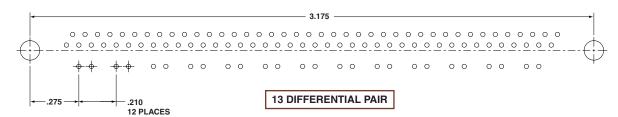
2 PLACES



5 DIFFERENTIAL PAIR







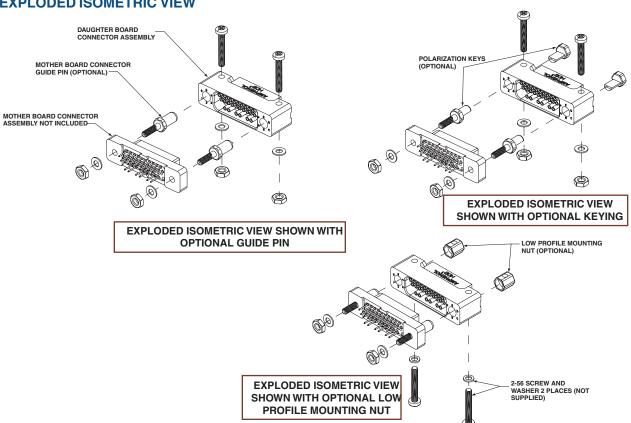
HARDWARE FOR ALL CONFIGURATIONS (Sold Separately)

| MOTHER BOARD | | | |
|----------------|---------------------------|----------|-------------------------|
| PART NUMBER | TYPE | STICKOUT | |
| HDB-508803-001 | POLARIZATION KEY (QTY 2) | 0.250 | |
| HDB-508803-002 | POLARIZATION KEY (QTY 2) | 0.500 | |
| HDB-508803-003 | POLARIZATION KEY (QTY 2) | 0.750 | |
| HDB-508802-001 | GUIDE PIN (QTY 2) | 0.250 | |
| HDB-508802-002 | GUIDE PIN (QTY 2) | 0.500 | |
| HDB-508802-003 | GUIDE PIN (QTY 2) | 0.750 | |
| HDB-508808-000 | THREADED BOSS (QTY 2)* | 0.250 | |
| HDB-508808-001 | THREADED BOSS (QTY 2)* | 0.500 | Accepts I/O Connector |
| HDB-508808-002 | THREADED BOSS (QTY 2)* | 0.750 | Jack Screw |
| HDB-508808-020 | LOCKING GUIDE PIN (QTY 2) | 0.250 | |
| HDB-508808-021 | LOCKING GUIDE PIN (QTY 2) | 0.500 | Shown with Mother Board |
| HDB-508808-022 | LOCKING GUIDE PIN (QTY 2) | 0.750 | Connector on page X |

^{*} Required with Mother Board only when mating to I/O Connector

| DAUGHTER BOARD | | |
|----------------|----------------------------------|--|
| PART NUMBER | TYPE | |
| HDB-508804-000 | POLARIZATION KEY (QTY 2) | |
| HDB-508804-001 | LOW PROFILE MOUNTING NUT (QTY 2) | |

EXPLODED ISOMETRIC VIEW



59

AmphenolLow Mating Force Rectangulars

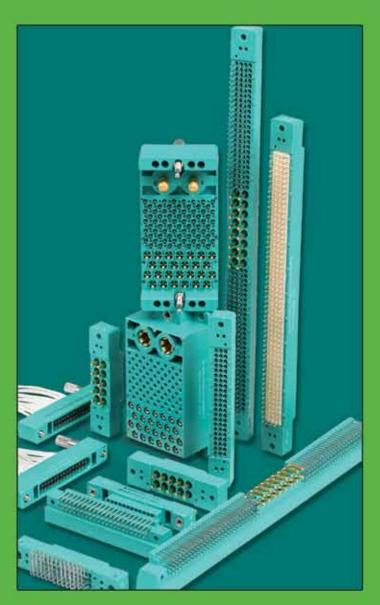


TABLE OF CONTENTS

Amphenol Low Mating Force Connectors Standard Connectors with Brush Contacts

| • Table of Contents |
|--|
| • Introduction - Features, Performance, Materials 6 |
| • Design Flexibility within Brush Connector Family 6 |
| Selecting the Correct Mated Connection, |
| Four Body Styles |
| How to Order - Military & Commercial 64-69 |
| Connector Row & Cavity Identification, |
| Contact Arrangements 2 Row6 |
| Contact Arrangements 3 & 4 Row 6 |
| Mother Board Connector |
| Daughter Board Connector73-76 |
| • Input/Output Connector77-8 |
| • PC Connector81-8 |
| • Smaller Sizes with .100 X .100 Sq. inch grid 85, 8 |

Hybrid Connectors - Brush Contacts in Combination with Other Contact Types

| • | Hybrid Configurations with Signal, Power, | |
|---|--|----|
| | Coax & Fiber Optics | 87 |
| , | Hybrids & Small Color-Coded Brush Connectors | 88 |

Other Brush Contact Rectangulars

| Dockin | Connectors | g | | |
|--------------------------|------------|---|--|--|

Accessories/Connector Installation

| • | Accessories, Polarization Keys | 90 |
|---|---|----|
| | Accessories, Test Probe Kit | 91 |
| | Connector Installation/User Application | |

Information.....92-95



Low Mating Force Connectors Typical Markets:

- Medical Equipment
- IC Chip Testers
- Telecommunications
- Military & Commercial Avionics
- Military Ground Vehicles
- GPS Systems



Amphenol Aerospace

MIL-DTL-55302 (M55302/166 THRU/172)

Amphenol's Low Mating Force Connectors are well known in the connector arena - with proven performance on the ground, in the air, and at sea. - In service for over 25 years, with over 50 million brush contacts fielded; and qualified for use on M1A2 Abrams, F-16 Falcon, F/A-22 Raptor, F-35 Lightning II, AIM-132 ASRAAM and many more applications.

Four Standard Body Styles



Key Connector Features

- 0.100 inch center to center, square grid contact spacing
- Application flexibility (parallel boards, perpendicular boards, wire to board, end to end boards, card extenders)
- 2, 3 and 4 row contact arrangements with 10 to 100 contacts per row in one contact per row increments
- Military versions meet MIL-DTL-55302/166 through /172
- Termination versatility; straight & 90° PCB stud, wire wrap & crimp
- Options on termination lengths and plating
- Front release/front removable contacts in Mother Board, Daughter Board and PC version; rear release/rear removable crimp contacts (size 22D) or printed circuit board pins provided with Input/Output
- Accessories available for latching and polarization
- Up to 256 keyed, mating polarizations available
- Hybrids available mix signal with power, RF or fiber optics
- Smaller sized connector designs with as few as 5 contacts per row
- RoHS compliant versions are available, consult Amphenol Aerospace for more information



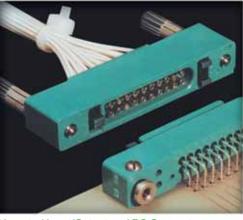
Performance

- voltage rating: 70,000 ft. 1300 325
- one and one-half ounce max. average contact engaging/ separating forces
- 7 million average contact resistance for row A contacts
- (Resistance will vary depending on the point of measurement and the length of the contact.)
- 3 ampere PCB contacts; 5 ampere wire wrap / crimp contacts
- -65°C to +125°C temperature rating
- 5 gigaohms minimum insulation resistance

- Connector Body Glass-filled thermoplastic molding material in accordance with MIL-M-24519 type GPT-15F and/or Grade B,
- Class 15 of MIL-P-46161 (UL94V-O)
- Polarization Keys Glass-filled acetal plastic molding material in accordance with MIL-P-46137
- Locking Screw/Mounting Bushing Corrosion resistant steel AISI 300 types passivated in accordance with QQ-P-35

Contacts

- Holders Copper alloy in accordance with Federal Specification QQ-B-626 or SAE J463
- Wire Berryllium copper in accordance with Federal Specification ASTM B197
- Sleeves If applicable, stainless steel in accordance with AMS-5514 passivated in accordance with ASTM A967



Unmated Input/Output and PC Connector



An Input/Output and Mother Board Connector



Mated Mother Board and Daughter Board Connector

Solutions

LRM (Line Replaceable Modules) Hi Speed/RF/Power

VITA 60, VME 64x 6

ectangular



Amphenol® Low Mating Force **Rectangular Connectors**

DESIGN FLEXIBILITY

Brush Contact Solutions

| Hybrids - Fiber Optics/ | Staggered/ LRM (Line Replaceable Modules)

VME64x/ 60,

High Density HSB3

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Ruggedized

The B3 Brush Contact is the standard contact for the family of connectors called Low Mating Force Rectangulars. This is because of the Brush contact's advantages for low mating force, stable electrical performance and extended service life. Amphenol provides a wide variety of interconnects within the "Brush Family of Connectors". This catalog section first gives the information you need for ordering the standard body styles, as described on pages 61 & 63, and then follows with information about further design flexibility. Below are some of the interconnect product solutions possible in Amphenol's rectangular products.

Amphenol's Broad Family of Low Mating Force Interconnect Products with Brush Contacts

Standard Brush Connectors

Combination of Brush

Combination of Brush Contacts, Coax and

Power Strip Connector Series with cavities for size 16 or 12 power contacts (or size 16 or 12 coax contacts).

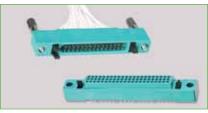
few as 10 Brush

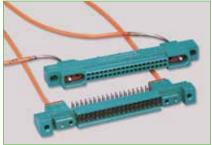
Contacts

Power Contacts

Contacts and Fiber

Optic Termini











Hybrid Custom Connector with Brush Contacts and Power Contacts



Docking Connectors -The Brush Contact offers high performance where frequent docking to charge and transfer data is a necessity.







Other Similar Rectangular Connectors from Amphenol

Other Amphenol connectors that accommodate Brush contacts are covered in the catalog sections of this catalog as follows:

- High Density HDB³ and HSB³ Series (pgs. 47-59)
- LRM (Line Replacable Module) Interconnects (pgs.
- High Speed Gigastak® and Digistak® LRM Interconnects (pgs. 31-36)
- Ruggedized, Non-Floating Brush Rack and Panel connectors (pgs. 96-98)

Amphenol Aerospace

SELECTING THE CORRECT MATED CONNECTION

STANDARD FOUR BODY **STYLES**

Mother Board Connector (MB)

also can be referred to as a "Backplane" Connector

- Straight PCB stud or Wire wrap termination
- Mates with: Daughter board or I/O connectors

Daughter Board Connector (DB)

also can be referred to as a "Module Connector"

- 90° PCB stud
- Mates with: Mother board or PC connectors

Printed Circuit Connector (PC)

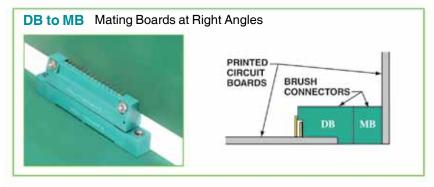
also can be referred to as a "Right Angle Mother board Connector or a "Card Extender Connector"

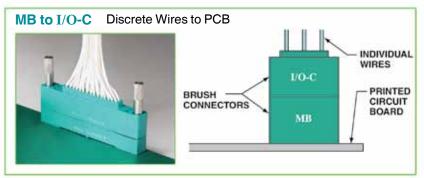
- 90° PCB stud
- Mates with: I/O or Daughter board connectors

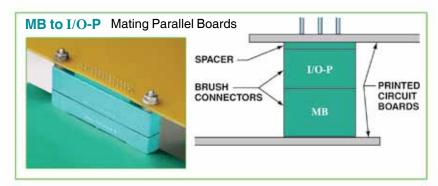
Input/Output Connector (I/O)

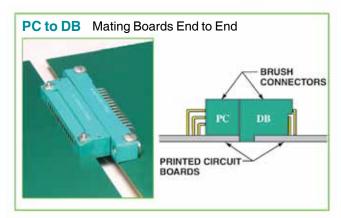
also can be referred to as a "Cable Connector'

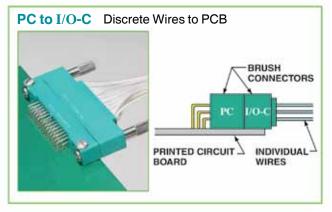
- I/O-C has rear removable crimp contacts
- I/O-P has round PCB stud solder contacts
- Mates with: Mother board or PC connectors











HOW TO ORDER (MILITARY TYPES)

Body Type/

Contact Style

/166

M55302

Brush Contact Solutions

Hybrids - Fiber Opiics/ | Staggered/ Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

MB, DB, PC Connectors **Military Part Number Ordering**

Example part number M55302/166A10X1

is shown as follows:

1. Connector Type M55302

Designates Low Mating Force Rectangular Connectors

2. Body Type/Contact Style

- /166 designates MB-P (Mother Board, Printed Circuit **Board Termination**)
- /167 designates MB-W (Mother Board, Wire-wrap Contacts)
- /168 designates PC (Printed Circuit, 90° Printed Circuit **Board Termination**)
- /170 designates DB (Daughter Board, 90° Printed Circuit Board Termination)

3. Number of Rows

- A 2 rows
- B 3 rows
- C 4 rows

4. Number of Contacts per Row

Contact counts per row range from 10 to 100 (Only 2 digits permitted in this space; for 100 contacts per row, use 00)

5. Tail Length

3.

Number

of Rows

| ···· | |
|--|--------------------------|
| MB-P (PCB Termination)* | MB-W** (Wire-wrap) |
| W222 ±.025 X300 ±.025 Y145 ±.025 Z113 ±.025 | Y700 ±.025 Z542 ±.025 |

4.

Number of

Contacts per Row

6.

Tail

Finish

5.

Contact Type/

Finish

X

Tail

Length

X

| DB* | PC* |
|--------------------------|----------|
| X300 ±.025 Y150 ±.025 | Y – .150 |
| Z120 ±.025 | Z095 |

- * Reference "J" Dimension on all connector drawings in this catalog.
- ** For MB-W only: Reference "H" Dimension on connector drawing on page 69.

6. Tail Finish

- 1 Tin lead per MIL-P-81728, 50 to 70%, .0001 min. thick over
- 2 Gold per MIL-G-45204, type II, grade C, class 00 (01 for MB-W) over nickel per QQ-N-290

Number

of Rows

IO Connectors Military Part Number Ordering

Example part number M55302/169A101 is shown as follows:

1. Connector Type

M55302

Designates Low Mating Force Rectangular Connectors

2. Body Type

/169 designates IO (Input/Output) (Contact type/finish is last digit of IO part number see list of options below)

3. Number of Rows

- A 2 rows
- B 3 rows
- C 4 rows

4. Number of Contacts per Row

Contact counts per row range from 10 to 100 (Only 2 digits permitted in this space; for 100 contacts per row, use 00)

To order Accessories, see page 66.

5. Contact Type/Finish

Body Type

/169

M55302

- 1 Crimp contact Tin lead per MIL-P-81728, 50 to 70% tin, .0001 min. thick over copper
- 2 Crimp contact Gold per MIL-G-45204, type II, grade C, class 1 over copper
- 3 Connectors supplied less contacts
- PCB contacts installed with .145 ±.025 stickout Tin lead per MIL-P-81728, 50 to 70% tin, .0001 min. thick over copper (Reference "J" Dimension on connector drawing on page 77).

To Order Replacement IO Contacts

(For use with connectors less contacts)

M55302/171-1

suffix designates crimp well finish

Number of

Contacts per Row

10

Crimp well finish

- 1 Crimp contact Tin lead per MIL-P-81728, 50 to 70% tin, .0001 min. thick over copper
- 2 Crimp contact Gold per MIL-G-45204, type II, grade C class 1 over copper.



HOW TO ORDER (COMMERCIAL TYPES)

MB, DB, I/O, PC Connectors Commercial Part Number Ordering

Example part number MB2-120P- () is shown as follows:

| 1. | 2. | 3. | 4. | 5. |
|-----------|----------------|--------------------------|----------------------|---------------------|
| Body Type | Number of Rows | Total Number of Contacts | Termination Style | Variation Suffix |
| MB | 2 - | 120 | Р | - () |

1. Body Type

MB designates Mother Board
DB designates Daughter Board
I/O designates Input/Output
PC designates Printed Circuit

2. Number of Rows

2, 3 or 4 rows

3. Total Number of Contacts

See Contact Arrangement lists for each connector style

4. Standard Termination Style

(Stickout values below apply to "J" dimension referenced on individual connector catalog pages).

| MBX-XXXP | Straight PCB stud, .021 dia, .113 ±.025 stickout, Sn/Ni plate |
|----------|---|
| MBX-XXXW | Solderless wrap,.025 sq.,.507 ±.025 stickout, Sn/Ni plate |
| DBX-XXXP | 90° PCB stud, .021 dia, .085 ±.025 stickout, Sn/Ni plate |
| IOX-XXXC | Crimp, rear removable contact, size 22D wire well, Sn/Ni plate |
| IOX-XXXP | PCB stud, .021 dia, .145 ±.025 stickout, Sn/Ni plate +.035 |
| PCX-XXXP | 90° PCB stud, .021 dia., .095 ⁰²⁵ stickout Sn/Ni plate |

LEGEND:

Sn/Ni designates Tin over Nickel Au/Ni designates Gold over Nickel Au/Cu designates Gold over Copper

To order Accessories, see next page.



SnPb/Cu designates Tin-Lead over Copper

5. Variation Suffix

(Stickout values below apply to "J" dimension referenced on individual connector catalog pages.)

| individu | al connector catalog pages.) |
|----------|--|
| (700) | Gold plate in accordance with MIL-G-45204, type II, .000030 min. thick gold (.000050 for solderless wrap) over .000050 min. thick nickel (standard termination length) |
| (701) | Gold plate in accordance with MIL-G-45204, type II, .000050 min. thick gold over .00015 min. thick copper (standard termination length) |
| (702) | PCB stud stickout of .145, Sn/Ni plate, MB-P |
| (703) | Au/Ni [same as (700)], PCB stud stickout of .145, MB-P |
| (704) | Au/Cu [same as (701)], PCB stud stickout of .145, MB-P |
| (705) | 90° PCB stud, .120 stickout. Sn/Ni plate, DB |
| (706) | Au/Ni [same as (700)], 90° PCB stud .120 stickout, DB |
| (707) | Au/Cu [same as (701)], 90° PCB .120 stickout, DB |
| (709) | PCB stud stickout of .300 DB (90°), .300 MB-P & .335 IO-P, Sn/Ni plate |
| (710) | Solderless wrap,.025 sq., .665 stickout, Sn/Ni plate, MB-W |
| (711) | Solderless wrap,.025 sq.,.665 stickout, Au/Ni, [same as (700)], MB-W |
| (713) | PCB stud stickout of .060, Sn/Ni plate, IO-P |
| (714) | 90° PCB stud stickout of .150, Sn/Ni plate, PC & DB |
| (715) | Solderless wrap, .025 sq., .665 stickout, Au/Cu [same as (701)], MB-W |
| (716) | 90° PCB stud stickout of .085 matte tin, DB |
| (717) | 90° PCB stud stickout of .095 matte tin, PC |
| (718) | 90° PCB stud stickout of .120 matte tin, DB |
| (719) | PCB stud stickout of .300 MB-P & .335 IO-P, matte tin |
| (720) | PCB stud stickout of .060 matte tin, IO-P |
| (721) | PCB stud stickout of .500, Sn/Ni plate, IO-P |
| (722) | PCB stud stickout of .356 matte tin, MB-P |
| (723) | PCB stud stickout of .192, Sn/Ni plate, MB-P |
| (724) | 90° PCB stud stickout of .095, RTV potted rear, Sn/Ni plate, PC |
| (725) | 90° PCB stud stickout of .120, RTV potted rear, Sn/Ni plate, DB |
| (726) | 90° PCB stud stickout of .150, RTV potted rear, Sn/Ni plate, PC & DB |
| (727) | PCB stud stickout of .145, RTV potted rear, Sn/Ni plate, MB-P |
| (728) | PCB stud stickout of .145, Au/Ni, [same as (700)], RTV potted rear, MB-P |
| (729) | 90° PCB stud stickout of .120, Au/Ni, [same as (700)], RTV potted rear, DB |
| (730) | 90° PCB stud stickout of .150, Au/Ni, [same as (700) |

Variation Suffixes continued on next page.

above], PC and DB

PCB stud stickout of .145, matte tin, MB-P

g. Solutions/ rush Contact

RM (Line Kepiaceable I gered/ Hybrids - Fiber Optics N-X Hi Speed/RF/Power

or Accessories

Ruggedized
VME 64x/
VITA 60, 66

)B3 | HSB3 | Hi Speed

andard |Hybrids - Signal/Power/| D Brush | Coax/Fiber Optics | Acc

(731)

HOW TO ORDER (COMMERCIAL TYPES) /ACCESSORIES

Brush Contact Solutions

| Hybrids - Fiber Optics | Staggered | Hybrids - Fiber Optics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

VME64x/ 60,

HSB3

Low Mating Force MIL-DTL-55302 Docking Conn./ | Hybrids - Signal/Power/ | cessories/Install. | Coax/Fiber Optics

MB, DB, I/O, PC Connectors **Commercial Part Number Ordering**

Example part number MB2-120P-()

| 1. | 2. | 3. | 4. | 5. |
|-----------|----------------|--------------------------|----------------------|---------------------|
| Body Type | Number of Rows | Total Number of Contacts | Termination Style | Variation Suffix |
| МВ | 2 - | 120 | Р | - () |

5. Variation Suffix, cont.

| (732) | PCB stud stickout of .300 DB (90°), .300 MB-P and |
|-------|---|
| | .335 IO-P, Au/Cu [same as (701)], |

- (733)PCB stud stickout of .421, matte tin, MB-P
- (734)Solderless wrap .025 sq.; .665 stickout, Au/Ni, [same as (700)], RTV potted rear, MB-W
- (735)RTV potted rear, standard termination length, Au/Ni, [same as (700)]
- (736)RTV potted rear, standard termination length, Sn/Ni [use (724) for PC]
- PCB stud stickout of $.300 \, \text{DB} \, (90^\circ)$, $.300 \, \text{MB-P}$ and (737).335 IO-P, Au/Ni, [same as (700)], RTV potted rear
- (738)PCB stud stickout of .192 SnPb/Cu (Mil-Spec), MB-P
- (739)PCB stud stickout of .300 DB (90°), .300 MB-P and .335 IO-P;, RTV potted rear, Sn/Ni
- (740)Solderless wrap .025 sq.; .665 stickout, Sn/Ni, RTV potted rear, MB-W
- Solderless wrap .025 sq.; .280 stickout, Au/Ni, [same (741)as (700)], MB-W
- (742)PCB .145, Au/Ni, [same as (700)], epoxy potted rear, MB-P
- 90° PCB .120, Au/Ni, [same as (700)], epoxy potted (743)rear, DB
- 90° PCB .120, Au/Ni, [same as (700)], (MIL-Spec), (744)epoxy potted rear, DB
- (746)90° PCB .120, SnPb/Cu, (MIL-Spec), epoxy potted
- (747)PCB stud stickout of .200, Sn/Ni, IO-P
- (748)PCB stud stickout of .145, Sn/Ni, epoxy potted rear,
- (749)PCB, epoxy potted rear, standard termination length, Sn/Ni

| (750) | PCB stud stickout of .172 termination, Au/Ni, [same as |
|-------|--|
| | (700)], RTV potted rear, MB-P |

- (751)90° PCB stud stickout of .150, Sn/Ni, epoxy potted rear, PC
- (752)Au/Ni, epoxy potted rear, standard termination length
- Solderless wrap .025 sq.; .665 stickout, Au/Ni, [same as (753)(700)], epoxy potted rear, MB-W
- PCB stud stickout of .172 termination, SnPb/Cu (754)(MIL-Spec), MB-P
- (757)PCB stud, .391 stickout, matte tin, MB-P
- (758)PCB stud, .172 stickout, Au/Ni, [same as (700)], epoxy potted rear, MB-P
- (760)PCB stud, .192 stickout, Au/Ni (Mil-Spec), MB-P
- (761)90° PCB stud, .120 stickout, Sn/Ni, epoxy potted rear,
- PCB stud, .145 stickout, Au/Ni (Mil-Spec), epoxy potted (762)rear, MB-P
- PCB stud, .145 stickout, SnPb/Cu (Mil-Spec), epoxy (763)potted rear, MB-P
- 90° PCB stud, .150 stickout, SnPb/Cu (Mil-Spec), epoxy (764)potted rear, DB & PC
- (765)PCB stud, stickout of .300 DB (90°), .300 MB-P, SnPb/ Cu (Mil-Spec), epoxy potted rear
- (766)90° PCB stud, .120 stickout, Au/Ni (Mil-Spec), epoxy potted rear, DB
- PCB stud, .192 stickout, Au/Ni (Mil-Spec), epoxy potted (767)rear, MB-P
- (768)PCB stud, .172 stickout, Au/Ni (Mil-Spec), MB-P
- 90° PCB stud, .200 stickout, Au/Ni (Mil-Spec), DB (769)
- (770)90° PCB stud, .260 stickout, Au/Ni (Mil-Spec), DB
- (773)90° PCB stud, .150 stickout, Au/Ni (Mil-Spec), RTV potted rear, PC & DB

Accessories Part Number Ordering

Amphenol® Low Mating Force Connectors are shipped less accessory items. Accessories may be ordered by either military or proprietary part numbers shown below:

| Accessory Item | Series | Military Part Number | Proprietary Part Number | Qty. Required |
|--------------------------------------|----------------|----------------------|-------------------------|---------------|
| Polarization Keys | MB, DB, IO, PC | M55302/78-02 | 10-285422-2 | 4* |
| Locking/Mounting Bushing | MB | M55302/172-01 | 10-411196-3 | 2 |
| Alternate Length Bushing (Longer) | MB | M55302/172-02 | 10-411196-5 | 2 |
| Locking Bushing | PC | M55302/172-05 | 10-411196-4 | 2 |
| Locking Screw, Plain | IO | M55302/172-04 | 10-502599 | 2 |
| Locking Screw, Slotted | IO | - | 10-502599-1 | 2 |
| Locking Screw, Slotted (Low Profile) | IO | M55302/172-03 | 10-502599-2 | 2 |
| Test Probe Kit | MB, DB, IO, PC | - | 11-10400-22 | 1** |

See pages 90-95 for more detailed information on these accessory items and how they are assembled into connectors.

^{* 4} Keys required per connector half, if used

^{**} One kit per connector gender is recommended

ROW & CAVITY IDENTIFICATION, CONTACT ARRANGEMENTS

Contact rows and cavities are identified with molded-in letters and numbers respectively and, depending on the connector style, are located either on the front, rear or both faces of the connector. See illustration at right.

Note: The brand name of Bendix may appear molded-in on connectors. As manufacturing molds are remade, the correct Amphenol name will replace the former Bendix name.

As shown in the second illustration at right, row identification is always at the radius end and begins with Row "A". Contact cavity identification always starts at radius end and begins with cavity #6 and then every fifth cavity thereafter, except for arrangements consisting of 10 contacts per row, which lack numerals. Up to every 9 contact locations at the high numeral end of the contact row will not be identified.

Mother Board and PC Connectors

Contact rows are identified on the <u>front</u> and <u>rear</u> faces. Contact cavities are identified on the rear face

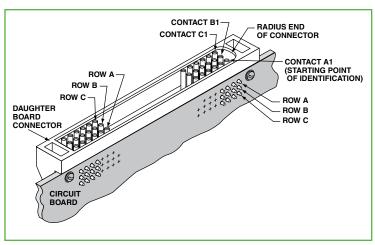
Daughter Board Connectors

Contact rows and cavities are identified on the <u>front</u> face.

Input/Output Connectors

Contact rows and cavities are identified on the rear face

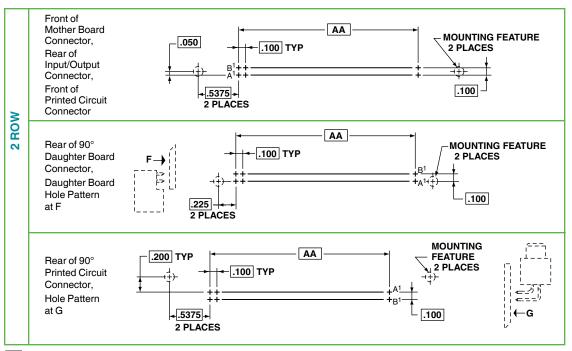
CONTACT ROWS AND CAVITIES ARE IDENTIFIED WITH MOLDED-IN LETTERS AND NUMBERS (FRONT FACE OF DAUGHTER BOARD SHOWN)



IDENTIFICATION STARTS AT THE RADIUS END OF THE CONNECTOR

Contacts

Contacts are supplied with MB, DB, IO and PC Connector Series assemblies as ordered.



| | Designates Basic Dimension. |
|------|---|
| Cons | sult Amphenol drawing for solderless wrap contact fixturing |

(datum) hole locations to facilitate connector alignment.

| 2 ROW |
|------------|
| 10 per Row |

| Total Contacts | AA | |
|-------------------|-------|--|
| 20 | .900 | |
| 30 | 1.400 | |
| 40 | 1.900 | |
| 50 | 2.400 | |
| 60 | 2.900 | |
| 70 | 3.400 | |
| 80 | 3.900 | |
| 90 | 4.400 | |
| 100 | 4.900 | |
| 110 | 5.400 | |
| 120 | 5.900 | |
| 130 | 6.400 | |
| 140 | 6.900 | |
| 150 | 7.400 | |
| 160 | 7.900 | |
| 170 | 8.400 | |
| 180 | 8.900 | |
| 190 | 9.400 | |
| 200 | 9.900 | |

67

CONTACT ARRANGEMENTS, CONT

Brush Contact Solutions

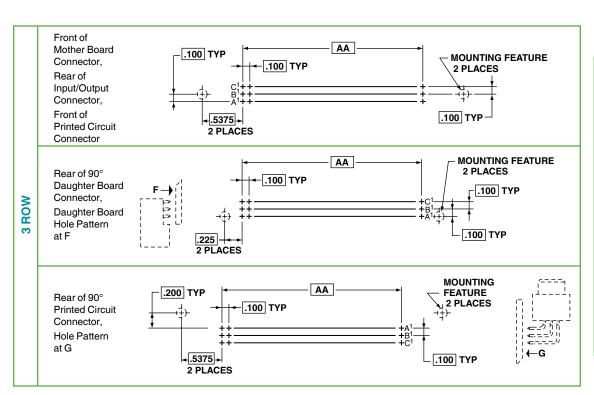
| Hybrids - Fiber Optics/ | Staggered/ LRM (Line Replaceable Modules)

VME64x / 60,

High Density HSB3

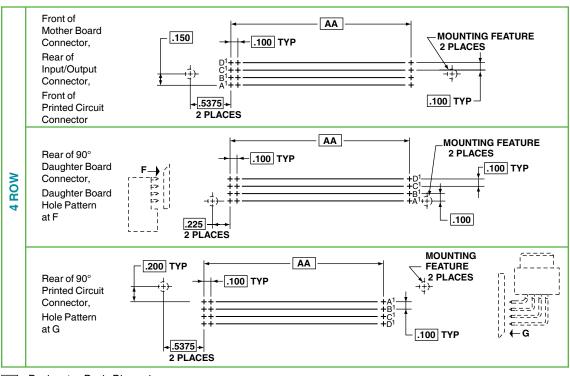
Low Mating Force MIL-DTL-55302 Coax

Rack & Pane Ruggedized



3 ROW 10 per Row

| 10 per Row | | | | |
|-------------------|-------|--|--|--|
| Total Contacts | AA | | | |
| 30 | .900 | | | |
| 45 | 1.400 | | | |
| 60 | 1.900 | | | |
| 75 | 2.400 | | | |
| 90 | 2.900 | | | |
| 105 | 3.400 | | | |
| 120 | 3.900 | | | |
| 135 | 4.400 | | | |
| 150 | 4.900 | | | |
| 165 | 5.400 | | | |
| 180 | 5.900 | | | |
| 195 | 6.400 | | | |
| 210 | 6.900 | | | |
| 225 | 7.400 | | | |
| 240 | 7.900 | | | |
| 255 | 8.400 | | | |
| 270 | 8.900 | | | |
| 285 | 9.400 | | | |
| 300 | 9.900 | | | |

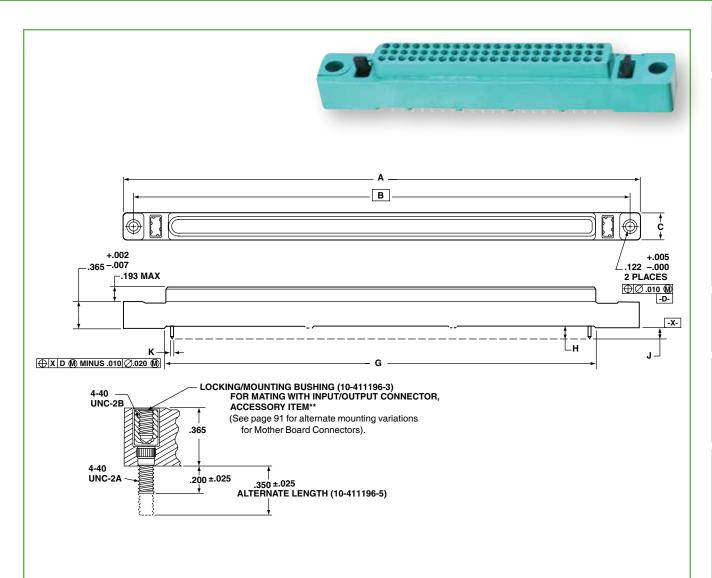


4 ROW 10 Per Row

| 1010 | 1100 |
|-------------------|-------|
| Total Contacts | AA |
| 40 | .900 |
| 60 | 1.400 |
| 80 | 1.900 |
| 100 | 2.400 |
| 120 | 2.900 |
| 140 | 3.400 |
| 160 | 3.900 |
| 180 | 4.400 |
| 200 | 4.900 |
| 220 | 5.400 |
| 240 | 5.900 |
| 260 | 6.400 |
| 280 | 6.900 |
| 300 | 7.400 |
| 320 | 7.900 |
| 340 | 8.400 |
| 360 | 8.900 |
| 380 | 9.400 |
| 400 | 9.900 |

Designates Basic Dimension.

Consult Amphenol drawing for solderless wrap contact fixturing (datum) hole locations to facilitate connector alignment.



MATES WITH DB AND IO SERIES CONNECTORS

Notes

When mating with DB connector, a total of .035 inch minimum radial pilot is available for connector body alignment.

All dimensions for reference only.

Polarization keys are not supplied as part of MB Connector Series assemblies. See Accessories How to Order, page 66 and further description, page 90.

** Locking/mounting bushings are not supplied as part of MB Connector Series assemblies. See Accessories How to Order, page 66 and further description on page 93.

Designates Basic Dimension

Consult Amphenol drawing for solderless wrap contact fixturing (datum) hole locations to facilitate connector alignment.

| Contact Data | | | | | | |
|--------------------------------|--------------------------------|------------|------------|------------|--|--|
| Description | Termination Style Letter | H ±.020 | J ±.020 | K ±.002 | | |
| Round PCB | Р | .148 | .113 | .021 Dia. | | |
| Stud Solder | P-(702) | .180 | .145 | .021 Dia. | | |
| Termination | P-(709) | .335 | .300 | .021 Dia. | | |
| Square | W | .542 | .507 | .025 Sq. | | |
| Solderless Wrap Termination | W-(710) | .700 | .665 | .025 Sq. | | |

NOTE: Other variations available - see pages 65 & 66, or consult Amphenol Aerospace.



Low Mating Force **Mother Board Connector**

2 ROW CONTACT ARRANGEMENTS

Pkg. Solutions,

| Hybrids - Fiber Optics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

Ruggedized VME64x / VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302

Ruggedized

| Number | | | | | |
|----------|------------|-------|-------|------|-------|
| of | MB | Α | В | С | G |
| Contacts | Number* | Max. | | Max. | Min. |
| 020 | MB2-020(*) | 2.295 | 1.975 | .390 | 1.040 |
| 022 | MB2-022(*) | 2.395 | 2.075 | .390 | 1.140 |
| 024 | MB2-024(*) | 2.495 | 2.175 | .390 | 1.240 |
| 026 | MB2-026(*) | 2.595 | 2.275 | .390 | 1.340 |
| 028 | MB2-028(*) | 2.695 | 2.375 | .390 | 1.440 |
| 030 | MB2-030(*) | 2.795 | 2.475 | .390 | 1.540 |
| 032 | MB2-032(*) | 2.895 | 2.575 | .390 | 1.640 |
| 034 | MB2-034(*) | 2.995 | 2.675 | .390 | 1.740 |
| 036 | MB2-036(*) | 3.095 | 2.775 | .390 | 1.840 |
| 038 | MB2-038(*) | 3.195 | 2.875 | .390 | 1.940 |
| 040 | MB2-040(*) | 3.295 | 2.975 | .390 | 2.040 |
| 042 | MB2-042(*) | 3.395 | 3.075 | .390 | 2.140 |
| 044 | MB2-044(*) | 3.495 | 3.175 | .390 | 2.240 |
| 046 | MB2-046(*) | 3.595 | 3.275 | .390 | 2.340 |
| 048 | MB2-048(*) | 3.695 | 3.375 | .390 | 2.440 |
| 050 | MB2-050(*) | 3.795 | 3.475 | .390 | 2.540 |
| 052 | MB2-052(*) | 3.895 | 3.575 | .390 | 2.640 |
| 054 | MB2-054(*) | 3.995 | 3.675 | .390 | 2.740 |
| 056 | MB2-056(*) | 4.095 | 3.775 | .390 | 2.840 |
| 058 | MB2-058(*) | 4.195 | 3.875 | .390 | 2.940 |
| 060 | MB2-060(*) | 4.295 | 3.975 | .390 | 3.040 |
| 062 | MB2-062(*) | 4.395 | 4.075 | .390 | 3.140 |
| 064 | MB2-064(*) | 4.495 | 4.175 | .390 | 3.240 |
| 066 | MB2-066(*) | 4.595 | 4.275 | .390 | 3.340 |
| 068 | MB2-068(*) | 4.695 | 4.375 | .390 | 3.440 |
| 070 | MB2-070(*) | 4.795 | 4.475 | .390 | 3.540 |
| 072 | MB2-072(*) | 4.895 | 4.575 | .390 | 3.640 |
| 074 | MB2-074(*) | 4.995 | 4.675 | .390 | 3.740 |
| 076 | MB2-076(*) | 5.095 | 4.775 | .390 | 3.840 |
| 078 | MB2-078(*) | 5.195 | 4.875 | .390 | 3.940 |
| 080 | MB2-080(*) | 5.295 | 4.975 | .390 | 4.040 |
| 082 | MB2-082(*) | 5.395 | 5.075 | .390 | 4.140 |
| 084 | MB2-084(*) | 5.495 | 5.175 | .390 | 4.240 |
| 086 | MB2-086(*) | 5.595 | 5.275 | .390 | 4.340 |
| 088 | MB2-088(*) | 5.695 | 5.375 | .390 | 4.440 |
| 090 | MB2-090(*) | 5.795 | 5.475 | .390 | 4.540 |
| 092 | MB2-092(*) | 5.895 | 5.575 | .390 | 4.640 |
| 094 | MB2-094(*) | 5.995 | 5.675 | .390 | 4.740 |
| 096 | MB2-096(*) | 6.095 | 5.775 | .390 | 4.840 |
| 098 | MB2-098(*) | 6.195 | 5.875 | .390 | 4.940 |
| 100 | MB2-100(*) | 6.295 | 5.975 | .390 | 5.040 |
| 102 | MB2-102(*) | 6.395 | 6.075 | .390 | 5.140 |
| 104 | MB2-104(*) | 6.495 | 6.175 | .390 | 5.240 |
| 106 | MB2-106(*) | 6.595 | 6.275 | .390 | 5.340 |
| 108 | MB2-108(*) | 6.695 | 6.375 | .390 | 5.440 |
| 110 | MB2-110(*) | 6.795 | 6.475 | .390 | 5.540 |
| | | | | | |

| Number | | | | | |
|----------|----------------|--------|----------|------|--------|
| of | , MB | . Α | В | , C | G |
| Contacts | Number* | Max. | | Max. | Min. |
| 112 | MB2-112(*) | 6.895 | 6.575 | .390 | 5.640 |
| 114 | MB2-114(*) | 6.995 | 6.675 | .390 | 5.740 |
| 116 | MB2-116(*) | 7.095 | 6.775 | .390 | 5.840 |
| 118 | MB2-118(*) | 7.195 | 6.875 | .390 | 5.940 |
| 120 | MB2-120(*) | 7.295 | 6.975 | .390 | 6.040 |
| 122 | MB2-122(*) | 7.395 | 7.075 | .390 | 6.140 |
| 124 | MB2-124(*) | 7.495 | 7.175 | .390 | 6.240 |
| 126 | MB2-126(*) | 7.595 | 7.275 | .390 | 6.340 |
| 128 | MB2-128(*) | 7.695 | 7.375 | .390 | 6.440 |
| 130 | MB2-130(*) | 7.795 | 7.475 | .390 | 6.540 |
| 132 | MB2-132(*) | 7.895 | 7.575 | .390 | 6.640 |
| 134 | MB2-134(*) | 7.995 | 7.675 | .390 | 6.740 |
| 136 | MB2-136(*) | 8.095 | 7.775 | .390 | 6.840 |
| 138 | MB2-138(*) | 8.195 | 7.875 | .390 | 6.940 |
| 140 | MB2-140(*) | 8.295 | 7.975 | .390 | 7.040 |
| 142 | MB2-142(*) | 8.395 | 8.075 | .390 | 7.140 |
| 144 | MB2-144(*) | 8.495 | 8.175 | .390 | 7.240 |
| 146 | MB2-146(*) | 8.595 | 8.275 | .390 | 7.340 |
| 148 | MB2-148(*) | 8.695 | 8.375 | .390 | 7.440 |
| 150 | MB2-150(*) | 8.795 | 8.475 | .390 | 7.540 |
| 152 | MB2-152(*) | 8.895 | 8.575 | .390 | 7.640 |
| 154 | MB2-154(*) | 8.995 | 8.675 | .390 | 7.740 |
| 156 | MB2-156(*) | 9.095 | 8.775 | .390 | 7.840 |
| 158 | MB2-158(*) | 9.195 | 8.875 | .390 | 7.940 |
| 160 | MB2-160(*) | 9.295 | 8.975 | .390 | 8.040 |
| 162 | MB2-162(*) | 9.395 | 9.075 | .390 | 8.140 |
| 164 | MB2-164(*) | 9.495 | 9.175 | .390 | 8.240 |
| 166 | MB2-166(*) | 9.595 | 9.275 | .390 | 8.340 |
| 168 | MB2-168(*) | 9.695 | 9.375 | .390 | 8.440 |
| 170 | MB2-170(*) | 9.795 | 9.475 | .390 | 8.540 |
| 172 | MB2-172(*) | 9.895 | 9.575 | .390 | 8.640 |
| 174 | MB2-174(*) | 9.995 | 9.675 | .390 | 8.740 |
| 176 | MB2-176(*) | 10.095 | 9.775 | .390 | 8.840 |
| 178 | MB2-178(*) | 10.195 | 9.875 | .390 | 8.940 |
| 180 | MB2-180(*) | 10.295 | 9.975 | .390 | 9.040 |
| 182 | MB2-182(*) | 10.395 | 10.075 | .390 | 9.140 |
| 184 | MB2-184(*) | 10.495 | 10.175 | .390 | 9.240 |
| 186 | MB2-186(*) | 10.595 | 10.275 | .390 | 9.340 |
| 188 | MB2-188(*) | 10.695 | 10.375 | .390 | 9.440 |
| 190 | MB2-190(*) | 10.795 | 10.475 | .390 | 9.540 |
| 192 | MB2-192(*) | 10.895 | 10.575 | .390 | 9.640 |
| 194 | MB2-194(*) | 10.995 | 10.675 | .390 | 9.740 |
| 196 | MB2-196(*) | 11.095 | 10.775 | .390 | 9.840 |
| 198 | MB2-198(*) | 11.195 | 10.775 | .390 | 9.940 |
| 200 | MB2-200(*) | 11.295 | 10.975 | .390 | 10.040 |
| | to Order, page | | . 5.57 0 | | |

^{*}See How to Order, pages 64-66.

Low Mating Force Mother Board Connector

Amphenol Aerospace

3 ROW CONTACT ARRANGEMENTS

| Number of | MB | Α | В | С | G |
|--------------|------------|-------|-------|------|-------|
| Contacts | Number* | Max. | Б | Max. | Min. |
| 030 | MB3-030(*) | 2.295 | 1.975 | .490 | 1.040 |
| 033 | MB3-033(*) | 2.395 | 2.075 | .490 | 1.140 |
| 036 | MB3-036(*) | 2.495 | 2.175 | .490 | 1.240 |
| 039 | MB3-039(*) | 2.595 | 2.275 | .490 | 1.340 |
| 042 | MB3-042(*) | 2.695 | 2.375 | .490 | 1.440 |
| 045 | MB3-045(*) | 2.795 | 2.475 | .490 | 1.540 |
| 048 | MB3-048(*) | 2.895 | 2.575 | .490 | 1.640 |
| 051 | MB3-051(*) | 2.995 | 2.675 | .490 | 1.740 |
| 054 | MB3-054(*) | 3.095 | 2.775 | .490 | 1.840 |
| 057 | MB3-057(*) | 3.195 | 2.875 | .490 | 1.940 |
| 060 | MB3-060(*) | 3.295 | 2.975 | .490 | 2.040 |
| 063 | MB3-063(*) | 3.395 | 3.075 | .490 | 2.140 |
| 066 | MB3-066(*) | 3.495 | 3.175 | .490 | 2.240 |
| 069 | MB3-069(*) | 3.595 | 3.275 | .490 | 2.340 |
| 072 | MB3-072(*) | 3.695 | 3.375 | .490 | 2.440 |
| 075 | MB3-075(*) | 3.795 | 3.475 | .490 | 2.540 |
| 078 | MB3-078(*) | 3.895 | 3.575 | .490 | 2.640 |
| 081 | MB3-081(*) | 3.995 | 3.675 | .490 | 2.740 |
| 084 | MB3-084(*) | 4.095 | 3.775 | .490 | 2.840 |
| 087 | MB3-087(*) | 4.195 | 3.875 | .490 | 2.940 |
| 090 | MB3-090(*) | 4.295 | 3.975 | .490 | 3.040 |
| 093 | MB3-093(*) | 4.395 | 4.075 | .490 | 3.140 |
| 096 | MB3-096(*) | 4.495 | 4.175 | .490 | 3.240 |
| 099 | MB3-099(*) | 4.595 | 4.275 | .490 | 3.340 |
| 102 | MB3-102(*) | 4.695 | 4.375 | .490 | 3.440 |
| 105 | MB3-105(*) | 4.795 | 4.475 | .490 | 3.540 |
| 108 | MB3-108(*) | 4.895 | 4.575 | .490 | 3.640 |
| 111 | MB3-111(*) | 4.995 | 4.675 | .490 | 3.740 |
| 114 | MB3-114(*) | 5.095 | 4.775 | .490 | 3.840 |
| 117 | MB3-117(*) | 5.195 | 4.875 | .490 | 3.940 |
| 120 | MB3-120(*) | 5.295 | 4.975 | .490 | 4.040 |
| 123 | MB3-123(*) | 5.395 | 5.075 | .490 | 4.140 |
| 126 | MB3-126(*) | 5.495 | 5.175 | .490 | 4.240 |
| 129 | MB3-129(*) | 5.595 | 5.275 | .490 | 4.340 |
| 132 | MB3-132(*) | 5.695 | 5.375 | .490 | 4.440 |
| 135 | MB3-135(*) | 5.795 | 5.475 | .490 | 4.540 |
| 138 | MB3-138(*) | 5.895 | 5.575 | .490 | 4.640 |
| 141 | MB3-141(*) | 5.995 | 5.675 | .490 | 4.740 |
| 144 | MB3-144(*) | 6.095 | 5.775 | .490 | 4.840 |
| 147 | MB3-147(*) | 6.195 | 5.875 | .490 | 4.940 |
| 150 | MB3-150(*) | 6.295 | 5.975 | .490 | 5.040 |
| 153 | MB3-153(*) | 6.395 | 6.075 | .490 | 5.140 |
| 156 | MB3-156(*) | 6.495 | 6.175 | .490 | 5.240 |
| 159 | MB3-150(*) | 6.595 | 6.275 | .490 | 5.340 |
| 162 | MB3-162(*) | 6.695 | 6.375 | .490 | 5.440 |
| 165 | ` ` | | | | 5.540 |
| כסו | MB3-165(*) | 6.795 | 6.475 | .490 | 0.040 |

| Number of | МВ | Α | В | С | G | | | |
|--------------------------------|------------|--------|--------|------|--------|--|--|--|
| Contacts | Number* | Max. | ь | Max. | Min. | | | |
| 168 | MB3-168(*) | 6.895 | 6.575 | .490 | 5.640 | | | |
| 171 | MB3-171(*) | 6.995 | 6.675 | .490 | 5.740 | | | |
| 174 | MB3-174(*) | 7.095 | 6.775 | .490 | 5.840 | | | |
| 177 | MB3-177(*) | 7.195 | 6.875 | .490 | 5.940 | | | |
| 180 | MB3-180(*) | 7.295 | 6.975 | .490 | 6.040 | | | |
| 183 | MB3-183(*) | 7.395 | 7.075 | .490 | 6.140 | | | |
| 186 | MB3-186(*) | 7.495 | 7.175 | .490 | 6.240 | | | |
| 189 | MB3-189(*) | 7.595 | 7.275 | .490 | 6.340 | | | |
| 192 | MB3-192(*) | 7.695 | 7.375 | .490 | 6.440 | | | |
| 195 | MB3-195(*) | 7.795 | 7.475 | .490 | 6.540 | | | |
| 198 | MB3-198(*) | 7.895 | 7.575 | .490 | 6.640 | | | |
| 201 | MB3-201(*) | 7.995 | 7.675 | .490 | 6.740 | | | |
| 204 | MB3-204(*) | 8.095 | 7.775 | .490 | 6.840 | | | |
| 207 | MB3-207(*) | 8.195 | 7.875 | .490 | 6.940 | | | |
| 210 | MB3-210(*) | 8.295 | 7.975 | .490 | 7.040 | | | |
| 213 | MB3-213(*) | 8.395 | 8.075 | .490 | 7.140 | | | |
| 216 | MB3-216(*) | 8.495 | 8.175 | .490 | 7.240 | | | |
| 219 | MB3-219(*) | 8.595 | 8.275 | .490 | 7.340 | | | |
| 222 | MB3-222(*) | 8.695 | 8.375 | .490 | 7.440 | | | |
| 225 | MB3-225(*) | 8.795 | 8.475 | .490 | 7.540 | | | |
| 228 | MB3-228(*) | 8.895 | 8.575 | .490 | 7.640 | | | |
| 231 | MB3-231(*) | 8.995 | 8.675 | .490 | 7.740 | | | |
| 234 | MB3-234(*) | 9.095 | 8.775 | .490 | 7.840 | | | |
| 237 | MB3-237(*) | 9.195 | 8.875 | .490 | 7.940 | | | |
| 240 | MB3-240(*) | 9.295 | 8.975 | .490 | 8.040 | | | |
| 243 | MB3-243(*) | 9.395 | 9.075 | .490 | 8.140 | | | |
| 246 | MB3-246(*) | 9.495 | 9.175 | .490 | 8.240 | | | |
| 249 | MB3-249(*) | 9.595 | 9.275 | .490 | 8.340 | | | |
| 252 | MB3-252(*) | 9.695 | 9.375 | .490 | 8.440 | | | |
| 255 | MB3-255(*) | 9.795 | 9.475 | .490 | 8.540 | | | |
| 258 | MB3-258(*) | 9.895 | 9.575 | .490 | 8.640 | | | |
| 261 | MB3-261(*) | 9.995 | 9.675 | .490 | 8.740 | | | |
| 264 | MB3-264(*) | 10.095 | 9.775 | .490 | 8.840 | | | |
| 267 | MB3-267(*) | 10.195 | 9.875 | .490 | 8.940 | | | |
| 270 | MB3-270(*) | 10.295 | 9.975 | .490 | 9.040 | | | |
| 273 | MB3-273(*) | 10.395 | 10.075 | .490 | 9.140 | | | |
| 276 | MB3-276(*) | 10.495 | 10.175 | .490 | 9.240 | | | |
| 279 | MB3-279(*) | 10.595 | 10.275 | .490 | 9.340 | | | |
| 282 | MB3-282(*) | 10.695 | 10.375 | .490 | 9.440 | | | |
| 285 | MB3-285(*) | 10.795 | 10.475 | .490 | 9.540 | | | |
| 288 | MB3-288(*) | 10.895 | 10.575 | .490 | 9.640 | | | |
| 291 | MB3-291(*) | 10.995 | 10.675 | .490 | 9.740 | | | |
| 294 | MB3-294(*) | 11.095 | 10.775 | .490 | 9.840 | | | |
| 297 | MB3-297(*) | 11.195 | 10.875 | .490 | 9.940 | | | |
| 300 | MB3-300(*) | 11.295 | 10.975 | .490 | 10.040 | | | |
| See How to Order, pages 64-66. | | | | | | | | |

^{*}See How to Order, pages 64-66.

Ruggedized



Low Mating Force **Mother Board Connector**

4 ROW CONTACT ARRANGMENTS

Pkg. Solutions,

| Hybrids - Fiber Optics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

Ruggedized VME64x / VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

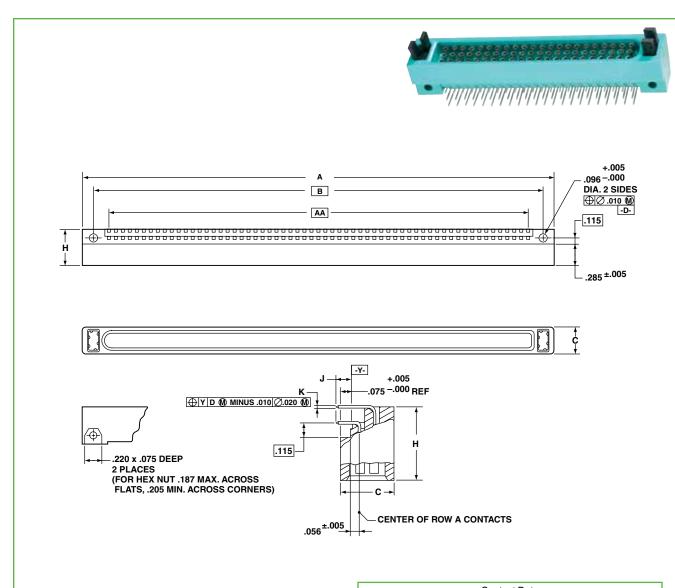
Low Mating Force MIL-DTL-55302

| | | | 1 | i e | i e |
|--------------|--------------|-------|-------|------|-------|
| Number of | МВ | Α | В | С | G |
| Contacts | Number* | Max. | | Max. | Min. |
| 040 | MB4-040(*) | 2.295 | 1.975 | .590 | 1.040 |
| 044 | MB4-044(*) | 2.395 | 2.075 | .590 | 1.140 |
| 048 | MB4-048(*) | 2.495 | 2.175 | .590 | 1.240 |
| 052 | MB4-052(*) | 2.595 | 2.275 | .590 | 1.340 |
| 056 | MB4-056(*) | 2.695 | 2.375 | .590 | 1.440 |
| 060 | MB4-060(*) | 2.795 | 2.475 | .590 | 1.540 |
| 064 | MB4-064(*) | 2.895 | 2.575 | .590 | 1.640 |
| 068 | MB4-068(*) | 2.995 | 2.675 | .590 | 1.740 |
| 072 | MB4-072(*) | 3.095 | 2.775 | .590 | 1.840 |
| 076 | MB4-076(*) | 3.195 | 2.875 | .590 | 1.940 |
| 080 | MB4-080(*) | 3.295 | 2.975 | .590 | 2.040 |
| 084 | MB4-084(*) | 3.395 | 3.075 | .590 | 2.140 |
| 088 | MB4-088(*) | 3.495 | 3.175 | .590 | 2.240 |
| 092 | MB4-092(*) | 3.595 | 3.275 | .590 | 2.340 |
| 096 | MB4-096(*) | 3.695 | 3.375 | .590 | 2.440 |
| 100 | MB4-100(*) | 3.795 | 3.475 | .590 | 2.540 |
| 104 | MB4-104(*) | 3.895 | 3.575 | .590 | 2.640 |
| 108 | MB4-104(*) | 3.995 | 3.675 | .590 | 2.740 |
| 112 | MB4-112(*) | 4.095 | 3.775 | .590 | 2.840 |
| 116 | MB4-116(*) | 4.195 | 3.875 | .590 | 2.940 |
| 120 | MB4-120(*) | 4.295 | 3.975 | .590 | 3.040 |
| 124 | MB4-124(*) | 4.395 | 4.075 | .590 | 3.140 |
| 128 | MB4-128(*) | 4.495 | 4.175 | .590 | 3.240 |
| 132 | MB4-132(*) | 4.595 | 4.275 | .590 | 3.340 |
| 136 | MB4-136(*) | 4.695 | 4.375 | .590 | 3.440 |
| 140 | MB4-140(*) | 4.795 | 4.475 | .590 | 3.540 |
| 144 | MB4-144(*) | 4.895 | 4.575 | .590 | 3.640 |
| 148 | MB4-148(*) | 4.995 | 4.675 | .590 | 3.740 |
| 152 | MB4-152(*) | 5.095 | 4.775 | .590 | 3.840 |
| 156 | MB4-156(*) | 5.195 | 4.875 | .590 | 3.940 |
| 160 | MB4-160(*) | 5.295 | 4.975 | .590 | 4.040 |
| 164 | MB4-164(*) | 5.395 | 5.075 | .590 | 4.140 |
| 168 | MB4-168(*) | 5.495 | 5.175 | .590 | 4.240 |
| 172 | MB4-172(*) | 5.595 | 5.275 | .590 | 4.340 |
| 176 | MB4-176(*) | 5.695 | 5.375 | .590 | 4.440 |
| 180 | MB4-180(*) | 5.795 | 5.475 | .590 | 4.540 |
| 184 | MB4-184(*) | 5.895 | 5.575 | .590 | 4.640 |
| 188 | MB4-188(*) | 5.995 | 5.675 | .590 | 4.740 |
| 192 | MB4-192(*) | 6.095 | 5.775 | .590 | 4.840 |
| 196 | MB4-192(*) | 6.195 | 5.875 | .590 | 4.940 |
| 200 | MB4-200(*) | 6.295 | 5.975 | .590 | 5.040 |
| 204 | MB4-204(*) | 6.395 | 6.075 | .590 | 5.140 |
| 208 | MB4-204() | 6.495 | 6.075 | .590 | 5.140 |
| 212 | MB4-212(*) | 6.595 | 6.275 | .590 | 5.340 |
| 216 | MB4-216(*) | 6.695 | 6.375 | .590 | 5.440 |
| 220 | MB4-220(*) | 6.795 | 6.475 | | 5.540 |
| | IVID4-22U() | 0.795 | 0.4/5 | .590 | 5.540 |

| Nicosakas | | | 1 | 1 | |
|--------------|---------------|-----------|--------|------|--------|
| Number of | MB | Α | В | С | G |
| Contacts | Number* | Max. | | Max. | Min. |
| 224 | MB4-224(*) | 6.895 | 6.575 | .590 | 5.640 |
| 228 | MB4-228(*) | 6.995 | 6.675 | .590 | 5.740 |
| 232 | MB4-232(*) | 7.095 | 6.775 | .590 | 5.840 |
| 236 | MB4-236(*) | 7.195 | 6.875 | .590 | 5.940 |
| 240 | MB4-240(*) | 7.295 | 6.975 | .590 | 6.040 |
| 244 | MB4-244(*) | 7.395 | 7.075 | .590 | 6.140 |
| 248 | MB4-248(*) | 7.495 | 7.175 | .590 | 6.240 |
| 252 | MB4-252(*) | 7.595 | 7.275 | .590 | 6.340 |
| 256 | MB4-256(*) | 7.695 | 7.375 | .590 | 6.440 |
| 260 | MB4-260(*) | 7.795 | 7.475 | .590 | 6.540 |
| 264 | MB4-264(*) | 7.895 | 7.575 | .590 | 6.640 |
| 268 | MB4-268(*) | 7.995 | 7.675 | .590 | 6.740 |
| 272 | MB4-272(*) | 8.095 | 7.775 | .590 | 6.840 |
| 276 | MB4-276(*) | 8.195 | 7.875 | .590 | 6.940 |
| 280 | MB4-280(*) | 8.295 | 7.975 | .590 | 7.040 |
| 284 | MB4-284(*) | 8.395 | 8.075 | .590 | 7.140 |
| 288 | MB4-288(*) | 8.495 | 8.175 | .590 | 7.240 |
| 292 | MB4-292(*) | 8.595 | 8.275 | .590 | 7.340 |
| 296 | MB4-296(*) | 8.695 | 8.375 | .590 | 7.440 |
| 300 | MB4-300(*) | 8.795 | 8.475 | .590 | 7.540 |
| 304 | MB4-304(*) | 8.895 | 8.575 | .590 | 7.640 |
| 308 | MB4-308(*) | 8.995 | 8.675 | .590 | 7.740 |
| 312 | MB4-312(*) | 9.095 | 8.775 | .590 | 7.840 |
| 316 | MB4-316(*) | 9.195 | 8.875 | .590 | 7.940 |
| 320 | MB4-320(*) | 9.295 | 8.975 | .590 | 8.040 |
| 324 | MB4-324(*) | 9.395 | 9.075 | .590 | 8.140 |
| 328 | MB4-328(*) | 9.495 | 9.175 | .590 | 8.240 |
| 332 | MB4-332(*) | 9.595 | 9.275 | .590 | 8.340 |
| 336 | MB4-336(*) | 9.695 | 9.375 | .590 | 8.440 |
| 340 | MB4-340(*) | 9.795 | 9.475 | .590 | 8.540 |
| 344 | MB4-344(*) | 9.895 | 9.575 | .590 | 8.640 |
| 348 | MB4-348(*) | 9.995 | 9.675 | .590 | 8.740 |
| 352 | MB4-352(*) | 10.095 | 9.775 | .590 | 8.840 |
| 356 | MB4-356(*) | 10.195 | 9.875 | .590 | 8.940 |
| 360 | MB4-360(*) | 10.295 | 9.975 | .590 | 9.040 |
| 364 | MB4-364(*) | 10.395 | 10.075 | .590 | 9.140 |
| 368 | MB4-368(*) | 10.495 | 10.175 | .590 | 9.240 |
| 372 | MB4-372(*) | 10.595 | 10.275 | .590 | 9.340 |
| 376 | MB4-376(*) | 10.695 | 10.375 | .590 | 9.440 |
| 380 | MB4-380(*) | 10.795 | 10.475 | .590 | 9.540 |
| 384 | MB4-384(*) | 10.895 | 10.575 | .590 | 9.640 |
| 388 | MB4-388(*) | 10.995 | 10.675 | .590 | 9.740 |
| 392 | MB4-392(*) | 11.095 | 10.775 | .590 | 9.840 |
| 396 | MB4-396(*) | 11.195 | 10.875 | .590 | 9.940 |
| 400 | MB4-400(*) | 11.295 | 10.975 | .590 | 10.040 |
| *See How | to Order, pag | es 64-66. | | | |

^{*}See How to Order, pages 64-66.

Rectangular Interconnects



MATES WITH MB AND PC SERIES CONNECTORS

Notes:

When mating with MB or PC connector, a total of .035 inch minimum radial pilot is available for connector body alignment.

All dimensions for reference only.

Polarization keys are not supplied as part of DB Connector Series assemblies. See Accessories How to Order, page 66 and further description, page 90.

Designates Basic Dimension

| Contact Data | | | | | | | |
|--------------|------------------------------------|---|------------|------------|--|--|--|
| Description | Scription Style Letter Arrangement | | J ±.020 | K ±.002 | | | |
| | Р | Α | .085 | .021 Dia. | | | |
| | Р | В | .085 | .021 Dia. | | | |
| | Р | С | .085 | .021 Dia. | | | |
| | Р | D | .085 | .021 Dia. | | | |
| Round PCB | P-(705) | Α | .120 | .021 Dia. | | | |
| Stud, 90° | P-(705) | В | .120 | .021 Dia. | | | |
| Solder | P-(705) | С | .120 | .021 Dia. | | | |
| Termination | P-(705) | D | .120 | .021 Dia. | | | |
| | P-(709) | Α | .300 | .021 Dia. | | | |
| | P-(709) | В | .300 | .021 Dia. | | | |
| | P-(709) | С | .300 | .021 Dia. | | | |
| | P-(709) | D | .300 | .021 Dia. | | | |

NOTE: Other variations available - see pages 65 & 66, or consult Amphenol Aerospace.



Low Mating Force **Daughter Board Connector**

2 ROW CONTACT ARRANGEMENTS

LRM (Line Replaceable Modules)

VME64x / VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302

| Number of | DB | Α | В | С | н | AA |
|--------------|----------|-------|-------|------|------|-------|
| Contacts | Number* | Max. | | Max. | Max. | |
| 020 | DB2-020P | 1.680 | 1.350 | .375 | .545 | .900 |
| 022 | DB2-022P | 1.780 | 1.450 | .375 | .545 | 1.000 |
| 024 | DB2-024P | 1.880 | 1.550 | .375 | .545 | 1.100 |
| 026 | DB2-026P | 1.980 | 1.650 | .375 | .545 | 1.200 |
| 028 | DB2-028P | 2.080 | 1.750 | .375 | .545 | 1.300 |
| 030 | DB2-030P | 2.180 | 1.850 | .375 | .545 | 1.400 |
| 032 | DB2-032P | 2.280 | 1.950 | .375 | .545 | 1.500 |
| 034 | DB2-034P | 2.380 | 2.050 | .375 | .545 | 1.600 |
| 036 | DB2-036P | 2.480 | 2.150 | .375 | .545 | 1.700 |
| 038 | DB2-038P | 2.580 | 2.250 | .375 | .545 | 1.800 |
| 040 | DB2-040P | 2.680 | 2.350 | .375 | .545 | 1.900 |
| 042 | DB2-042P | 2.780 | 2.450 | .375 | .545 | 2.000 |
| 044 | DB2-044P | 2.880 | 2.550 | .375 | .545 | 2.100 |
| 046 | DB2-046P | 2.980 | 2.650 | .375 | .545 | 2.200 |
| 048 | DB2-048P | 3.080 | 2.750 | .375 | .545 | 2.300 |
| 050 | DB2-050P | 3.180 | 2.850 | .375 | .545 | 2.400 |
| 052 | DB2-052P | 3.280 | 2.950 | .375 | .545 | 2.500 |
| 054 | DB2-054P | 3.380 | 3.050 | .375 | .545 | 2.600 |
| 056 | DB2-056P | 3.480 | 3.150 | .375 | .545 | 2.700 |
| 058 | DB2-058P | 3.580 | 3.250 | .375 | .545 | 2.800 |
| 060 | DB2-060P | 3.680 | 3.350 | .375 | .545 | 2.900 |
| 062 | DB2-062P | 3.780 | 3.450 | .375 | .545 | 3.000 |
| 064 | DB2-064P | 3.880 | 3.550 | .375 | .545 | 3.100 |
| 066 | DB2-066P | 3.980 | 3.650 | .375 | .545 | 3.200 |
| 068 | DB2-068P | 4.080 | 3.750 | .375 | .545 | 3.300 |
| 070 | DB2-070P | 4.180 | 3.850 | .375 | .545 | 3.400 |
| 072 | DB2-072P | 4.280 | 3.950 | .375 | .545 | 3.500 |
| 074 | DB2-074P | 4.380 | 4.050 | .375 | .545 | 3.600 |
| 076 | DB2-076P | 4.480 | 4.150 | .375 | .545 | 3.700 |
| 078 | DB2-078P | 4.580 | 4.250 | .375 | .545 | 3.800 |
| 080 | DB2-080P | 4.680 | 4.350 | .375 | .545 | 3.900 |
| 082 | DB2-082P | 4.780 | 4.450 | .375 | .545 | 4.000 |
| 084 | DB2-084P | 4.880 | 4.550 | .375 | .545 | 4.100 |
| 086 | DB2-086P | 4.980 | 4.650 | .375 | .545 | 4.200 |
| 088 | DB2-088P | 5.080 | 4.750 | .375 | .545 | 4.300 |
| 090 | DB2-090P | 5.180 | 4.850 | .375 | .545 | 4.400 |
| 092 | DB2-092P | 5.280 | 4.950 | .375 | .545 | 4.500 |
| 094 | DB2-094P | 5.380 | 5.050 | .375 | .545 | 4.600 |
| 096 | DB2-096P | 5.480 | 5.150 | .375 | .545 | 4.700 |
| 098 | DB2-098P | 5.580 | 5.250 | .375 | .545 | 4.800 |
| 100 | DB2-100P | 5.680 | 5.350 | .375 | .545 | 4.900 |
| 102 | DB2-102P | 5.780 | 5.450 | .375 | .545 | 5.000 |
| 104 | DB2-104P | 5.880 | 5.550 | .375 | .545 | 5.100 |
| 106 | DB2-106P | 5.980 | 5.650 | .375 | .545 | 5.200 |
| 108 | DB2-108P | 6.080 | 5.750 | .375 | .545 | 5.300 |
| 110 | DB2-110P | 6.180 | 5.850 | .375 | .545 | 5.400 |

| Number | DB | _ | _ | | Н | AA |
|----------------|----------|-----------|--------|-----------|-----------|-------|
| of Contacts | Number* | A Max. | В | C Max. | П Мах. | AA |
| 112 | DB2-112P | 6.280 | 5.950 | .375 | .545 | 5.500 |
| 114 | DB2-114P | 6.380 | 6.050 | .375 | .545 | 5.600 |
| 116 | DB2-116P | 6.480 | 6.150 | .375 | .545 | 5.700 |
| 118 | DB2-118P | 6.580 | 6.250 | .375 | .545 | 5.800 |
| 120 | DB2-120P | 6.680 | 6.350 | .375 | .545 | 5.900 |
| 122 | DB2-122P | 6.780 | 6.450 | .375 | .545 | 6.000 |
| 124 | DB2-124P | 6.880 | 6.550 | .375 | .545 | 6.100 |
| 126 | DB2-126P | 6.980 | 6.650 | .375 | .545 | 6.200 |
| 128 | DB2-128P | 7.080 | 6.750 | .375 | .545 | 6.300 |
| 130 | DB2-130P | 7.180 | 6.850 | .375 | .545 | 6.400 |
| 132 | DB2-132P | 7.280 | 6.950 | .375 | .545 | 6.500 |
| 134 | DB2-134P | 7.380 | 7.050 | .375 | .545 | 6.600 |
| 136 | DB2-136P | 7.480 | 7.150 | .375 | .545 | 6.700 |
| 138 | DB2-138P | 7.580 | 7.250 | .375 | .545 | 6.800 |
| 140 | DB2-140P | 7.680 | 7.350 | .375 | .545 | 6.900 |
| 142 | DB2-142P | 7.780 | 7.450 | .375 | .545 | 7.000 |
| 144 | DB2-144P | 7.880 | 7.550 | .375 | .545 | 7.100 |
| 146 | DB2-146P | 7.980 | 7.650 | .375 | .545 | 7.200 |
| 148 | DB2-148P | 8.080 | 7.750 | .375 | .545 | 7.300 |
| 150 | DB2-150P | 8.180 | 7.850 | .375 | .545 | 7.400 |
| 152 | DB2-152P | 8.280 | 7.950 | .375 | .545 | 7.500 |
| 154 | DB2-154P | 8.380 | 8.050 | .375 | .545 | 7.600 |
| 156 | DB2-156P | 8.480 | 8.150 | .375 | .545 | 7.700 |
| 158 | DB2-158P | 8.580 | 8.250 | .375 | .545 | 7.800 |
| 160 | DB2-160P | 8.680 | 8.350 | .375 | .545 | 7.900 |
| 162 | DB2-162P | 8.780 | 8.450 | .375 | .545 | 8.000 |
| 164 | DB2-164P | 8.880 | 8.550 | .375 | .545 | 8.100 |
| 166 | DB2-166P | 8.980 | 8.650 | .375 | .545 | 8.200 |
| 168 | DB2-168P | 9.080 | 8.750 | .375 | .545 | 8.300 |
| 170 | DB2-170P | 9.180 | 8.850 | .375 | .545 | 8.400 |
| 172 | DB2-172P | 9.280 | 8.950 | .375 | .545 | 8.500 |
| 174 | DB2-174P | 9.380 | 9.050 | .375 | .545 | 8.600 |
| 176 | DB2-176P | 9.480 | 9.150 | .375 | .545 | 8.700 |
| 178 | DB2-178P | 9.580 | 9.250 | .375 | .545 | 8.800 |
| 180 | DB2-180P | 9.680 | 9.350 | .375 | .545 | 8.900 |
| 182 | DB2-182P | 9.780 | 9.450 | .375 | .545 | 9.000 |
| 184 | DB2-184P | 9.880 | 9.550 | .375 | .545 | 9.100 |
| 186 | DB2-186P | 9.980 | 9.650 | .375 | .545 | 9.200 |
| 188 | DB2-188P | 10.080 | 9.750 | .375 | .545 | 9.300 |
| 190 | DB2-190P | 10.180 | 9.850 | .375 | .545 | 9.400 |
| 192 | DB2-192P | 10.280 | 9.950 | .375 | .545 | 9.500 |
| 194 | DB2-194P | 10.380 | 10.050 | .375 | .545 | 9.600 |
| 196 | DB2-196P | 10.480 | 10.150 | .375 | .545 | 9.700 |
| 198 | DB2-198P | 10.580 | 10.250 | .375 | .545 | 9.800 |
| 200 | DB2-200P | 10.680 | 10.350 | .375 | .545 | 9.900 |
| *Coo How to | Oud | 64.66 | | | | |

^{*}See How to Order, pages 64-66.

Low Mating Force Daughter Board Connector

Amphenol Aerospace

3 ROW CONTACT ARRANGEMENTS

| Number of Contacts | DB Number* | A Max. | В | C Max. | H Max. | АА |
|--------------------------|---------------|-----------|-------|-----------|-----------|-------|
| 030 | DB3-030P | 1.680 | 1.350 | .475 | .645 | .900 |
| 033 | DB3-033P | 1.780 | 1.450 | .475 | .645 | 1.000 |
| 036 | DB3-036P | 1.880 | 1.550 | .475 | .645 | 1.100 |
| 039 | DB3-039P | 1.980 | 1.650 | .475 | .645 | 1.200 |
| 042 | DB3-042P | 2.080 | 1.750 | .475 | .645 | 1.300 |
| 045 | DB3-045P | 2.180 | 1.850 | .475 | .645 | 1.400 |
| 048 | DB3-048P | 2.280 | 1.950 | .475 | .645 | 1.500 |
| 051 | DB3-051P | 2.380 | 2.050 | .475 | .645 | 1.600 |
| 054 | DB3-054P | 2.480 | 2.150 | .475 | .645 | 1.700 |
| 057 | DB3-057P | 2.580 | 2.250 | .475 | .645 | 1.800 |
| 060 | DB3-060P | 2.680 | 2.350 | .475 | .645 | 1.900 |
| 063 | DB3-063P | 2.780 | 2.450 | .475 | .645 | 2.000 |
| 066 | DB3-066P | 2.880 | 2.550 | .475 | .645 | 2.100 |
| 069 | DB3-069P | 2.980 | 2.650 | .475 | .645 | 2.200 |
| 072 | DB3-072P | 3.080 | 2.750 | .475 | .645 | 2.300 |
| 075 | DB3-075P | 3.180 | 2.850 | .475 | .645 | 2.400 |
| 078 | DB3-078P | 3.280 | 2.950 | .475 | .645 | 2.500 |
| 081 | DB3-081P | 3.380 | 3.050 | .475 | .645 | 2.600 |
| 084 | DB3-084P | 3.480 | 3.150 | .475 | .645 | 2.700 |
| 087 | DB3-087P | 3.580 | 3.250 | .475 | .645 | 2.800 |
| 090 | DB3-090P | 3.680 | 3.350 | .475 | .645 | 2.900 |
| 093 | DB3-093P | 3.780 | 3.450 | .475 | .645 | 3.000 |
| 096 | DB3-096P | 3.880 | 3.550 | .475 | .645 | 3.100 |
| 099 | DB3-099P | 3.980 | 3.650 | .475 | .645 | 3.200 |
| 102 | DB3-102P | 4.080 | 3.750 | .475 | .645 | 3.300 |
| 105 | DB3-105P | 4.180 | 3.850 | .475 | .645 | 3.400 |
| 108 | DB3-108P | 4.280 | 3.950 | .475 | .645 | 3.500 |
| 111 | DB3-111P | 4.380 | 4.050 | .475 | .645 | 3.600 |
| 114 | DB3-114P | 4.480 | 4.150 | .475 | .645 | 3.700 |
| 117 | DB3-117P | 4.580 | 4.250 | .475 | .645 | 3.800 |
| 120 | DB3-120P | 4.680 | 4.350 | .475 | .645 | 3.900 |
| 123 | DB3-123P | 4.780 | 4.450 | .475 | .645 | 4.000 |
| 126 | DB3-126P | 4.880 | 4.550 | .475 | .645 | 4.100 |
| 129 | DB3-129P | 4.980 | 4.650 | .475 | .645 | 4.200 |
| 132 | DB3-132P | 5.080 | 4.750 | .475 | .645 | 4.300 |
| 135 | DB3-135P | 5.180 | 4.850 | .475 | .645 | 4.400 |
| 138 | DB3-138P | 5.280 | 4.950 | .475 | .645 | 4.500 |
| 141 | DB3-141P | 5.380 | 5.050 | .475 | .645 | 4.600 |
| 144 | DB3-144P | 5.480 | 5.150 | .475 | .645 | 4.700 |
| 147 | DB3-147P | 5.580 | 5.250 | .475 | .645 | 4.800 |
| 150 | DB3-150P | 5.680 | 5.350 | .475 | .645 | 4.900 |
| 153 | DB3-153P | 5.780 | 5.450 | .475 | .645 | 5.000 |
| 156 | DB3-156P | 5.880 | 5.550 | .475 | .645 | 5.100 |
| 159 | DB3-159P | 5.980 | 5.650 | .475 | .645 | 5.200 |
| 162 | DB3-162P | 6.080 | 5.750 | .475 | .645 | 5.300 |
| 165 | DB3-165P | 6.180 | 5.850 | .475 | .645 | 5.400 |

| Number of | DB | Α | В | С | Н | AA |
|--------------|---------------|---------|--------|------|------|-------|
| Contacts | Number* | Max. | | Max. | Max. | ,,,, |
| 168 | DB3-168P | 6.280 | 5.950 | .475 | .645 | 5.500 |
| 171 | DB3-171P | 6.380 | 6.050 | .475 | .645 | 5.600 |
| 174 | DB3-174P | 6.480 | 6.150 | .475 | .645 | 5.700 |
| 177 | DB3-177P | 6.580 | 6.250 | .475 | .645 | 5.800 |
| 180 | DB3-180P | 6.680 | 6.350 | .475 | .645 | 5.900 |
| 183 | DB3-183P | 6.780 | 6.450 | .475 | .645 | 6.000 |
| 186 | DB3-186P | 6.880 | 6.550 | .475 | .645 | 6.100 |
| 189 | DB3-189P | 6.980 | 6.650 | .475 | .645 | 6.200 |
| 192 | DB3-192P | 7.080 | 6.750 | .475 | .645 | 6.300 |
| 195 | DB3-195P | 7.180 | 6.850 | .475 | .645 | 6.400 |
| 198 | DB3-198P | 7.280 | 6.950 | .475 | .645 | 6.500 |
| 201 | DB3-201P | 7.380 | 7.050 | .475 | .645 | 6.600 |
| 204 | DB3-204P | 7.480 | 7.150 | .475 | .645 | 6.700 |
| 207 | DB3-207P | 7.580 | 7.250 | .475 | .645 | 6.800 |
| 210 | DB3-210P | 7.680 | 7.350 | .475 | .645 | 6.900 |
| 213 | DB3-213P | 7.780 | 7.450 | .475 | .645 | 7.000 |
| 216 | DB3-216P | 7.880 | 7.550 | .475 | .645 | 7.100 |
| 219 | DB3-219P | 7.980 | 7.650 | .475 | .645 | 7.200 |
| 222 | DB3-222P | 8.080 | 7.750 | .475 | .645 | 7.300 |
| 225 | DB3-225P | 8.180 | 7.850 | .475 | .645 | 7.400 |
| 228 | DB3-228P | 8.280 | 7.950 | .475 | .645 | 7.500 |
| 231 | DB3-231P | 8.380 | 8.050 | .475 | .645 | 7.600 |
| 234 | DB3-234P | 8.480 | 8.150 | .475 | .645 | 7.700 |
| 237 | DB3-237P | 8.580 | 8.250 | .475 | .645 | 7.800 |
| 240 | DB3-240P | 8.680 | 8.350 | .475 | .645 | 7.900 |
| 243 | DB3-243P | 8.780 | 8.450 | .475 | .645 | 8.000 |
| 246 | DB3-246P | 8.880 | 8.550 | .475 | .645 | 8.100 |
| 249 | DB3-249P | 8.980 | 8.650 | .475 | .645 | 8.200 |
| 252 | DB3-252P | 9.080 | 8.750 | .475 | .645 | 8.300 |
| 255 | DB3-255P | 9.180 | 8.850 | .475 | .645 | 8.400 |
| 258 | DB3-258P | 9.280 | 8.950 | .475 | .645 | 8.500 |
| 261 | DB3-261P | 9.380 | 9.050 | .475 | .645 | 8.600 |
| 264 | DB3-264P | 9.480 | 9.150 | .475 | .645 | 8.700 |
| 267 | DB3-267P | 9.580 | 9.250 | .475 | .645 | 8.800 |
| 270 | DB3-270P | 9.680 | 9.350 | .475 | .645 | 8.900 |
| 273 | DB3-273P | 9.780 | 9.450 | .475 | .645 | 9.000 |
| 276 | DB3-276P | 9.880 | 9.550 | .475 | .645 | 9.100 |
| 279 | DB3-279P | 9.980 | 9.650 | .475 | .645 | 9.200 |
| 282 | DB3-282P | 10.080 | 9.750 | .475 | .645 | 9.300 |
| 285 | DB3-285P | 10.180 | 9.850 | .475 | .645 | 9.400 |
| 288 | DB3-288P | 10.280 | 9.950 | .475 | .645 | 9.500 |
| 291 | DB3-291P | 10.380 | 10.050 | .475 | .645 | 9.600 |
| 294 | DB3-294P | 10.480 | 10.150 | .475 | .645 | 9.700 |
| 297 | DB3-397P | 10.580 | 10.250 | .475 | .645 | 9.800 |
| 300 | DB3-300P | 10.680 | 10.350 | .475 | .645 | 9.900 |
| *Coo How + | o Ordor, page | ~ E4 EE | | | | |

^{*}See How to Order, pages 64-66.



Low Mating Force **Daughter Board Connector**

4 ROW CONTACT ARRANGEMENTS

Pkg. Solutions,

LRM (Line Replaceable Modules)

VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302

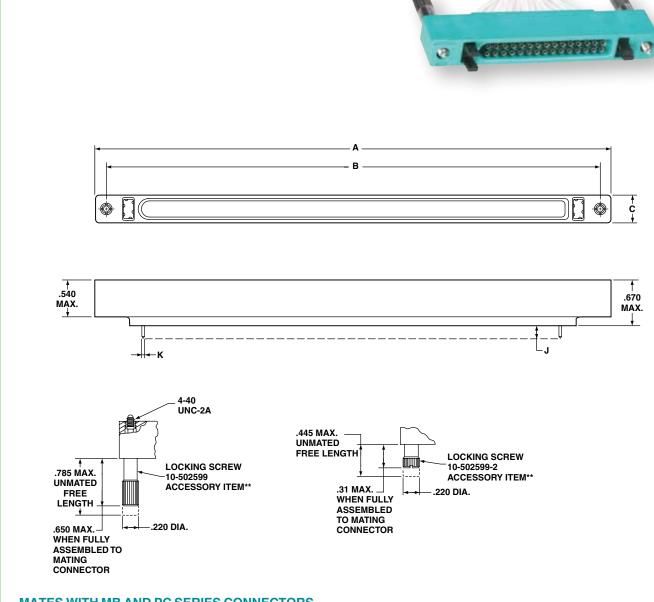
| Number of Contacts | DB Number* | A Max. | В | C Max. | H Max. | AA |
|--------------------------|---------------|-----------|-------|-----------|-----------|-------|
| 040 | DB4-040P | 1.680 | 1.350 | .575 | .745 | .900 |
| 044 | DB4-044P | 1.780 | 1.450 | .575 | .745 | 1.000 |
| 048 | DB4-048P | 1.880 | 1.550 | .575 | .745 | 1.100 |
| 052 | DB4-052P | 1.980 | 1.650 | .575 | .745 | 1.200 |
| 056 | DB4-056P | 2.080 | 1.750 | .575 | .745 | 1.300 |
| 060 | DB4-060P | 2.180 | 1.850 | .575 | .745 | 1.400 |
| 064 | DB4-064P | 2.280 | 1.950 | .575 | .745 | 1.500 |
| 068 | DB4-068P | 2.380 | 2.050 | .575 | .745 | 1.600 |
| 072 | DB4-072P | 2.480 | 2.150 | .575 | .745 | 1.700 |
| 076 | DB4-076P | 2.580 | 2.250 | .575 | .745 | 1.800 |
| 080 | DB4-080P | 2.680 | 2.350 | .575 | .745 | 1.900 |
| 084 | DB4-084P | 2.780 | 2.450 | .575 | .745 | 2.000 |
| 088 | DB4-088P | 2.880 | 2.550 | .575 | .745 | 2.100 |
| 092 | DB4-092P | 2.980 | 2.650 | .575 | .745 | 2.200 |
| 096 | DB4-096P | 3.080 | 2.750 | .575 | .745 | 2.300 |
| 100 | DB4-100P | 3.180 | 2.850 | .575 | .745 | 2.400 |
| 104 | DB4-104P | 3.280 | 2.950 | .575 | .745 | 2.500 |
| 108 | DB4-108P | 3.380 | 3.050 | .575 | .745 | 2.600 |
| 112 | DB4-112P | 3.480 | 3.150 | .575 | .745 | 2.700 |
| 116 | DB4-116P | 3.580 | 3.250 | .575 | .745 | 2.800 |
| 120 | DB4-120P | 3.680 | 3.350 | .575 | .745 | 2.900 |
| 124 | DB4-124P | 3.780 | 3.450 | .575 | .745 | 3.000 |
| 128 | DB4-128P | 3.880 | 3.550 | .575 | .745 | 3.100 |
| 132 | DB4-132P | 3.980 | 3.650 | .575 | .745 | 3.200 |
| 136 | DB4-136P | 4.080 | 3.750 | .575 | .745 | 3.300 |
| 140 | DB4-140P | 4.180 | 3.850 | .575 | .745 | 3.400 |
| 144 | DB4-144P | 4.280 | 3.950 | .575 | .745 | 3.500 |
| 148 | DB4-148P | 4.380 | 4.050 | .575 | .745 | 3.600 |
| 152 | DB4-152P | 4.480 | 4.150 | .575 | .745 | 3.700 |
| 156 | DB4-156P | 4.580 | 4.250 | .575 | .745 | 3.800 |
| 160 | DB4-160P | 4.680 | 4.350 | .575 | .745 | 3.900 |
| 164 | DB4-164P | 4.780 | 4.450 | .575 | .745 | 4.000 |
| 168 | DB4-168P | 4.880 | 4.550 | .575 | .745 | 4.100 |
| 172 | DB4-172P | 4.980 | 4.650 | .575 | .745 | 4.200 |
| 176 | DB4-176P | 5.080 | 4.750 | .575 | .745 | 4.300 |
| 180 | DB4-180P | 5.180 | 4.850 | .575 | .745 | 4.400 |
| 184 | DB4-184P | 5.280 | 4.950 | .575 | .745 | 4.500 |
| 188 | DB4-188P | 5.380 | 5.050 | .575 | .745 | 4.600 |
| 192 | DB4-192P | 5.480 | 5.150 | .575 | .745 | 4.700 |
| 196 | DB4-196P | 5.580 | 5.250 | .575 | .745 | 4.800 |
| 200 | DB4-200P | 5.680 | 5.350 | .575 | .745 | 4.900 |
| 204 | DB4-204P | 5.780 | 5.450 | .575 | .745 | 5.000 |
| 208 | DB4-208P | 5.880 | 5.550 | .575 | .745 | 5.100 |
| 212 | DB4-212P | 5.980 | 5.650 | .575 | .745 | 5.200 |
| 216 | DB4-216P | 6.080 | 5.750 | .575 | .745 | 5.300 |
| 220 | DB4-220P | 6.180 | 5.850 | .575 | .745 | 5.400 |

| Number | | | | | | |
|----------------|---------------|-----------|--------|-----------|-----------|-------|
| of Contacts | DB Number* | A Max. | В | C Max. | H Max. | AA |
| 224 | DB4-224P | 6.280 | 5.950 | .575 | .745 | 5.500 |
| 228 | DB4-228P | 6.380 | 6.050 | .575 | .745 | 5.600 |
| 232 | DB4-232P | 6.480 | 6.150 | .575 | .745 | 5.700 |
| 236 | DB4-236P | 6.580 | 6.250 | .575 | .745 | 5.800 |
| 240 | DB4-240P | 6.680 | 6.350 | .575 | .745 | 5.900 |
| 244 | DB4-244P | 6.780 | 6.450 | .575 | .745 | 6.000 |
| 248 | DB4-248P | 6.880 | 6.550 | .575 | .745 | 6.100 |
| 252 | DB4-252P | 6.980 | 6.650 | .575 | .745 | 6.200 |
| 256 | DB4-256P | 7.080 | 6.750 | .575 | .745 | 6.300 |
| 260 | DB4-260P | 7.180 | 6.850 | .575 | .745 | 6.400 |
| 264 | DB4-264P | 7.280 | 6.950 | .575 | .745 | 6.500 |
| 268 | DB4-268P | 7.380 | 7.050 | .575 | .745 | 6.600 |
| 272 | DB4-272P | 7.480 | 7.150 | .575 | .745 | 6.700 |
| 276 | DB4-276P | 7.580 | 7.250 | .575 | .745 | 6.800 |
| 280 | DB4-280P | 7.680 | 7.350 | .575 | .745 | 6.900 |
| 284 | DB4-284P | 7.780 | 7.450 | .575 | .745 | 7.000 |
| 288 | DB4-288P | 7.780 | 7.550 | .575 | .745 | 7.100 |
| 292 | DB4-292P | 7.980 | 7.650 | .575 | .745 | 7.200 |
| 296 | DB4-296P | 8.080 | 7.750 | .575 | .745 | 7.300 |
| 300 | DB4-300P | 8.180 | 7.850 | .575 | .745 | 7.400 |
| 304 | DB4-304P | 8.280 | 7.950 | .575 | .745 | 7.500 |
| 308 | DB4-308P | 8.380 | 8.050 | .575 | .745 | 7.600 |
| 312 | DB4-312P | 8.480 | 8.150 | .575 | .745 | 7.700 |
| 316 | DB4-316P | 8.580 | 8.250 | .575 | .745 | 7.800 |
| 320 | DB4-320P | 8.680 | 8.350 | .575 | .745 | 7.900 |
| 324 | DB4-324P | 8.780 | 8.450 | .575 | .745 | 8.000 |
| 328 | DB4-328P | 8.880 | 8.550 | .575 | .745 | 8.100 |
| 332 | DB4-332P | 8.980 | 8.650 | .575 | .745 | 8.200 |
| 336 | DB4-336P | 9.080 | 8.750 | .575 | .745 | 8.300 |
| 340 | DB4-340P | 9.180 | 8.850 | .575 | .745 | 8.400 |
| 344 | DB4-344P | 9.280 | 8.950 | .575 | .745 | 8.500 |
| 348 | DB4-348P | 9.380 | 9.050 | .575 | .745 | 8.600 |
| 352 | DB4-352P | 9.480 | 9.150 | .575 | .745 | 8.700 |
| 356 | DB4-356P | 9.580 | 9.250 | .575 | .745 | 8.800 |
| 360 | DB4-360P | 9.680 | 9.350 | .575 | .745 | 8.900 |
| 364 | DB4-364P | 9.780 | 9.450 | .575 | .745 | 9.000 |
| 368 | DB4-368P | 9.880 | 9.550 | .575 | .745 | 9.100 |
| 372 | DB4-372P | 9.980 | 9.650 | .575 | .745 | 9.200 |
| 376 | DB4-376P | 10.080 | 9.750 | .575 | .745 | 9.300 |
| 380 | DB4-380P | 10.180 | 9.850 | .575 | .745 | 9.400 |
| 384 | DB4-384P | 10.280 | 9.950 | .575 | .745 | 9.500 |
| 388 | DB4-388P | 10.380 | 10.050 | .575 | .745 | 9.600 |
| 392 | DB4-392P | 10.480 | 10.150 | .575 | .745 | 9.700 |
| 396 | DB4-396P | 10.580 | 10.250 | .575 | .745 | 9.800 |
| 400 | DB4-400P | 10.680 | 10.350 | .575 | .745 | 9.900 |

^{*}See How to Order, pages 64-66.

Ruggedized

Interconnects Kectangular



MATES WITH MB AND PC SERIES CONNECTORS

When mating with MB or PC connector, a total of .022 inch minimum radial pilot is available for connector body alignment.

All dimensions for reference only.

Crimp contact, wire well size 22D, supplied with IO Connector Series assemblies. Optional noble metal termination plating available. See How to Order, page 66.

Polarization keys are not supplied as part of IO Connector Series assemblies. See Accessories How to Order, page 66 and further

** Locking Screws are not supplied as part of IO Connector Series assemblies. See Accessories How to Order, page 66 and further description, page 93.

| Contact Data | | | | | | | |
|---------------------------------|--------------------------------|------------|------------|--|--|--|--|
| Description | Termination Style Letter | J ±.020 | K ±.002 | | | | |
| Rear Removable Crimp Contact | С | N/A | N/A | | | | |
| Round PCB | Р | .145 | .021 | | | | |
| Stud Solder | P-(713) | .060 | .021 | | | | |
| Termination | P-(709) | .335 | .021 | | | | |

NOTE: Other variations available - see pages 65 & 66, or consult Amphenol Aerospace.



Low Mating Force Input/Output Connector

2 ROW CONTACT ARRANGEMENTS

Brush Contact Pkg. Solutions,

| Hybrids - Fiber Optics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

Ruggedized VME64x / VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302

| Nicosia | | | | |
|--------------------------|---------------|-----------|-------|-----------|
| Number of Contacts | IO Number* | A Max. | В | C Max. |
| | | | 1.075 | |
| 020 | IO2-020(*) | 2.295 | 1.975 | .390 |
| 022 | IO2-022(*) | 2.395 | 2.075 | |
| 024 | IO2-024(*) | 2.495 | 2.175 | .390 |
| 026 | IO2-026(*) | 2.595 | 2.275 | .390 |
| 028 | IO2-028(*) | 2.695 | 2.375 | .390 |
| 030 | IO2-030(*) | 2.795 | 2.475 | .390 |
| 032 | IO2-032(*) | 2.895 | 2.575 | .390 |
| 034 | IO2-034(*) | 2.995 | 2.675 | .390 |
| 036 | IO2-036(*) | 3.095 | 2.775 | .390 |
| 038 | IO2-038(*) | 3.195 | 2.875 | .390 |
| 040 | IO2-040(*) | 3.295 | 2.975 | .390 |
| 042 | IO2-042(*) | 3.395 | 3.075 | .390 |
| 044 | IO2-044(*) | 3.495 | 3.175 | .390 |
| 046 | IO2-046(*) | 3.595 | 3.275 | .390 |
| 048 | IO2-048(*) | 3.695 | 3.375 | .390 |
| 050 | IO2-050(*) | 3.795 | 3.475 | .390 |
| 052 | IO2-052(*) | 3.895 | 3.575 | .390 |
| 054 | IO2-054(*) | 3.995 | 3.675 | .390 |
| 056 | IO2-056(*) | 4.095 | 3.775 | .390 |
| 058 | IO2-058(*) | 4.195 | 3.875 | .390 |
| 060 | IO2-060(*) | 4.295 | 3.975 | .390 |
| 062 | IO2-062(*) | 4.395 | 4.075 | .390 |
| 064 | IO2-064(*) | 4.495 | 4.175 | .390 |
| 066 | IO2-066(*) | 4.595 | 4.275 | .390 |
| 068 | IO2-068(*) | 4.695 | 4.375 | .390 |
| 070 | IO2-070(*) | 4.795 | 4.475 | .390 |
| 072 | IO2-072(*) | 4.895 | 4.575 | .390 |
| 074 | IO2-074(*) | 4.995 | 4.675 | .390 |
| 076 | IO2-076(*) | 5.095 | 4.775 | .390 |
| 078 | IO2-078(*) | 5.195 | 4.875 | .390 |
| 080 | IO2-080(*) | 5.295 | 4.975 | .390 |
| 082 | IO2-082(*) | 5.395 | 5.075 | .390 |
| 084 | IO2-084(*) | 5.495 | 5.175 | .390 |
| 086 | IO2-086(*) | 5.595 | 5.275 | .390 |
| 088 | IO2-088(*) | 5.695 | 5.375 | .390 |
| 090 | IO2-090(*) | 5.795 | 5.475 | .390 |
| 092 | IO2-092(*) | 5.895 | 5.575 | .390 |
| 094 | IO2-094(*) | 5.995 | 5.675 | .390 |
| 096 | IO2-096(*) | 6.095 | 5.775 | .390 |
| 098 | IO2-098(*) | 6.195 | 5.875 | .390 |
| 100 | IO2-100(*) | 6.295 | 5.975 | .390 |
| 102 | IO2-102(*) | 6.395 | 6.075 | .390 |
| 104 | IO2-104(*) | 6.495 | 6.175 | .390 |
| 106 | IO2-106(*) | 6.595 | 6.275 | .390 |
| 108 | IO2-108(*) | 6.695 | 6.375 | .390 |
| 110 | IO2-110(*) | 6.795 | 6.475 | .390 |

| Number of Contacts | IO Number* | A Max. | В | C Max. | | | |
|--------------------------------|--------------------------|-----------|--------|-----------|--|--|--|
| 112 | IO2-112(*) | 6.895 | 6.575 | .390 | | | |
| 114 | IO2-114(*) | 6.995 | 6.675 | .390 | | | |
| 116 | IO2-114() | 7.095 | 6.775 | .390 | | | |
| 118 | IO2-118(*) | 7.195 | 6.875 | .390 | | | |
| 120 | IO2-120(*) | 7.195 | 6.975 | .390 | | | |
| 122 | IO2-122(*) | 7.395 | 7.075 | .390 | | | |
| 124 | IO2-124(*) | 7.495 | 7.175 | .390 | | | |
| 126 | IO2-124() | 7.495 | 7.175 | .390 | | | |
| 128 | IO2-128(*) | 7.695 | 7.275 | .390 | | | |
| | IO2-128() IO2-130(*) | | | | | | |
| 130 | | 7.795 | 7.475 | .390 | | | |
| 132 | IO2-132(*) | 7.895 | 7.575 | .390 | | | |
| 134 | IO2-134(*) | 7.995 | 7.675 | .390 | | | |
| 136 | IO2-136(*) | 8.095 | 7.775 | .390 | | | |
| 138 | IO2-138(*) | 8.195 | 7.875 | .390 | | | |
| 140 | IO2-140(*) | 8.295 | 7.975 | .390 | | | |
| 142 | IO2-142(*) | 8.395 | 8.075 | .390 | | | |
| 144 | IO2-144(*) | 8.495 | 8.175 | .390 | | | |
| 146 | IO2-146(*) | 8.595 | 8.275 | .390 | | | |
| 148 | IO2-148(*) | 8.695 | 8.375 | .390 | | | |
| 150 | IO2-150(*) | 8.795 | 8.475 | .390 | | | |
| 152 | IO2-152(*) | 8.895 | 8.575 | .390 | | | |
| 154 | IO2-154(*) | 8.995 | 8.675 | .390 | | | |
| 156 | IO2-156(*) | 9.095 | 8.775 | .390 | | | |
| 158 | IO2-158)*) | 9.195 | 8.875 | .390 | | | |
| 160 | IO2-160(*) | 9.295 | 8.975 | .390 | | | |
| 162 | IO2-162(*) | 9.395 | 9.075 | .390 | | | |
| 164 | IO2-164(*) | 9.495 | 9.175 | .390 | | | |
| 166 | IO2-166(*) | 9.595 | 9.275 | .390 | | | |
| 168 | IO2-168(*) | 9.695 | 9.375 | .390 | | | |
| 170 | IO2-170(*) | 9.795 | 9.475 | .390 | | | |
| 172 | IO2-172(*) | 9.895 | 9.575 | .390 | | | |
| 174 | IO2-174(*) | 9.995 | 9.675 | .390 | | | |
| 176 | IO2-176(*) | 10.095 | 9.775 | .390 | | | |
| 178 | IO2-178(*) | 10.195 | 9.875 | .390 | | | |
| 180 | IO2-180(*) | 10.295 | 9.975 | .390 | | | |
| 182 | IO2-182(*) | 10.395 | 10.075 | .390 | | | |
| 184 | IO2-184(*) | 10.495 | 10.175 | .390 | | | |
| 186 | IO2-186(*) | 10.595 | 10.275 | .390 | | | |
| 188 | IO2-188(*) | 10.695 | 10.375 | .390 | | | |
| 190 | IO2-190(*) | 10.795 | 10.475 | .390 | | | |
| 192 | IO2-192(*) | 10.795 | 10.575 | .390 | | | |
| 194 | IO2-194(*) | 10.995 | 10.675 | .390 | | | |
| 196 | IO2-194() | 11.095 | 10.075 | .390 | | | |
| 198 | IO2-190() | 11.195 | 10.775 | .390 | | | |
| 200 | IO2-198() | 11.295 | 10.875 | .390 | | | |
| | | | 10.373 | .030 | | | |
| See How to Order, pages 64-66. | | | | | | | |

Low Mating Force Input/Output Connector

Amphenol Aerospace

3 ROW CONTACT ARRANGEMENTS

| Number of Contacts | IO Number* | A Max. | В | C Max. |
|--------------------------|---------------|-----------|-------|-----------|
| 030 | IO3-030(*) | 2.295 | 1.975 | .490 |
| 033 | IO3-033(*) | 2.395 | 2.075 | .490 |
| 036 | IO3-036(*) | 2.495 | 2.175 | .490 |
| 039 | IO3-039(*) | 2.595 | 2.275 | .490 |
| 042 | IO3-042(*) | 2.695 | 2.375 | .490 |
| 045 | IO3-045(*) | 2.795 | 2.475 | .490 |
| 048 | IO3-048(*) | 2.894 | 2.575 | .490 |
| 051 | IO3-051(*) | 2.995 | 2.675 | .490 |
| 054 | IO3-054(*) | 3.095 | 2.775 | .490 |
| 057 | IO3-057(*) | 3.195 | 2.875 | .490 |
| 060 | IO3-060(*) | 3.295 | 2.975 | .490 |
| 063 | IO3-063(*) | 3.395 | 3.075 | .490 |
| 066 | IO3-066(*) | 3.495 | 3.175 | .490 |
| 069 | IO3-069(*) | 3.595 | 3.275 | .490 |
| 072 | IO3-072(*) | 3.695 | 3.375 | .490 |
| 075 | IO3-075(*) | 3.795 | 3.475 | .490 |
| 078 | IO3-078(*) | 3.895 | 3.575 | .490 |
| 081 | IO3-081(*) | 3.995 | 3.675 | .490 |
| 084 | IO3-084(*) | 4.095 | 3.775 | .490 |
| 087 | IO3-087(*) | 4.195 | 3.875 | .490 |
| 090 | IO3-090(*) | 4.295 | 3.975 | .490 |
| 090 | IO3-090(*) | 4.395 | 4.075 | .490 |
| 096 | IO3-095(*) | 4.495 | 4.175 | .490 |
| 099 | IO3-099(*) | 4.595 | 4.275 | .490 |
| 102 | IO3-102(*) | 4.695 | 4.375 | .490 |
| 105 | IO3-105(*) | 4.795 | 4.475 | .490 |
| 108 | IO3-108(*) | 4.895 | 4.575 | .490 |
| 111 | IO3-100() | 4.995 | 4.675 | .490 |
| 114 | IO3-114(*) | 5.095 | 4.775 | .490 |
| 117 | IO3-117(*) | 5.195 | 4.875 | .490 |
| 120 | IO3-117() | 5.295 | 4.975 | .490 |
| 123 | IO3-120(*) | 5.395 | 5.075 | .490 |
| 126 | IO3-126(*) | 5.495 | 5.175 | .490 |
| 129 | IO3-120() | 5.595 | 5.275 | .490 |
| 132 | IO3-129() | 5.695 | 5.375 | .490 |
| 135 | IO3-135(*) | 5.795 | 5.475 | .490 |
| 138 | IO3-138(*) | 5.895 | 5.575 | .490 |
| 141 | IO3-141(*) | 5.995 | 5.675 | .490 |
| 144 | IO3-141(*) | 6.095 | 5.775 | .490 |
| 147 | IO3-144() | 6.195 | 5.875 | .490 |
| 150 | IO3-147() | 6.295 | 5.975 | .490 |
| 153 | IO3-153(*) | 6.395 | 6.075 | .490 |
| 156 | IO3-156(*) | 6.495 | 6.175 | .490 |
| 159 | IO3-159(*) | 6.595 | 6.275 | .490 |
| 162 | IO3-162(*) | 6.695 | 6.375 | .490 |
| 165 | IO3-165(*) | 6.795 | 6.475 | .490 |
| 100 | 100 100() | 0.700 | 0.470 | 50 |

| | | 1 | | |
|--------------------|------------------|-----------|--------|-----------|
| Number of Contacts | IO Number* | A Max. | В | C Max. |
| | | | | |
| 168 | IO3-168(*) | 6.895 | 6.575 | .490 |
| 171 | IO3-171(*) | 6.995 | 6.675 | .490 |
| 174 | IO3-174(*) | 7.095 | 6.775 | .490 |
| 177 | IO3-177(*) | 7.195 | 6.875 | .490 |
| 180 | IO3-180(*) | 7.295 | 6.975 | .490 |
| 183 | IO3-183(*) | 7.395 | 7.075 | .490 |
| 186 | IO3-186(*) | 7.495 | 7.175 | .490 |
| 189 | IO3-189(*) | 7.595 | 7.275 | .490 |
| 192 | IO3-192(*) | 7.695 | 7.375 | .490 |
| 195 | IO3-195(*) | 7.795 | 7.475 | .490 |
| 198 | IO3-198(*) | 7.895 | 7.575 | .490 |
| 201 | IO3-201(*) | 7.995 | 7.675 | .490 |
| 204 | IO3-204(*) | 8.095 | 7.775 | .490 |
| 207 | IO3-207(*) | 8.195 | 7.875 | .490 |
| 210 | IO3-210(*) | 8.295 | 7.975 | .490 |
| 213 | IO3-213(*) | 8.395 | 8.075 | .490 |
| 216 | IO3-216(*) | 8.495 | 8.175 | .490 |
| 219 | IO3-219(*) | 8.595 | 8.275 | .490 |
| 222 | IO3-222(*) | 8.695 | 8.375 | .490 |
| 225 | IO3-225(*) | 8.795 | 8.475 | .490 |
| 228 | IO3-228(*) | 8.895 | 8.575 | .490 |
| 231 | IO3-231(*) | 8.995 | 8.675 | .490 |
| 234 | IO3-234(*) | 9.095 | 8.775 | .490 |
| 237 | IO3-237(*) | 9.195 | 8.875 | .490 |
| 240 | IO3-240(*) | 9.295 | 8.975 | .490 |
| 243 | IO3-243(*) | 9.395 | 9.075 | .490 |
| 246 | IO3-246(*) | 9.495 | 9.175 | .490 |
| 249 | IO3-249(*) | 9.595 | 9.275 | .490 |
| 252 | IO3-252(*) | 9.695 | 9.375 | .490 |
| 255 | IO3-255(*) | 9.795 | 9.475 | .490 |
| 258 | IO3-258(*) | 9.895 | 9.575 | .490 |
| 261 | IO3-261(*) | 9.995 | 9.675 | .490 |
| 264 | IO3-264(*) | 10.095 | 9.775 | .490 |
| 267 | IO3-267(*) | 10.195 | 9.875 | .490 |
| 270 | IO3-270(*) | 10.295 | 9.975 | .490 |
| 273 | IO3-273(*) | 10.395 | 10.075 | .490 |
| 276 | IO3-276(*) | 10.495 | 10.175 | .490 |
| 279 | IO3-279(*) | 10.595 | 10.275 | .490 |
| 282 | IO3-282(*) | 10.695 | 10.375 | .490 |
| 285 | IO3-285(*) | 10.795 | 10.475 | .490 |
| 288 | IO3-288(*) | 10.895 | 10.575 | .490 |
| 291 | IO3-291(*) | 10.995 | 10.675 | .490 |
| 294 | IO3-294(*) | 11.095 | 10.775 | .490 |
| 297 | IO3-297(*) | 11.195 | 10.875 | .490 |
| 300 | IO3-300(*) | 11.295 | 10.975 | .490 |
| | Order nages 64-6 | | | |

^{*}See How to Order, pages 64-66.

Accessories



Low Mating Force Input/Output Connector

4 ROW CONTACT ARRANGEMENTS

Brush Contact Pkg. Solutions,

| Hybrids - Fiber Optics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

Options/

Ruggedized VME64x / VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302

| Number of | IO | Α | В | С |
|--------------|------------|-------|-------|------|
| Contacts | Number* | Max. | | Max. |
| 040 | IO4-040(*) | 2.295 | 1.975 | .590 |
| 044 | IO4-044(*) | 2.395 | 2.075 | .590 |
| 048 | IO4-048(*) | 2.495 | 2.175 | .590 |
| 052 | IO4-052(*) | 2.595 | 2.275 | .590 |
| 056 | IO4-056(*) | 2.695 | 2.375 | .590 |
| 060 | IO4-060(*) | 2.795 | 2.475 | .590 |
| 064 | IO4-064(*) | 2.895 | 2.575 | .590 |
| 068 | IO4-068(*) | 2.995 | 2.675 | .590 |
| 072 | IO4-072(*) | 3.095 | 2.775 | .590 |
| 076 | IO4-076(*) | 3.195 | 2.875 | .590 |
| 080 | IO4-080(*) | 3.295 | 2.975 | .590 |
| 084 | IO4-084(*) | 3.395 | 3.075 | .590 |
| 088 | IO4-088(*) | 3.495 | 3.175 | .590 |
| 092 | IO4-092(*) | 3.595 | 3.275 | .590 |
| 096 | IO4-096(*) | 3.695 | 3.375 | .590 |
| 100 | IO4-100(*) | 3.795 | 3.475 | .590 |
| 104 | IO4-104(*) | 3.895 | 3.575 | .590 |
| 108 | IO4-108(*) | 3.995 | 3.675 | .590 |
| 112 | IO4-112(*) | 4.095 | 3.775 | .590 |
| 116 | IO4-116(*) | 4.195 | 3.875 | .590 |
| 120 | IO4-120(*) | 4.295 | 3.975 | .590 |
| 124 | IO4-124(*) | 4.395 | 4.075 | .590 |
| 128 | IO4-128(*) | 4.495 | 4.175 | .590 |
| 132 | IO4-132(*) | 4.595 | 4.275 | .590 |
| 136 | IO4-136(*) | 4.695 | 4.375 | .590 |
| 140 | IO4-140(*) | 4.795 | 4.475 | .590 |
| 144 | IO4-144(*) | 4.895 | 4.575 | .590 |
| 148 | IO4-148(*) | 4.995 | 4.675 | .590 |
| 152 | IO4-152(*) | 5.095 | 4.775 | .590 |
| 156 | IO4-156(*) | 5.195 | 4.875 | .590 |
| 160 | IO4-160(*) | 5.295 | 4.975 | .590 |
| 164 | IO4-164(*) | 5.395 | 5.075 | .590 |
| 168 | IO4-168(*) | 5.495 | 5.175 | .590 |
| 172 | IO4-172(*) | 5.595 | 5.275 | .590 |
| 176 | IO4-176(*) | 5.695 | 5.375 | .590 |
| 180 | IO4-180(*) | 5.795 | 5.475 | .590 |
| 184 | IO4-184(*) | 5.895 | 5.575 | .590 |
| 188 | IO4-188(*) | 5.995 | 5.675 | .590 |
| 192 | IO4-192(*) | 6.095 | 5.775 | .590 |
| 196 | IO4-196(*) | 6.195 | 5.875 | .590 |
| 200 | IO4-200(*) | 6.295 | 5.975 | .590 |
| 204 | IO4-204(*) | 6.395 | 6.075 | .590 |
| 208 | IO4-208(*) | 6.495 | 6.175 | .590 |
| 212 | IO4-212(*) | 6.595 | 6.275 | .590 |
| 216 | IO4-216(*) | 6.695 | 6.375 | .590 |
| 220 | IO4-220(*) | 6.795 | 6.475 | .590 |

| | I | I | I | | | |
|---------------|--------------------------------|--------|--------|------|--|--|
| Number of | IO | Α | В | С | | |
| Contacts | Number* | Max. | | Max. | | |
| 224 | IO4-224(*) | 6.895 | 6.575 | .590 | | |
| 228 | IO4-228(*) | 6.995 | 6.675 | .590 | | |
| 232 | IO4-232(*) | 7.095 | 6.775 | .590 | | |
| 236 | IO4-236(*) | 7.195 | 6.875 | .590 | | |
| 240 | IO4-240(*) | 7.295 | 6.975 | .590 | | |
| 244 | IO4-244(*) | 7.395 | 7.075 | .590 | | |
| 248 | IO4-248(*) | 7.495 | 7.175 | .590 | | |
| 252 | IO4-252(*) | 7.595 | 7.275 | .590 | | |
| 256 | IO4-256(*) | 7.695 | 7.375 | .590 | | |
| 260 | IO4-260(*) | 7.795 | 7.475 | .590 | | |
| 264 | IO4-264(*) | 7.895 | 7.575 | .590 | | |
| 268 | IO4-268(*) | 7.995 | 7.675 | .590 | | |
| 272 | IO4-272(*) | 8.095 | 7.775 | .590 | | |
| 276 | IO4-276(*) | 8.195 | 7.875 | .590 | | |
| 280 | IO4-280(*) | 8.295 | 7.975 | .590 | | |
| 284 | IO4-284(*) | 8.395 | 8.075 | .590 | | |
| 288 | IO4-288(*) | 8.495 | 8.175 | .590 | | |
| 292 | IO4-292(*) | 8.595 | 8.275 | .590 | | |
| 296 | IO4-296(*) | 8.695 | 8.375 | .590 | | |
| 300 | IO4-300(*) | 8.795 | 8.475 | .590 | | |
| 304 | IO4-304(*) | 8.895 | 8.575 | .590 | | |
| 308 | IO4-308(*) | 8.995 | 8.675 | .590 | | |
| 312 | IO4-312(*) | 9.095 | 8.775 | .590 | | |
| 316 | IO4-316(*) | 9.195 | 8.875 | .590 | | |
| 320 | IO4-320(*) | 9.295 | 8.975 | .590 | | |
| 324 | IO4-324(*) | 9.395 | 9.075 | .590 | | |
| 328 | IO4-328(*) | 9.496 | 9.175 | .590 | | |
| 332 | IO4-332(*) | 9.595 | 9.275 | .590 | | |
| 336 | IO4-336(*) | 9.695 | 9.375 | .590 | | |
| 340 | IO4-340(*) | 9.795 | 9.475 | .590 | | |
| 344 | IO4-344(*) | 9.895 | 9.575 | .590 | | |
| 348 | IO4-348(*) | 9.995 | 9.675 | .590 | | |
| 352 | IO4-352(*) | 10.095 | 9.775 | .590 | | |
| 356 | IO4-356(*) | 10.195 | 9.875 | .590 | | |
| 360 | IO4-360(*) | 10.295 | 9.975 | .590 | | |
| 364 | IO4-364(*) | 10.395 | 10.075 | .590 | | |
| 368 | IO4.368(*) | 10.495 | 10.175 | .590 | | |
| 372 | IO4-372(*) | 10.595 | 10.275 | .590 | | |
| 376 | IO4-376(*) | 10.695 | 10.375 | .590 | | |
| 380 | IO4-380(*) | 10.795 | 10.475 | .590 | | |
| 384 | IO4-384(*) | 10.895 | 10.575 | .590 | | |
| 388 | IO4-388(*) | 10.995 | 10.675 | .590 | | |
| 392 | IO4-392(*) | 11.095 | 10.775 | .590 | | |
| 396 | IO4-396(*) | 11.195 | 10.875 | .590 | | |
| 400 | IO4-400(*) | 11.295 | 10.975 | .590 | | |
| *See How to 0 | See How to Order, pages 64-66. | | | | | |

^{*}See How to Order, pages 64-66.

Amphenol Aerospace

DIMENSIONAL DRAWING

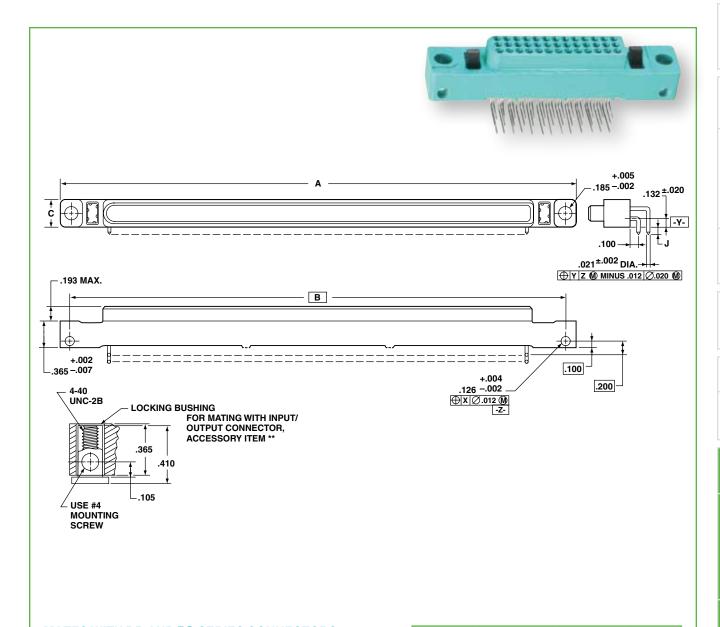
Solutions

LRM (Line Replaceable Modules) Hybrids - Fiber Optics Hi Speed/RF/Power

VITA 60,

Hi Speed

Interconnects Reclangular



MATES WITH DB AND IO SERIES CONNECTORS

Notes:

When mating with DB connector, a total of .035 inch minimum radial pilot is available for connector body alignment.

All dimensions for reference only.

Polarization keys are not supplied as part of PC Connector Series assemblies. See Accessories How to Order, page 66 and further description, page 90.

** Locking busings are not supplied as part of PC Connector Series assembles. See Accessories How to Order, page 66, and further description, page 93.

☐ Designates Basic Dimension

| Contact Data | | | | | |
|--------------|--------------------------------|--------------------|-------------------|--|--|
| Description | Termination Style Letter | Arrangement Row | J +.035 025 | | |
| Round PCB | Р | Α | .095 | | |
| | Р | В | .095 | | |
| | Р | С | .095 | | |
| Stud, 90° | Р | D | .095 | | |
| Solder | Solder P-(714) | | .150 | | |
| Termination | Termination P-(714) | | .150 | | |
| | P-(714) | С | .150 | | |
| | P-(714) | D | .150 | | |

NOTE: Other variations available - see pages 65 & 66, or consult Amphenol Aerospace.



Low Mating Force PC Connector

2 ROW CONTACT ARRANGEMENTS

Pkg. Solutions,

LRM (Line Replaceable Modules)

Ruggedized VME64x / VITA 60, 66

High Density
HSB3 HDB3
Hi Speed

Low Mating Force MIL-DTL-55302

| | | I | | |
|--------------|----------------------|-------|----------------|------|
| Number of | PC | . А | В | ,c |
| Contacts | Number* | Max. | | Max. |
| 020 | PC2-020P | 2.295 | 1.975 | .390 |
| 022 | PC2-022P | 2.395 | 2.075 | .390 |
| 024 | PC2-024P | 2.495 | 2.175 | .390 |
| 026 | PC2-026P | 2.595 | 2.275 | .390 |
| 028 | PC2-028P | 2.695 | 2.375 | .390 |
| 030 | PC2-030P | 2.795 | 2.475 | .390 |
| 032 | PC2-032P | 2.895 | 2.575 | .390 |
| 034 | PC2-034P | 2.995 | 2.675 | .390 |
| 036 | PC2-036P | 3.095 | 2.775 | .390 |
| 038 | PC2-038P | 3.195 | 2.875 | .390 |
| 040 | PC2-040P | 3.295 | 2.975 | .390 |
| 042 | PC2-042P | 3.395 | 3.075 | .390 |
| 044 | PC2-044P | 3.495 | 3.175 | .390 |
| 046 | PC2-046P | 3.595 | 3.275 | .390 |
| 048 | PC2-048P | 3.695 | 3.375 | .390 |
| 050 | PC2-050P | 3.795 | 3.475 | .390 |
| 052 | PC2-052P | 3.895 | 3.575 | .390 |
| 054 | PC2-054P | 3.995 | 3.675 | .390 |
| 056 | PC2-056P | 4.095 | 3.775 | .390 |
| 058 | PC2-058P | 4.195 | 3.875 | .390 |
| 060 | PC2-060P | 4.295 | 3.975 | .390 |
| 062 | PC2-062P | 4.395 | 4.075 | .390 |
| 064 | PC2-064P | 4.495 | 4.175 | .390 |
| 066 | PC2-066P | 4.595 | 4.275 | .390 |
| 068 | PC2-068P | 4.695 | 4.375 | .390 |
| 070 | PC2-070P | 4.795 | 4.475 | .390 |
| 072 | PC2-072P | 4.895 | 4.575 | .390 |
| 074 | PC2-074P | 4.995 | 4.675 | .390 |
| 076 | PC2-076P | 5.095 | 4.775 | .390 |
| 078 | PC2-078P | 5.195 | 4.875 | .390 |
| 080 | PC2-080P | 5.295 | 4.975 | .390 |
| 082 | PC2-082P | 5.395 | 5.075 | .390 |
| 084 | PC2-084P | 5.495 | 5.175 | .390 |
| 086 | PC2-086P | 5.595 | 5.275 | .390 |
| 088 | PC2-088P | 5.695 | 5.375 | .390 |
| 090 | PC2-090P | 5.795 | 5.475 | .390 |
| 090 | PC2-090P | 5.795 | 5.475 | .390 |
| 092 | PC2-092P | | 5.675 | |
| 094 | | 5.995 | | .390 |
| 098 | PC2-096P | 6.095 | 5.775 5.875 | .390 |
| | PC2-098P PC2-100P | 6.195 | | .390 |
| 100 | | 6.295 | 5.975 | .390 |
| 102 | PC2-102P PC2-104P | 6.395 | 6.075 | .390 |
| 104 | | 6.495 | 6.175 | .390 |
| 106 | PC2-106P | 6.595 | 6.275 | .390 |
| 108 | PC2-108P | 6.695 | 6.375 | .390 |
| 110 | PC2-110P | 6.795 | 6.475 | .390 |

| Number | | | | |
|----------|-------------------|--------|--------|------|
| of | PC | , A | В | , C |
| Contacts | Number* | Max. | | Max. |
| 112 | PC2-112P | 6.895 | 6.575 | .390 |
| 114 | PC2-114P | 6.995 | 6.675 | .390 |
| 116 | PC2-116P | 7.095 | 6.775 | .390 |
| 118 | PC2-118P | 7.195 | 6.875 | .390 |
| 120 | PC2-120P | 7.295 | 6.975 | .390 |
| 122 | PC2-122P | 7.395 | 7.075 | .390 |
| 124 | PC2-124P | 7.495 | 7.175 | .390 |
| 126 | PC2-126P | 7.595 | 7.275 | .390 |
| 128 | PC2-128P | 7.695 | 7.375 | .390 |
| 130 | PC2-130P | 7.795 | 7.475 | .390 |
| 132 | PC2-132P | 7.895 | 7.575 | .390 |
| 134 | PC2-134P | 7.995 | 7.675 | .390 |
| 136 | PC2-136P | 8.095 | 7.775 | .390 |
| 138 | PC2-138P | 8.195 | 7.875 | .390 |
| 140 | PC2-140P | 8.295 | 7.975 | .390 |
| 142 | PC2-142P | 8.395 | 8.075 | .390 |
| 144 | PC2-144P | 8.495 | 8.175 | .390 |
| 146 | PC2-146P | 8.595 | 8.275 | .390 |
| 148 | PC2-148P | 8.695 | 8.375 | .390 |
| 150 | PC2-150P | 8.795 | 8.475 | .390 |
| 152 | PC2-152P | 8.895 | 8.575 | .390 |
| 154 | PC2-154P | 8.995 | 8.675 | .390 |
| 156 | PC2-156P | 9.095 | 8.775 | .390 |
| 158 | PC2-158P | 9.195 | 8.875 | .390 |
| 160 | PC2-160P | 9.295 | 8.975 | .390 |
| 162 | PC2-162P | 9.395 | 9.075 | .390 |
| 164 | PC2-164P | 9.495 | 9.175 | .390 |
| 166 | PC2-166P | 9.595 | 9.275 | .390 |
| 168 | PC2-168P | 9.695 | 9.375 | .390 |
| 170 | PC2-170P | 9.795 | 9.475 | .390 |
| 172 | PC2-172P | 9.895 | 9.575 | .390 |
| 174 | PC2-174P | 9.995 | 9.675 | .390 |
| 176 | PC2-176P | 10.095 | 9.775 | .390 |
| 178 | PC2-178P | 10.195 | 9.875 | .390 |
| 180 | PC2-180P | 10.295 | 9.975 | .390 |
| 182 | PC2-182P | 10.395 | 10.075 | .390 |
| 184 | PC2-184P | 10.495 | 10.175 | .390 |
| 186 | PC2-186P | 10.595 | 10.275 | .390 |
| 188 | PC2-188P | 10.695 | 10.375 | .390 |
| 190 | PC2-190P | 10.795 | 10.475 | .390 |
| 192 | PC2-192P | 10.895 | 10.575 | .390 |
| 194 | PC2-194P | 10.995 | 10.675 | .390 |
| 196 | PC2-196P | 11.095 | 10.775 | .390 |
| 198 | PC2-198P | 11.195 | 10.875 | .390 |
| 200 | PC2-200P | 11.295 | 10.975 | .390 |
| | Order, pages 64-6 | | | |

Amphenol Aerospace

3 ROW CONTACT ARRANGEMENTS

| Number of Contacts | PC Number* | A Max. | В | C Max. |
|--------------------------|---------------|-----------|-------|-----------|
| 030 | PC3-030P | 2.295 | 1.975 | .490 |
| 033 | PC3-033P | 2.395 | 2.075 | .490 |
| 036 | PC3-036P | 2.495 | 2.175 | .490 |
| 039 | PC3-039P | 2.595 | 2.275 | .490 |
| 042 | PC3-042P | 2.695 | 2.375 | .490 |
| 045 | PC3-045P | 2.795 | 2.475 | .490 |
| 048 | PC3-048P | 2.895 | 2.575 | .490 |
| 051 | PC3-051P | 2.995 | 2.675 | .490 |
| 054 | PC3-054P | 3.095 | 2.775 | .490 |
| 057 | PC3-057P | 3.195 | 2.875 | .490 |
| 060 | PC3-060P | 3.295 | 2.975 | .490 |
| 063 | PC3-063P | 3.395 | 3.075 | .490 |
| 066 | PC3-066P | 3.495 | 3.175 | .490 |
| 069 | PC3-069P | 3.595 | 3.275 | .490 |
| 072 | PC3-072P | 3.695 | 3.375 | .490 |
| 075 | PC3-075P | 3.795 | 3.475 | .490 |
| 078 | PC3-078P | 3.895 | 3.575 | .490 |
| 081 | PC3-081P | 3.995 | 3.675 | .490 |
| 084 | PC3-084P | 4.095 | 3.775 | .490 |
| 087 | PC3-087P | 4.195 | 3.875 | .490 |
| 090 | PC3-090P | 4.295 | 3.975 | .490 |
| 093 | PC3-093P | 4.395 | 4.075 | .490 |
| 096 | PC3-096P | 4.495 | 4.175 | .490 |
| 099 | PC3-099P | 4.595 | 4.275 | .490 |
| 102 | PC3-102P | 4.695 | 4.375 | .490 |
| 105 | PC3-105P | 4.795 | 4.475 | .490 |
| 108 | PC3-108P | 4.895 | 4.575 | .490 |
| 111 | PC3-111P | 4.995 | 4.675 | .490 |
| 114 | PC3-114P | 5.095 | 4.775 | .490 |
| 117 | PC3-117P | 5.195 | 4.875 | .490 |
| 120 | PC3-120P | 5.295 | 4.975 | .490 |
| 123 | PC3-123P | 5.395 | 5.075 | .490 |
| 126 | PC3-126P | 5.495 | 5.175 | .490 |
| 129 | PC3-129P | 5.595 | 5.275 | .490 |
| 132 | PC3-132P | 5.695 | 5.375 | .490 |
| 135 | PC3-135P | 5.795 | 5.475 | .490 |
| 138 | PC3-138P | 5.895 | 5.575 | .490 |
| 141 | PC3-141P | 5.995 | 5.675 | .490 |
| 144 | PC3-144P | 6.095 | 5.775 | .490 |
| 147 | PC3-147P | 6.195 | 5.875 | .490 |
| 150 | PC3-150P | 6.295 | 5.975 | .490 |
| 153 | PC3-153P | 6.395 | 6.075 | .490 |
| 156 | PC3-156P | 6.495 | 6.175 | .490 |
| 159 | PC3-159P | 6.595 | 6.275 | .490 |
| 162 | PC3-162P | 6.695 | 6.375 | .490 |
| 165 | PC3-165P | 6.795 | 6.475 | .490 |

| Number | PC | | В | С |
|----------------|-------------------|---------------------------------------|--------|------|
| of Contacts | Number* | A Max. | P | Max. |
| 168 | PC3-168P | 6.895 | 6.575 | .490 |
| 171 | PC3-171P | 6.995 | 6.675 | .490 |
| 174 | PC3-174P | 7.095 | 6.775 | .490 |
| 177 | PC3-177P | 7.195 | 6.875 | .490 |
| 180 | PC3-180P | 7.295 | 6.975 | .490 |
| 183 | PC3-183P | 7.395 | 7.075 | .490 |
| 186 | PC3-186P | 7.495 | 7.175 | .490 |
| 189 | PC3-189P | 7.595 | 7.275 | .490 |
| 192 | PC3-192P | 7.695 | 7.375 | .490 |
| 195 | PC3-195P | 7.795 | 7.475 | .490 |
| 198 | PC3-198P | 7.895 | 7.575 | .490 |
| 201 | PC3-201P | 7.995 | 7.675 | .490 |
| 204 | PC3-204P | 8.095 | 7.775 | .490 |
| 207 | PC3-207P | 8.195 | 7.875 | .490 |
| 210 | PC3-210P | 8.295 | 7.975 | .490 |
| 213 | PC3-213P | 8.395 | 8.075 | .490 |
| 216 | PC3-216P | 8.495 | 8.175 | .490 |
| 219 | PC3-219P | 8.595 | 8.275 | .490 |
| 222 | PC3-222P | 8.695 | 8.375 | .490 |
| 225 | PC3-225P | 8.795 | 8.475 | .490 |
| 228 | PC3-228P | 8.895 | 8.575 | .490 |
| 231 | PC3-231P | 8.995 | 8.675 | .490 |
| 234 | PC3-234P | 9.095 | 8.775 | .490 |
| 237 | PC3-237P | 9.195 | 8.875 | .490 |
| 240 | PC3-240P | 9.295 | 8.975 | .490 |
| 243 | PC3-243P | 9.395 | 9.075 | .490 |
| 246 | PC3-246P | 9.495 | 9.175 | .490 |
| 249 | PC3-249P | 9.595 | 9.275 | .490 |
| 252 | PC3-252P | 9.695 | 9.375 | .490 |
| 255 | PC3-255P | 9.795 | 9.475 | .490 |
| 258 | PC3-258P | 9.895 | 9.575 | .490 |
| 261 | PC3-261P | 9.995 | 9.675 | .490 |
| 264 | PC3-264P | 10.095 | 9.775 | .490 |
| 267 | PC3-267P | 10.195 | 9.875 | .490 |
| 270 | PC3-270P | 10.295 | 9.975 | .490 |
| 273 | PC3-273P | 10.395 | 10.075 | .490 |
| 276 | PC3-276P | 10.495 | 10.175 | .490 |
| 279 | PC3-279P | 10.595 | 10.275 | .490 |
| 282 | PC3-282P | 10.695 | 10.375 | .490 |
| 285 | PC3-285P | 10.795 | 10.475 | .490 |
| 288 | PC3-288P | 10.895 | 10.575 | .490 |
| 291 | PC3-291P | 10.995 | 10.675 | .490 |
| 294 | PC3-294P | 11.095 | 10.775 | .490 |
| 279 | PC3-297P | 11.195 | 10.875 | .490 |
| 300 | PC3-300P | 11.295 | 10.975 | .490 |
| | Order, pages 64-6 | · · · · · · · · · · · · · · · · · · · | | |

^{*}See How to Order, pages 64-66.



Low Mating Force PC Connector

4 ROW CONTACT ARRANGEMENTS

Brush Contact Pkg. Solutions,

| Hybrids - Fiber Optics | Staggered | Hi Speed/RF/Power | GEN-X LRM (Line Replaceable Modules)

Ruggedized VME64x / VITA 60, 66

High Density
HSB3 HDB3

Low Mating Force MIL-DTL-55302

| Number of | PC | Α | В | С |
|--------------|----------|-------|-------|------|
| Contacts | Number* | Max. | | Max. |
| 040 | PC4-040P | 2.295 | 1.975 | .590 |
| 044 | PC4-044P | 2.395 | 2.075 | .590 |
| 048 | PC4-048P | 2.495 | 2.175 | .590 |
| 052 | PC4-052P | 2.595 | 2.275 | .590 |
| 056 | PC4-056P | 2.695 | 2.375 | .590 |
| 060 | PC4-060P | 2.795 | 2.475 | .590 |
| 064 | PC4-064P | 2.895 | 2.575 | .590 |
| 068 | PC4-068P | 2.995 | 2.675 | .590 |
| 072 | PC4-072P | 3.095 | 2.775 | .590 |
| 076 | PC4-076P | 3.195 | 2.875 | .590 |
| 080 | PC4-080P | 3.295 | 2.975 | .590 |
| 084 | PC4-084P | 3.395 | 3.075 | .590 |
| 088 | PC4-088P | 3.495 | 3.175 | .590 |
| 092 | PC4-092P | 3.595 | 3.275 | .590 |
| 096 | PC4-096P | 3.695 | 3.375 | .590 |
| 100 | PC4-100P | 3.795 | 3.475 | .590 |
| 104 | PC4-104P | 3.895 | 3.575 | .590 |
| 108 | PC4-108P | 3.995 | 3.675 | .590 |
| 112 | PC4-112P | 4.095 | 3.775 | .590 |
| 116 | PC4-116P | 4.195 | 3.875 | .590 |
| 120 | PC4-120P | 4.295 | 3.975 | .590 |
| 124 | PC4-124P | 4.395 | 4.075 | .590 |
| 128 | PC4-128P | 4.495 | 4.175 | .590 |
| 132 | PC4-132P | 4.595 | 4.275 | .590 |
| 136 | PC4-136P | 4.695 | 4.375 | .590 |
| 140 | PC4-140P | 4.795 | 4.475 | .590 |
| 144 | PC4-144P | 4.895 | 4.575 | .590 |
| 148 | PC4-148P | 4.995 | 4.675 | .590 |
| 152 | PC4-152P | 5.095 | 4.775 | .590 |
| 156 | PC4-156P | 5.195 | 4.875 | .590 |
| 160 | PC4-160P | 5.295 | 4.975 | .590 |
| 164 | PC4-164P | 5.395 | 5.075 | .590 |
| 168 | PC4-168P | 5.495 | 5.175 | .590 |
| 172 | PC4-172P | 5.595 | 5.275 | .590 |
| 176 | PC4-176P | 5.695 | 5.375 | .590 |
| 180 | PC4-180P | 5.795 | 5.475 | .590 |
| 184 | PC4-184P | 5.895 | 5.575 | .590 |
| 188 | PC4-188P | 5.995 | 5.675 | .590 |
| 192 | PC4-192P | 6.095 | 5.775 | .590 |
| 196 | PC4-196P | 6.195 | 5.875 | .590 |
| 200 | PC4-200P | 6.295 | 5.975 | .590 |
| 204 | PC4-204P | 6.395 | 6.075 | .590 |
| 208 | PC4-208P | 6.495 | 6.175 | .590 |
| 212 | PC4-212P | 6.595 | 6.275 | .590 |
| 216 | PC4-216P | 6.695 | 6.375 | .590 |
| 220 | PC4-220P | 6.795 | 6.475 | .590 |

| Number of | PC | Α | В | С |
|---------------|-------------------|--------|--------|------|
| Contacts | Number* | Max. | | Max. |
| 224 | PC4-224P | 6.895 | 6.575 | .590 |
| 228 | PC4-228P | 6.995 | 6.675 | .590 |
| 232 | PC4-232P | 7.095 | 6.775 | .590 |
| 236 | PC4-236P | 7.195 | 6.875 | .590 |
| 240 | PC4-240P | 7.295 | 6.975 | .590 |
| 244 | PC4-244P | 7.395 | 7.075 | .590 |
| 248 | PC4-248P | 7.495 | 7.175 | .590 |
| 252 | PC4-252P | 7.595 | 7.275 | .590 |
| 256 | PC4-256P | 7.695 | 7.375 | .590 |
| 260 | PC4-260P | 7.795 | 7.475 | .590 |
| 264 | PC4-264P | 7.895 | 7.575 | .590 |
| 268 | PC4-268P | 7.995 | 7.675 | .590 |
| 272 | PC4-272P | 8.095 | 7.775 | .590 |
| 276 | PC4-276P | 8.195 | 7.875 | .590 |
| 280 | PC4-280P | 8.295 | 7.975 | .590 |
| 284 | PC4-284P | 8.395 | 8.075 | .590 |
| 288 | PC4-288P | 8.495 | 8.175 | .590 |
| 292 | PC4-292P | 8.595 | 8.275 | .590 |
| 296 | PC4-296P | 8.695 | 8.375 | .590 |
| 300 | PC4-300P | 8.795 | 8.475 | .590 |
| 304 | PC4-304P | 8.895 | 8.575 | .590 |
| 308 | PC4-308P | 8.995 | 8.675 | .590 |
| 312 | PC4-312P | 9.095 | 8.775 | .590 |
| 316 | PC4-316P | 9.195 | 8.875 | .590 |
| 320 | PC4-320P | 9.295 | 8.975 | .590 |
| 324 | PC4-324P | 9.395 | 9.075 | .590 |
| 328 | PC4-328P | 9.495 | 9.175 | .590 |
| 332 | PC4-332P | 9.595 | 9.275 | .590 |
| 336 | PC4-336P | 9.695 | 9.375 | .590 |
| 340 | PC4-340P | 9.795 | 9.475 | .590 |
| 344 | PC4-344P | 9.895 | 9.575 | .590 |
| 348 | PC4-348P | 9.995 | 9.675 | .590 |
| 352 | PC4-352P | 10.095 | 9.775 | .590 |
| 356 | PC4-356P | 10.195 | 9.875 | .590 |
| 360 | PC4-360P | 10.295 | 9.975 | .590 |
| 364 | PC4-364P | 10.395 | 10.075 | .590 |
| 368 | PC4-368P | 10.495 | 10.175 | .590 |
| 372 | PC4-372P | 10.595 | 10.275 | .590 |
| 376 | PC4-376P | 10.695 | 10.375 | .590 |
| 380 | PC4-380P | 10.795 | 10.475 | .590 |
| 384 | PC4-384P | 10.895 | 10.575 | .590 |
| 388 | PC4-388P | 10.995 | 10.675 | .590 |
| 392 | PC4-392P | 11.095 | 10.775 | .590 |
| 396 | PC4-396P | 11.195 | 10.875 | .590 |
| 400 | PC4-400P | 11.295 | 10.975 | .590 |
| *See How to C | Order, pages 64-6 | | | |

To meet more customer needs and provide more design flexibility, Amphenol expanded their low mating force connector family with smaller contact count connectors (sizes with less than standard 10 contacts per row). These are available with as few as 10 brush contacts per connector and up to 36 brush contacts per connector. The arrangements are in the same .100 X .100 square inch grid pattern as standard low mating force connectors. They are offered in mother board, daughter board, input/output and printed circuit styles. (Shown on this page and the following page). For how to order information please consult Amphenol Aerospace.



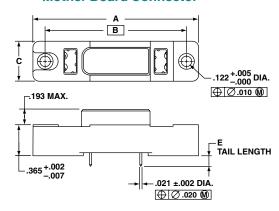
LOW MATING FORCE CONNECTORS IN SMALLER SIZES

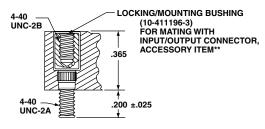
Mother Board Connector

| Number of Contacts | Contact Pattern | A Max. | В | C Max. |
|--------------------------|--------------------|-----------|-------|-----------|
| 10 | 2 Row X 5 | 1.795 | 1.475 | .390 |
| 12 | 2 Row X 6 | 1.895 | 1.575 | .390 |
| 14 | 2 Row X 7 | 1.995 | 1.675 | .390 |
| 15 | 3 Row X 5 | 1.795 | 1.475 | .490 |
| 16 | 2 Row X 8 | 2.095 | 1.775 | .390 |
| 10 | 2 Row X 9 | 2.195 | 1.875 | .390 |
| 18 | 3 Row X 6 | 1.895 | 1.575 | .490 |
| 20 | 4 Row X 5 | 1.795 | 1.475 | .590 |
| 21 | 3 Row X 7 | 1.995 | 1.675 | .490 |
| 0.4 | 3 Row X 8 | 2.095 | 1.775 | .490 |
| 24 | 4 Row X 6 | 1.895 | 1.575 | .590 |
| 27 | 3 Row X 9 | 2.195 | 1.875 | .490 |
| 28 | 4 Row X 7 | 1.995 | 1.675 | .590 |
| 32 | 4 Row X 8 | 2.095 | 1.775 | .590 |
| 36 | 4 Row X 9 | 2.195 | 1.875 | .590 |

^{**} Accessory item supplied separately. See Accessory How to Order page 66 and page 93 for alternate mounting methods.

Mother Board Connector





Daughter Board Connector

| Number of Contacts | Contact Pattern | A Max. | В | C Max. | D Max. |
|--------------------------|--------------------|-----------|-------|-----------|-----------|
| 10 | 2 Row X 5 | 1.180 | .850 | .375 | .545 |
| 12 | 2 Row X 6 | 1.280 | .950 | .375 | .545 |
| 14 | 2 Row X 7 | 1.380 | 1.050 | .375 | .545 |
| 15 | 3 Row X 5 | 1.180 | .850 | .475 | .645 |
| 16 | 2 Row X 8 | 1.480 | 1.150 | .375 | .545 |
| 40 | 2 Row X 9 | 1.580 | 1.250 | .375 | .545 |
| 18 | 3 Row X 6 | 1.280 | .950 | .475 | .645 |
| 20 | 4 Row X 5 | 1.180 | .850 | .575 | .745 |
| 21 | 3 Row X 7 | 1.380 | 1.050 | .475 | .645 |
| 24 | 3 Row X 8 | 1.480 | 1.150 | .475 | .645 |
| 24 | 4 Row X 6 | 1.280 | .950 | .575 | .745 |
| 27 | 3 Row X 9 | 1.580 | 1.250 | .475 | .645 |
| 28 | 4 Row X 7 | 1.380 | 1.050 | .575 | .745 |
| 32 | 4 Row X 8 | 1.480 | 1.150 | .575 | .745 |
| 36 | 4 Row X 9 | 1.580 | 1.250 | .575 | .745 |



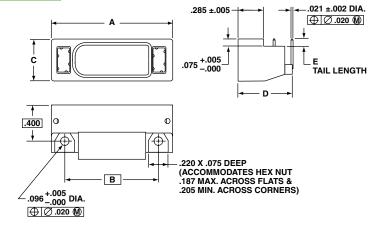
Ε Tail Length

> ±.020 .148

> > .180

.335

Daughter Board Connector



Solutions

GEN-X

LRM (Line Replaceable Modules) Hybrids - Fiber Optics Hi Speed/RF/Power

VITA 60, VME 64x/

High Density Hi Speed

Low Mating Force MIL-DTL-55302

Rack & Panel

Ruggedized

ectangulai

Interconnects Rectangular



28

32

36

Low Mating Force Connector Smaller Sizes with .100 X .100 Sq. Inch Grid, cont.

DESIGN FLEXIBILITY

Solutions **Brush Contact**

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/

VME64x/ 60,

High Density HSB3

Low Mating Force MIL-DTL-55302

Rack & Pane Ruggedized Brush

| | Input/Out | tput Con | nector | |
|--------------------------|--------------------|-----------|--------|-----------|
| Number of Contacts | Contact Pattern | A Max. | В | C Max. |
| 10 | 2 Row X 5 | 1.795 | 1.475 | .390 |
| 12 | 2 Row X 6 | 1.895 | 1.575 | .390 |
| 14 | 2 Row X 7 | 1.995 | 1.675 | .390 |
| 15 | 3 Row X 5 | 1.795 | 1.475 | .490 |
| 16 | 2 Row X 8 | 2.095 | 1.775 | .390 |
| 40 | 2 Row X 9 | 2.195 | 1.875 | .390 |
| 18 | 3 Row X 6 | 1.895 | 1.575 | .490 |
| 20 | 4 Row X 5 | 1.795 | 1.475 | .590 |
| 21 | 3 Row X 7 | 1.995 | 1.675 | .490 |
| 0.4 | 3 Row X 8 | 2.095 | 1.775 | .490 |
| 24 | 4 Row X 6 | 1.895 | 1.575 | .590 |
| 27 | 3 Row X 9 | 2.195 | 1.875 | .490 |
| 28 | 4 Row X 7 | 1.995 | 1.675 | .590 |

.590

.590

.785 MAX.

UNMATED

FREE

LENGTH

.650 MAX. WHEN FULLY

ASSEMBLED TO MATING CONNECTOR

| Contact Type | K Dia. ±.020 | E Tail Length ±.020 |
|---------------------------------|--------------------|---------------------------|
| Rear Removable Crimp Contact | N/A | N/A |
| Round PCB Stud | .021 | .145 |
| Solder Termination | .021 | .335 |

4 Row X 8

4 Row X 9

Input/Output Connector В .670 K DIA TAIL LENGTH UNC-2A .445 MAX. UNMATED FREE LENGTH LOCKING SCREW 10-502599-2 ACCESSORY ITEM** LOCKING SCREW 10-502599 .31 MAX. **ACCESSORY ITEM**** WHEN FULLY ASSEMBLED TO MATING CONNECTOR .220 DIA.

Printed Circuit Connector

2.095

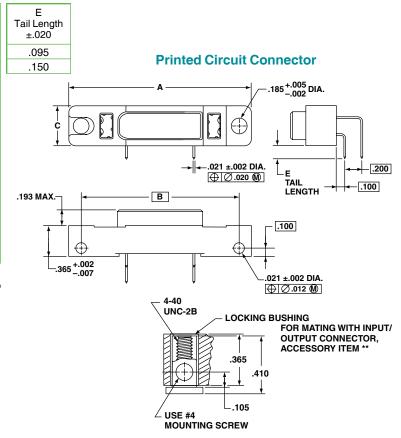
2.195

1.775

1.875

| Number of Contacts | Contact Pattern | A Max. | В | C Max. | D Max. |
|--------------------------|--------------------|-----------|-------|-----------|-----------|
| 10 | 2 Row X 5 | 1.180 | .850 | .375 | .545 |
| 12 | 2 Row X 6 | 1.280 | .950 | .375 | .545 |
| 14 | 2 Row X 7 | 1.380 | 1.050 | .375 | .545 |
| 15 | 3 Row X 5 | 1.180 | .850 | .475 | .645 |
| 16 | 2 Row X 8 | 1.480 | 1.150 | .375 | .545 |
| 40 | 2 Row X 9 | 1.580 | 1.250 | .375 | .545 |
| 18 | 3 Row X 6 | 1.280 | .950 | .475 | .645 |
| 20 | 4 Row X 5 | 1.180 | .850 | .575 | .745 |
| 21 | 3 Row X 7 | 1.380 | 1.050 | .475 | .645 |
| 24 | 3 Row X 8 | 1.480 | 1.150 | .475 | .645 |
| 24 | 4 Row X 6 | 1.280 | .950 | .575 | .745 |
| 27 | 3 Row X 9 | 1.580 | 1.250 | .475 | .645 |
| 28 | 4 Row X 7 | 1.380 | 1.050 | .575 | .745 |
| 32 | 4 Row X 8 | 1.480 | 1.150 | .575 | .745 |
| 36 | 4 Row X 9 | 1.580 | 1.250 | .575 | .745 |

^{**} Accessory item supplied separately. See Accessory How to Order page 66 and page 93 for alternate mounting methods.



kg. Solutions Brush Contact

Staggered GEN-X

Ruggedizec VME 64x/ VITA 60, 66

High Den

Density HSB3 Hi Speed

ndard | Hybrids - Signal/Power

55302 Rad

LMD/LMS
Rectanguic

Other Rectangular Interconnects

SIGNAL, POWER, COAX OR FIBER OPTICS

The B³ Brush contact is the standard contact for Low mating force connectors due to its low mating force, stable electrical performance and extended service life. Design flexibility is expanded with the ability to add combinations of other types of contacts: signal, power, high speed coax or fiber optic termini; in one high density hybrid connector.

Power, shielded coax or twinax contacts, in combination with Brush signal contacts are available in configurations of the following (see next page for illustrations):

- A single row of size 16 power or coax or twinax contacts with 2 rows of brush contacts
- A single row of size 12 power or coax or twinax contacts with 3 rows of brush contacts
- A double row of size 16 power or coax or twinax contacts with 4 rows of brush contacts
 Power and coax contacts are standard MIL-DTL-38999 Series II type. (Size 12 & 16 power contacts per M39029/57 & M39029/58. Size 12 & 16 coax per M39029/27, M39029/28, M39029/76 amd M39029/77).

Consult Amphenol board level product marketing (800-678-0141) for assistance with available hybrid configurations.

NOTE: Power and coax contacts and fiber optic termini are not provided with the connector and must be purchased separately.



Amphenol's Power Strip connectors were developed for use as a dedicated power interface between module cards and backplanes. These connectors use the same insert bodies as Amphenol low mating force connectors, but have power contacts rather than brush contacts. Cavities allow for size 16 or 12 power contacts. Or, coax/twinax contacts can also be used in these size 16 or 12 cavities.

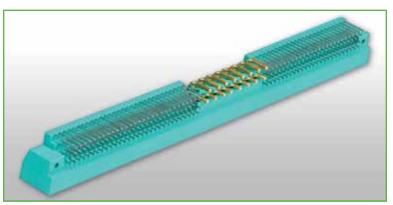
HYBRID BRUSH CONNECTORS WITH FIBER OPTIC TERMINI

Amphenol's superiority and breadth of product offering is demonstrated in its capability for packaging fiber termini and the Brush contact in a printed circuit board rectangular connector. Fiber optic MIL-PRF-29504 termini size 16 and HD20 can be used as well as the 90° termini style with optical performance the same as when used in cylindrical connectors.

For more information on Amphenol fiber optic connectors and termini, see the Fiber Optic section of Amphenol's Combined Circular Interconnects catalog on-line at www.amphenolaerospace.com



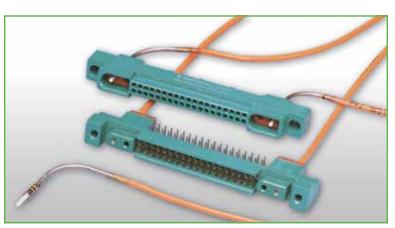
COMBINATION OF BRUSH CONTACTS & SHIELDED CONTACTS



CONNECTOR WITH BRUSH CONTACTS & SIZE 16 POWER PIN CONTACTS



POWER STRIP RECTANGULARS WITH SIZE 16 POWER CONTACTS



COMBINATION OF BRUSH CONTACTS & MS29504 FIBER OPTIC TERMINI



Custom Hybrid Designs, Small Color-Coded Brush Connectors

MORE DESIGN FLEXIBILITY

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/

99 VME64x/ 60,

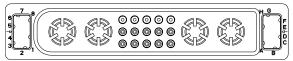
High Density HSB3

Low Mating Force MIL-DTL-55302 Docking Conn./ Hybrids - Signal/Power/ ccessories/Install. Coαx/Fiber Optics

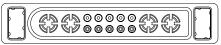
Rack & Panel Ruggedized Brush

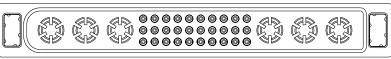
The following shows examples of hybrid configuration connectors that have been developed. Consult Amphenol Aerospace for assistance in solving design problems and for part numbers that will provide the proper combination of these hybrid configurations to meet your specific connector application requirements.

Hybrid: 30 B³ brush contacts, 6 size 12 power/coax/twinax contacts Hybrid: 15 B3 Brush contacts, 4 size 12 power/coax/twinax contacts

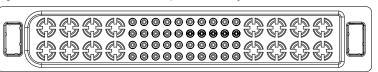


Hybrid: 10 B3 brush contacts, 4 size 16 power/coax/twinax contacts

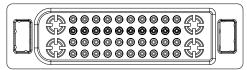




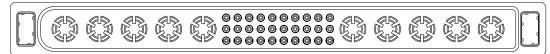
Hybrid: 40 B3 brush contacts, 16 size 16 power/coax/twinax contacts



Hybrid: 40 B³ Brush contacts, 4 size 16 power/coax/twinax contacts

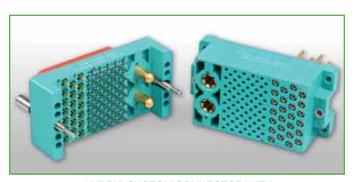


Hybrid: 30 B³ brush contacts, 10 size 12 power/coax/twinax contacts



Amphenol can meet innovative connector solutions with custom designs. Our board level engineers can work with customers who need special contact arrangements or special sized inserts.

The special hybrid connector shown at right was developed for the Vetronics System on a military tank. This custom shape insert design houses a combination of contact types, a sealing grommet, and has special mounting/locking screws.



HYBRID CUSTOM CONNECTOR WITH 75 BRUSH DIGITAL CONTACTS, 26 SIZE 16 POWER CONTACTS & 2 SIZE 04 POWER CONTACTS

SMALL COLOR-CODED BRUSH CONTACT **CONNECTORS DESIGNED FOR MEDICAL** INSTRUMENTATION

Amphenol has responded to the needs of the medical industry by offering even smaller inserts with brush contacts. These small profile, highly reliable interconnects, are ideal for medical and test equipment such as patient monitoring systems. As color coding is a marketdriven requirement, a variety of colors are available.



SMALL COLOR-CODED BRUSH CONNECTORS WITH AS FEW AS 5 CONTACTS PER CONNECTOR

Amphenol Aerospace

.070 INCH X .100 INCH STAGGERED GRID SPACING

BRUSH CONTACT CONNECTORS MAKE THE IDEAL CHOICE FOR FREQUENT DOCKING APPLICATIONS

When frequent docking to charge and transfer data is a necessity, the brush contact system offers high performance of over 100,000 mating cycles. This long contact life without degradation in performance provides customers with reliability in frequent docking applications such as:

Handheld GPS units

Scanners

- Handheld radios
- Accessories
- Rugged computers
- · Cellular phones
- Controllers

Performance

Durability: Up to 100,000 mating cycles Insertion/Extraction Force: 1.5 ounce typical per contact

Operating Temperature: . -65° to 125°C

Current Rating: Up to 5 amperes (termination depen-

dent)

Hot swap 1 ampere maximum (load

dependent)

Data Rate

(Select connectors only): . Configurable for 3.125 Gbps differential

signal

Insulation Resistance: . . 5 gigaohms minimum

Dielectric Withstanding

Voltage: 750 volts @ sea level minimum

250 volts @ 70,000 feet elevation min.

Solderability: MIL-STD-202, method 208

Salt Fog: 48 hours IAW MIL-STD-1344, method

1002, type II

Humidity: IAW MIL-STD-1344, method 1002,

type II

Vibration: 4 hours in each of 3 mutually perpen-

axes IAW MIL-STD-1344, method

2004, test condition G

. . . . 1 shock along each of three mutually

perpendicular axes IAW MIL-STD-1344, method 2004, test

condition G

Features

Radial Misalignment: . . . Capable of correcting up to a .040"

initial radial misalignment

Angular Misalignment: . . Capable of mating with up to a 4° initial

angular misalignment

Polarization: "D" shaped interface Color: Standard is black, variety of other

colors are available

Materials

Insulator: Glass-filled thermoplastic molding Wire Beryllium copper per ASTM B197;

finish is gold per ASTM B488 over

nickel per AMS-QQ-N-290

Holder Brass similar to UNS C33500; finish is

gold per MIL-G-45204 or tin-lead per MIL-P-81728 or tin per MIL-T-10727

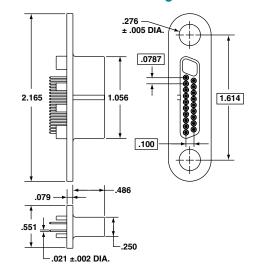
(RoHS compliant

Sleeve: . . . Stainless steel per AMS-5514,

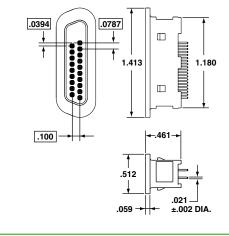
passivated IAW QQ-P-35 (DB and I/O connectors only)

Amphenol offers Docking Connectors in a compact size, with tighter spaced custom brush contacts (.0787 inch x .100 inch staggered grid spacing).

Mother Board Docking Connector



Daughter Board Docking Connector



For more information, including how to order, consult Amphenol Aerospace. Call 800-678-0141 and ask for Amphenol board level product marketing for assistance. Solutions

LRM (Line Replaceable Modules Hybrids - Fiber Optics

Accessories

VITA 60, VME 64x

Hi Speed

Low Mating Force MIL-DTL-55302

Rack & Panel

kectangulai

Interconnects Rectangular



Low Mating Force Connector Accessories

POLARIZATION KEYS

Brush Contact Solutions

GEN-X

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/

99 VME64x / 60,

High Density HSB3

ow Mating Force MIL-DTL-55302 Coax

General information follows on this page and the next three pages for assembling connector accessories with Amphenol® Low Mating Force B3 Brush Contact Connectors.* Provided are suggestions for proper connector installation that will help to maintain connector straightness after equipment assembly.

Low mating force connector bodies are intentionally designed to be non-rigid to facilitate application variables such as compliance to printed circuit boards, fixtures and card cages, vibration and shock exposure, thermal excursions and differential expansion characteristics. Users may employ installation procedures that will provide mating surface straightness of these non-rigid bodies within 0.010 inch to ensure maximum connector performance.

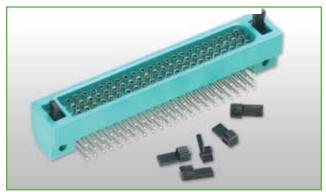
Generally, no external board support structures are required with B3 brush contact connectors as long as the mounting surface offers sufficient rigidity. However, longer installations should consider external support to prevent excessive flexing of the connector/printed circuit board assembly.

POLARIZATION KEYS

Polarization Keys, 10-285422-2 are accessory items, ordered separately for MB, DB, IO and PC Series Low Mating Force Connectors. If used, 4 keys are required per connector half. See page X for ordering information. Examples at right show key locations for mating connector halves. The number or letter designations on all mating connectors are arranged so that the projecting keys on one relate to the same numbers or letters on the other. With the numbers or letters matching, the connector will mate.

TYPICAL CODE SEQUENCE

B. H-1.5 4 Different possibilities at each position = 256



DAUGHTER BOARD CONNECTOR WITH POLARIZATION KEYS

* Installation Instructions for B3 Low Mating Force Connectors had formerly been covered in publication L-1220. This has been discontinued and all installation instructions are covered here on pages 90-95.

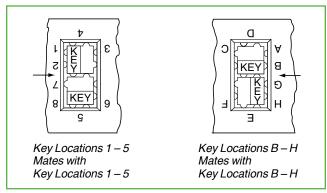
CONNECTOR ACCESSORIES THAT ARE USED WITH B3 BRUSH CONNECTORS INCLUDE:

- Locking screws for I/O connector mounting to board
- Locking/mounting bushings:
 - for PC connector mounting to board or mating to I/O connector
 - for MB connector mounting to board or mating to I/O connector
- Polarization keys for each style connector provide up to 256 different key locations for alternate keying
- Test Probe kits for ensuring that contacts are properly wired within a connector and to prevent damage to brush contacts during probing.

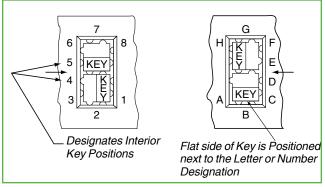
For How to Order Accessories see page 66.

B³ brush PC style connectors are shipped with PC tail combs that not only protect the tails during shipment, but aid the person assembling the connectors to boards to align the contacts.

Refer to page 63 of this catalog for illustration of the connector styles and how they mate.



KEY LOCATIONS MOTHER BOARD OR PC CONNECTORS



KEY LOCATIONS DAUGHTER BOARD OR INPUT/OUTPUT CONNECTORS

Amphenol Aerospace

TEST PROBE KIT

In order to insure that contacts are properly wired within a connector, a Test Probe Kit is needed (Part number to order is 11-10400-22). This kit is especially designed to prevent damage to brush contacts during probing. It consists of a plastic holder, insert, and two contacts, usable for either Mother Board or Daughter Board applications. It is recommended that the user buy two kits, if using connectors of two genders. The kits are not convertible after assembly.

Instructions:

DB-IO Test Probe -

Slide the insert back over the wire and crimp contact on. Follow crimping procedure below. Then snap the insert and contact assembly into the holder.

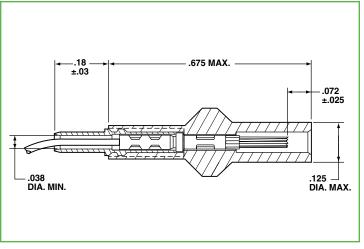
MB-PC Test probe -

Slide holder over wire and then crimp contact. Follow crimping procedure below. Slide the insert on the contact and seat it against the shoulder. Slide the holder forward and snap it onto the insert.

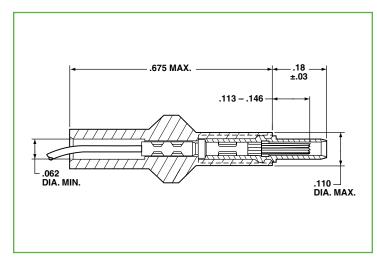
Crimping Procedure: Using accepted industry procedures, strip wire end to be terminated 1/8 to 5/32 inch. Care should be taken not to nick wire strands. Assemble the M22520/2-01 crimp tool and the M22520/2-27 positioner, and place tool selector in correct setting for wire size. Selected wire size must not have an insulation diameter more than .062 for MB-PC and not more than .038 for DB/IO.

AWG 22 24 26 28 **SEL** 3 2

Insert stripped wire end into contact wire well. Strands should be visible in wire well inspection hole. Bottom contact and wire assembly in positioner, and close handles of crimp tool to complete crimp. Handles will not open unless full crimping cycle has been completed.



DAUGHTER BOARD - INPUT/OUTPUT TEST PROBE



MOTHER BOARD - PC TEST PROBE

LRM (Line Replaceable Modules) Hi Speed/RF/Power Accessories

> VITA 60, 8

Hi Speed



Low Mating Force Connector Installation

USER APPLICATION INFORMATION

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Ξ

BRUSH CONNECTORS USER APPLICATION INFORMATION

The Brush B³ connector is a highly sophisticated, innovative low mating force device designed to provide a multiplicity or highly redundant number of contact sites for high density, high performance applications. Contact resistance is stable and low, approximately 1/3 lower than the most widely available contemporary two piece printed circuit card connector type. To maximize the B3 connector capability and assure the greatest potential reliability, several guidelines should be followed.

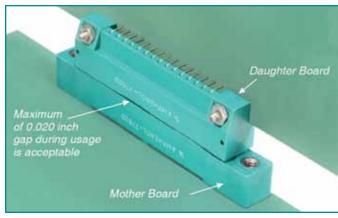
Ideally, connectors should be fully mated and not used as a packaging system tolerance absorber. Full mating occurs when the two molded thermoplastic contact housings (connector bodies) touch, plug skirt to receptacle shoulder over the entire length of the connector. However, manufacturing tolerances and user installation procedures must be considered and can be expected to prevent the "ideal" situation.

Connector bodies were intentionally designed to be non-rigid as permanent flexibility is necessary to allow compliance to user printed circuit cards, fixtures and card cages. Vibration and shock exposure, thermal excursions, contact repairability, and differential expansion characteristics further dictate the desirability of flexible connectors.

Amphenol drawing call-outs of part flatness to a 0.010 inch FIM (Total Indicator Reading - Full Indicator Movement) over the mating surface length is to be interpreted as in an "as used" condition. Rigid mounting of Mother Board (plug) parts to frames, multi-layer printed circuit boards or back panels should consider the need for the 0.010 inch maximum condition after soldering or solderless wrapping procedures.

Normal Mother Board parts in an unrestrained, unused condition may exceed the "as used" 0.010 inch reading at normal ambient or storage environments. Thermal cycling may further aggravate or adjust the condition. These parts present a profile from flat to a "smile" appearance when viewed from the side with the mating surface uppermost. (For example, see photo above). Normal positioning of this part on the Mother Board with slight restraint through use of mounting hardware or standard mounting bolts will automatically allow part compliance to the flatness condition of the board. Slight restraint is urged to allow for differential thermal expansion compensation during preheating and soldering operations. Final torquing or permanent fastening should be effected after cool down and thermal neutralization. Normal solderless wrapping procedures could ignore the differential expansion consideration.

Daughter Board connectors present the same flat to "smile" profile in a free state with the mating surface downward. The relief shelf can be used as a reference or guide when used with a straight edged Daughter Board or printed circuit board "page". Once proper positioning is verified and contact tails are solder fixed to the plated through holes, straightness will be permanently retained.



DAUGHTER BOARD AND MOTHER BOARD **FULLY MATED CONDITION**

Users are urged to monitor the quality of connector installation to optimize the mating of connectors.

During usage and when mated the worst case condition of the "as used" 0.010 inch maximum reading of both the plug and receptacle could cause a maximum gap between plug and receptacle moldings of 0.020 inch. This condition is well within the B³ product mated performance goals as our minimum effective electrical contact engagement has greater than a 100% safety factor. Users are urged to monitor the quality of connector installation to optimize the mating of connectors.

Input/Output connectors also normally exhibit a flat to "smile" profile with the mating surface downward. This "smile" condition self corrects once mated with the Mother Board counterpart and accessory locking screws are fastened. Again, checking for the 0.020 inch maximum gap is urged as a quality control monitor of user application techniques.

Amphenol has attempted to design in the ultimate for connector compliancy and self-correction during normal user installation procedures. The connector capabilities and inherent reliability rely in part on practical user procedures and application considerations. Refer to pages 93-95 for other installation instructions. And, refer to page 63 for correct mating of low mating force connectors. Amphenol board level engineers and product specialists are available to assist the user with application recommendations and processing guidance. Give us a call at 607-563-5011 and ask for board level technical assistance if further information is needed.

Amphenol Aerospace

USER APPLICATION INFORMATION

MOTHER BOARD CONNECTOR

MB connectors that are mounted on printed circuit boards should be installed on the board and held somewhat loosely, yet assuring all connector molding standoff pads contact the surface of the board, prior to soldering. There are several methods for attaching the MB connector to the board. Inserting locking/mounting bushings with an arbor press is shown in the top photo at right. Locking/mounting bushing accessory, two per connector, may be inserted into 0.185 inch diameter CSK holes at each end of the front of a MB connector body. (Part number to order locking/mounting bushing is 10-41196-3). Using a light arbor press or similar device, firmly press the knurled section of the bushing into the lower 0.122 inch diameter hole until the front of the bushing is flush with, or slightly below, the front surface of the MB connector. Refer to Figure 1 at right.

Make sure the bushing and hole axis are properly aligned. Avoid excessive force which may crack the back surface of the MB connector body.

The back of the locking/mounting bushing has a 4-40 UNC-2A THD to mount the connector. Fasten the connector with a suitable washer and nut. The front of the locking/ mounting bushing has a 4-40 UNC-2B THD which will mate with the locking screw accessory of an IO connector.

Alternate Mounting Variations for Mother Board Connector

A clinch nut (such as all ESNA 79NCFMA2-26 or equivalent may be pressed from the front, knurled end first, through the 0.185 diameter CSK into the 0.122 inch diameter hole at each end of the connector. An appropriate length 2-56 UNC-3A screw, washer, and nut may be used to mount the connector. Mounting forces should be applied to the bushing toward the rear of the connector. (See Figure 2 below)

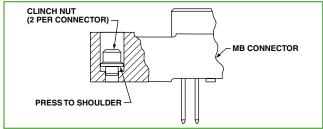


FIGURE 2: MB CONNECTOR WITH CLINCH NUT MOUNTING

When a Daughter Board is mated, use a 4-40 screw of appropriate length with a suitable washer under the head. Insert the screw from the front of the connector through the 0.185 inch diameter CSK into the 0.122 inch diameter hole at each end of the connector and fasten with a suitable washer and nut. (Refer to Figure 3 below). Torque to 5.5 pound-inch maximum after soldering operation has been completed.

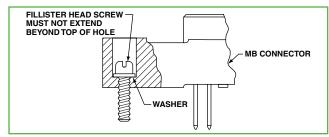
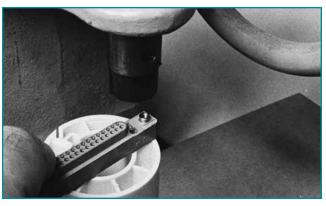


FIGURE 3: MB CONNECTOR WITH SCREW MOUNTING



LOCKING/MOUNTING BUSHING ACCESSORY INSERTED INTO MB CONNECTOR BODY

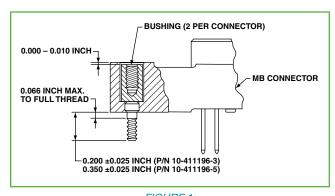


FIGURE 1: ASSEMBLY OF LOCKING/MOUNTING BUSHING INTO MB CONNECTOR

If MB connectors are to be wave soldered to printed circuit boards, the boards should be fixtured to maintain assembly straightness prior to and during the wave soldering process. (Refer to Figure 4 below).

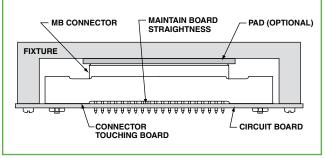


FIGURE 4: TYPICAL FIXTURE FOR SOLDERING **MB CONNECTORS**

LRM (Line Replaceable Modules Hi Speed/RF/Power

60

ectangula



Low Mating Force Connector Installation

USER APPLICATION INFORMATION

Solutions **Brush Contact** Pkg.

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/ Speed/RF/ Ξ

DAUGHTER BOARD CONNECTOR

DB connectors should be loosely held on the printed circuit board prior to and during wave soldering. Care must be taken to ensure that the board does not bow away from the center of the connector during the soldering process. Also, especially on long length daughter board connectors, care must be taken that the

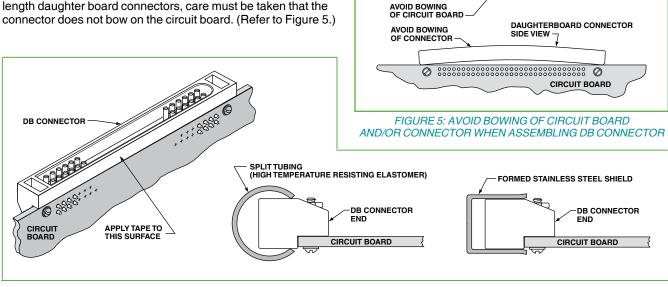


FIGURE 6: THREE TYPICAL MASKING APPLICATIONS FOR SOLDERING DB CONNECTORS

After soldering, mounting screws should be properly torqued.

For cosmetic purposes, the board side of the DB connector can be masked prior to wave soldering to protect it from heat exposure and solder wash. Acceptable masking may be accomplished with split tubing, stainless steel, or Mystik Tape #7010 or #7367. (Refer to Figure 6).

Printed wiring boards with DB connectors attached should be inserted into the housing until firmly seated. If possible, visual observation of the MB/ DB mated condition is recommended. The fully mated condition occurs when the DB connector skirt bottoms on the MB or PC connector shoulder along the full length. (Refer to Figure 7).

Printed circuit boards should be supported in card guides and locked in position when connectors are fully mated.

CIRCUIT DAUGHTER BOARD CONNECTOR MOTHER BOARD CONNECTOR CIRCUIT BOARD **FULLY MATED**

DAUGHTERBOARD CONNECTOR

CIRCUIT BOARD

FIGURE 7: MB CONNECTOR & DB CONNECTOR IN FULLY MATED CONDITION

PC CONNECTOR

connector.

The PC connector should be loosely attached to the printed circuit board prior to any soldering of contacts. Locking bushing accessory, two per connector, may be inserted from the back of a PC connector body into large mounting holes at each end. See photo at right. Part number to order locking bushing accessory for PC connectors is 10-411196-4. The 0.126 inch diameter cross holes in the locking bushing must be aligned with the 0.126 inch diameter cross hole in the PC connector body. These holes accept a 4-40 UNC-2A screw which should be long enough to allow mounting to the board. Fasten with a suitable washer and nut, making sure an appropriate washer is also under the head. The front of the locking bushing has a 4-40 UNC-2B thread which will mate with the locking bushing accessory of an IO



LOCKING BUSHING ACCESSORY INSERTED INTO PC CONNECTOR BODY

Amphenol Aerospace

USER APPLICATION INFORMATION

PC CONNECTOR, CONT.

The mounting surface to which the connector is applied should not extend forward of the shoulder of the PC connector. If the mounting surface does extend beyond the shoulder, a shim (minimum 0.005 inch thick) must be inserted between the connector body and the mounting surface. (Refer to Figure 8). After soldering, mounting screws should be properly torqued.

Fixturing of the PC connector and mounting surface may be desirable to assure straightness after wave soldering.

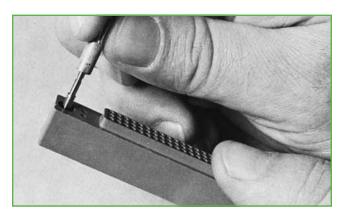
SHOULDER SHOULDER PC CONNECTOR PC CONNECTOR USE A ---0.005 INCH SHIM OR WASHER IF MOUNTING CIRCUIT BOARD CIRCUIT BOARD SUBFACE EXTENDS BEYOND SHOULDER OF CONNECTOR

FIGURE 8: PC CONNECTOR MOUNTING

INPUT/OUTPUT CONNECTOR

Use of mating hardware, such as locking screws, is recommended with I/O connectors. See photo at right. Locking screw accessory, two per connector, may be inserted into the large holes at each end of the back of an IO connector body. Part number to order locking screw accessory is 10-411196-4. By hand, press the locking screw firmly down into the cavity until it reaches a positive stop. The locking screw is then captivated in the retention system of the cavity. The front of the locking screw has a 4-40 UNC-2A thread which will mate with the locking bushing accessories of MB or PC connectors. (Refer to Figure 9 for I/O locking screw dimensions).

Should it be necessary to remove the captivated locking screw accessory, push the screw as far forward as possible. Using vise grip pliers to grasp the threaded end and pliers to hold the knurled end, apply torque until the locking screw breaks in two. Each half will then drop out.



LOCKING SCREW ACCESSORY INSERTED INTO IO CONNECTOR BODY

Alternate Mounting Variation for Input/Output Connectors

For fixed mounting, a 6-32 thread forming screw, type AB (MS5186) may be inserted through the mounting member and into the holes at each end of the connector body from the back. The screws must be used with suitable washers and must be of sufficient length to penetrate the connector body 0.350 inch. Care must be taken not to over-tighten the screws.

Visual observation of the mating of the MB connector to the I/O connector or the PC connector to the I/O connector is recommended. The fully mated condition occurs when the I/O connector skirt bottoms on the MB or PC shoulder along the full length. (Refer to Figure 10).

FULLY MATED CONDITION

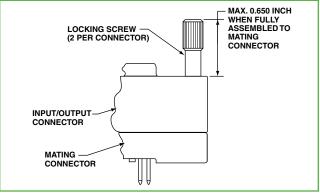


FIGURE 9: I/O LOCKING SCREW DIMENSIONS

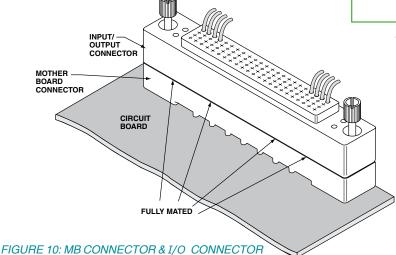
Printed circuit boards containing PC connectors that are mating with I/O connectors should utilize a holding device that is capable of locking the board in place to prevent back-off during use.

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60,

Rack & Panel Ruggedized

ctangular



Amphenol Ruggedized, Non-Floating, Brush Rack and Panel Connectors





Ruggedized, Non-Floating
Brush Rack & Panel Typical Markets:

- C4ISR/Tactical Radios
- Military Avionics



Amphenol® Ruggedized, Non-Floating **Brush Rack & Panel Connectors**

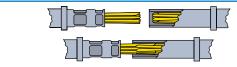
Amphenol Aerospace

FEATURES & OPTIONS

RUGGEDIZED, NON-FLOATING BRUSH RACK AND PANEL CONNECTORS

This connector series utilizes Amphenol's durable and reliable B³ contact system in a rugged, non-floating Rack and Panel connector.

BRUSH CONTACT TECHNOLOGY



Multiple strands of high tensile strength wire bundled together to form brush-like contacts. See Brush Contact Technology section of this catalog for further description.

Included in this series are digital and power/digital "hybrid" insert arrangements. The hybrid series utilizes Amphenol's high performance RADSOK® power contacts along with Amphenol's proven B3 contact. (See next page for more description of RADSOK® contacts.)

AVAILABLE FEATURES:

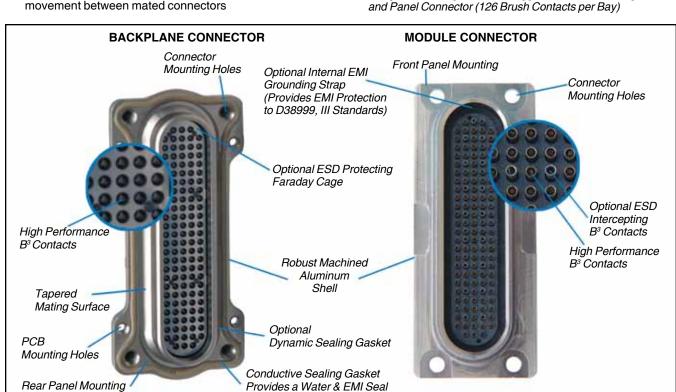
- High performance B3 brush contacts
- 0.100 inch x 0.100 inch square grid footprint
- Environmentally sealed at connector interface when mated (optional feature)
- Environmentally sealed connector mounting interface
- EMI protection is available at mounting surfaces and connector interface
- ESD protection is available allows use of Class 3 hardened chips (4KV max. voltage)
- Tapered mating surface provides near zero X & Y plane movement between mated connectors



Ruggedized, Non-Floating Brush Rack and Panel Connector (6 RADSOK® High Power Contacts and 74 Brush Contacts)



2 Bay Shell Configuration of Ruggedized, Non-Floating Rack



Hi Speed/RF/Power

VITA 60,

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Instal Conn

MD/



Amphenol® Ruggedized, Non-Floating **Brush Rack & Panel Connectors**

PERFORMANCE DATA / HYBRIDS WITH RADSOK®

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/Power

99 VME64x / 90,

High Density HSB3

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Coax/ Accessories/Install Docking Conn./

CONNECTOR PERFORMANCE:

Standard performance requirements for 126 pin signal version:

- Durability: 500 mating cycles
- Operating Temperature: -60° to 125°C
- Current Rating: 3 amperes Hot swap 1 ampere max. (load dependent) - non ESD protected version only.
- Insulation Resistance: 1 gigaohm minimum
- Dielectric Withstanding Voltage: 500V, 60 Hz RMS @ sea level, 300V, 60 Hz RMS @ 15,000 ft. elevation
- Solderability: J-STD-004, -005 & -006
- Salt Fog: EIA-364-26B, test condition B
- Humidity: EIA-364-31B, test method III
- Vibration: EIA-364-28B, test condition III
- Shock: EIA-364-27B, test condition G
- ESD Protection intercepts ESD events on signal pins from 4kV to 25kV

Consult Amphenol Aerospace, Sidney NY for more information on ruggedized, non-floating rack and panel connectors to fit your particular interconnect needs.



Custom 2-Bay Ruggedized, Non-Floating Brush Rack and Panel Connector (126 brush contacts per bay)



Standard 126 pattern in Ruggedized, Non-Floating Brush Rack and Panel Connector.

HIGH POWER IS ACHIEVED WITH HYBRID RACK AND PANEL CONNECTORS THAT UTILIZE AMPHENOL® RADSOK® CONTACTS



RADSOK® CONTACT TECHNOLOGY:

- Socket cylinder within female contacts has several equally spaced longitudinal beams twisted into a hyperbolic shape.
- As male pin is inserted, axial members in the female half deflect, imparting high current flow across the connection with minimal voltage loss.
- The hyperbolic, stamped grid configuration ensures a large, coaxial, face-to-face surface area engagement.
- Ideal for crimp termination applications requiring repeated mating cycles and high current with low milli-volt drop.

For more information on RADSOK® products from Amphenol: www:amphenol-industrial.com and www.radsok.com Contact Amphenol Aerospace Operations, Sidney, NY (Phone: 607-563-5011) or Amphenol Power Solutions, Fraser, MI

(Phone: 586-294-7400)

AmphenolLMD and LMS Modular Connectors

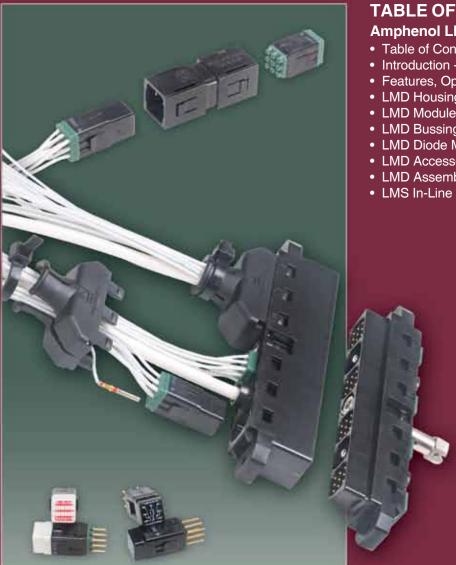


TABLE OF CONTENTS

Amphenol LMD & LMS Modular Connectors

| , | Table of Contents99 |
|---|--|
| , | Introduction - Features, Benefits, Performance 100 |
| , | Features, Options & Contact Data101 |
| , | LMD Housings - How to Order102 |
| , | LMD Module Contact Arrangements 103, 104 |
| , | LMD Bussing Modules |
| , | LMD Diode Modules & Relay Modules106 |
| , | LMD Accessories |
| , | LMD Assembly Instructions |
| , | LMS In-Line Splice Connector 110 |



LMD & LMS Typical Markets:

- Commerical Avionics
- Avionics Instrumention

Amphenol Aerospace



Amphenol® LMD and LMS Modular Connectors for Rack & Panel or Cable Attachment

INTRODUCTION: FEATURES, BENEFITS, PERFORMANCE

Solutions **Brush Contac**

Hybrids - Fiber Opiics/ Staggered/ Hi Speed/RF/Power GEN-X LRM (Line Replaceable Modules)

60,

High Density HSB3

| Hybrids - Signal/Power/ | Standard Brush Low Mating Force MIL-DTL-55302 Coax/Fiber Optics Accessories/Install Docking Conn./

Ruggedized



LMD Modular Connectors

The LMD Connector Series was designed by Amphenol Pyle-National to provide flexibility in the assembly of wire harnesses that are used in instrumentation and avionic control environments. The modular design of the LMD provides rack and panel or cable to cable attachment.

Design Features of LMD Connectors

- An LMD Connector is comprised of a housing, modules and contacts - each ordered separately, requiring assembly
- Lightweight housings are offered in two materials
 - standard black thermoplastic
 - high performance composite material for EMI shieldina
 - white thermoplastic nylon material with increased solvent resistance
- Four standard modules are available with the following contact arrangements: 1 #8, 4 #16, 9 #20,
- Modules are available in sealed and unsealed versions
- Linear module design may be used for rack and panel or cable to cable applications
- Bussing modules available to allow for a plurality of circuit network configurations without extra hardware
- Diode modules provide a current protection system for avionic instrumentation packages and eliminate the need for dedicated PC boards and other hardware
- Miniature relay modules can be added which eliminate the need for printed circuit boards and hardware



LMD Receptacle and Plug

LMD Benefits

- Reduces assembly and production costs
- Eliminates costly PC board and associated hardware
- Reduces inventory levels and associated costs
- Allows for a variety of circuit configurations
- Permits ease of circuit upgrading
- Facilitates equipment maintenance

LMD Performance Characteristics

| Temperature Rating | -55° C to +140° C (-67 ° F to +284° F) |
|-------------------------------------|--|
| Insulation Resistance (min.) | 5000 megohms initial: 1000 megohms after 96 hours humidity |
| Durability | 250 cycles (mating and unmating) |
| Vibration | Maximum discontinuity of one microsecond when subjected to sinusoidal vibration of 10 to 2000 Hz at 15 gravity units |
| Physical Shock | Maximum discontinuity of one microsecond when subjected to 1/2 -sine-wave transient shock of 50 gravity units with pulse duration of 11 milliseconds |
| Module Insertion & Removal Force | 5 lbs. maximum |
| Module Retention | 70 lbs. minimum |

LMS Modular Connectors

Supplementing the LMD connector family, Amphenol/Pyle National offers the LMS in-line splice connector; a low cost interconnects that incorporates the LMD modules and contacts.

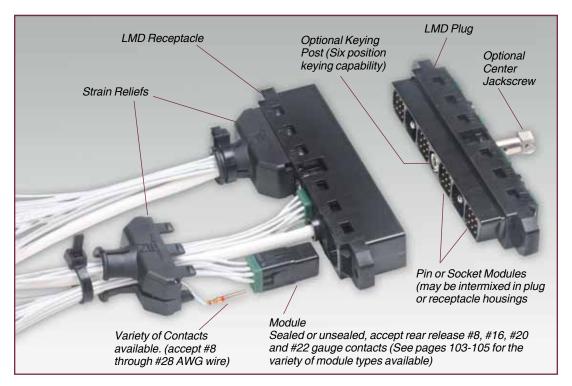
- Standard LMS splice connector 3-piece assembly with module removal tool access
- Tool-less splice connector 3-piece assembly with a push-button module release for easy module removal
- Two-piece bracket available for panel mounting
- Used in wire harness, instrument and equipment terminations and test points



LMS Tool-less Splice Connector

Amphenol Aerospace

FEATURES, OPTIONS & CONTACT DATA



LMD Features and Options

LMD's module options provide a mix of both active and passive devices within one connector. The features and options of this series describe the design flexibility in this connector series:

- LMD Standard components are molded of a U/L rated 94VO flame retardant, light-weight thermoplastic material. Alternate white nylon material (provides resistance to industrial oils and solvents) is available; consult Amphenol Aerospace for availability.
- The linear LMD connector may be used for rack and panel or cable-to-cable applications.
- Plug and receptacle housings may be front or rear panel mounted.
- Optional keying post provides six position keying capability.
- The optional center jackscrew provides ease of mating and unmating and insures high reliability under vibration.
- Cable strain reliefs are available for internal attachment. (See page 107).
- Variety of module types. Sealed and unsealed modules accept rear release #8, #16, #20 and #22 gauge contacts. Bussing, diode and relay modules available. PC tail contacts are also available; consult Amphenol Aerospace.
- A variety of contacts accept #8 through #28 AWG wire. Commercially available automated crimp terminating equipment may be used.
- Wired or unwired modules are rear inserted and held by two retention tines. With the aid of a front release tool, the modules are easily removed from the rear. (See pg. 107).
- Pin or socket modules may be intermixed in plug or receptacle housings.

Contact Data

| | | Contact Re | sistance | Dielectric | Max. |
|-----------------|--------------|------------------------|--------------------|---------------------------------------|--|
| Contact Size | Wire Size | Test Current (amperes) | Max. Millivolts | Withstand- ing Voltage AC (RMS) | Recommended Working Voltage AC (RMS) |
| 22 | 22 28 | 5.0 1.5 | 73 54 | 1800 | 600 |
| 20 | 20 24 | 7.5 3.0 | 55 45 | 1800 | 600 |
| 16 | 16 20 | 13.0 7.5 | 49 46 | 2300 | 900 |
| 8* | 12 14 | 23 17 | 42 40 | 2300 | 900 |
| 8 | 8 10 | 46 33 | 26 28 | 2300 | 900 |

| Contact Size | Wire Size | Contact Crimp Tensile Strength Lbs. Min. | Max. Wire Insulation | |
|-----------------|--------------|--|-------------------------|--|
| | 28 | 3 | | |
| 22 | 26 | 5 | .054 | |
| 22 | 24 | 8 | .054 | |
| | 22 | 12 | | |
| | 24 | 8 | | |
| 20 | 22 | 12 | .083 | |
| | 20 | 20 | | |
| | 20 | 20 | | |
| 16 | 18 | 30 | .103 | |
| | 16 | 50 | | |
| | 14 | 70 | | |
| 8* | 12 | 110 | .255 | |
| 8 | 10 | 150 | 055 | |
| 8 | 8 | 220 | .255 | |

^{*} with #12 wire well

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60,

ctangular



LMD HOUSINGS - HOW TO ORDER

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/

99 VME64x / VITA 60, 66

High Density Hi Speed HSB3

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Codx Accessories/Install Conn./

Rack & Panel Ruggedized Brush

Docking (

HOW TO ORDER LMD HOUSINGS

Housings are ordered separately from modules and contacts. Housings are available with 6 bays. Typical housing part number is shown as follows:

| | 1. | 2. | 3. | 4. | 5. | 6. |
|-------------------|-----|---------------------|-------------------|-------------------|-----------------------|---------------------|
| 1. Connector Type | | Housing Material | Number of Modules | Connector Type | Coupling Mechanism | Alternate Keying |
| LMD | LMD | -0 | 6 | Р | J | 3 |

2. Housing Material

| 0 | designates standard black thermoplastic |
|---|---|
| F | designates white thermoplastic nylon material - |
| • | consult Amphenol for availability |

3. Number of Modules

| 6 | cavities in plug or receptacle |
|---|--------------------------------|
| O | housing (available in 6 only) |

4. Connector Type

| Р | designates plug |
|---|-----------------------|
| R | designates receptacle |

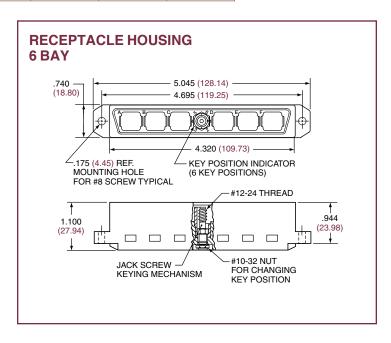
5. Coupling Mechanism

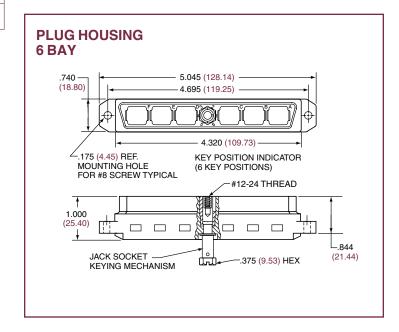
| J | designates jack-socket, rotating |
|---|---------------------------------------|
| K | designates jack-screw, fixed |
| Е | designates without coupling mechanism |

6. Alternate Keying

| 3 | 6 positions of keying post: 1, 2, 3, 4, 5 or 6 |
|---|--|
| 7 | designates keying hardware shipped unassembled for field assembly |
| 8 | designates no alternate keying hardware. Keyed through housing only. |

Ordering information on modules, contacts and strain reliefs is given on other pages of this LMD catalog section that follow.



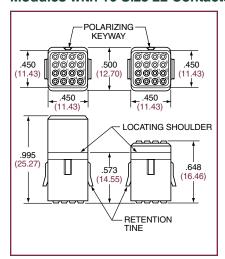


Amphenol Aerospace

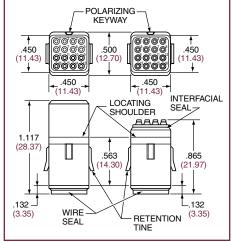
MODULE CONTACT ARRANGEMENTS

Modules and contacts for LMD connectors are sold separately from housings.

Modules with 16 Size 22 Contacts



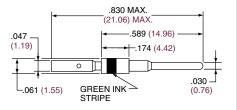
Socket Pin Module Module Part number: Part number: LMD-3003-S LMD-3003-P



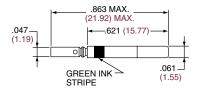
Sealed Socket Sealed Pin Module Module Part number: Part number: LMD-4003-S LMD-4003-P

Pin Contact Size 22

Part number: LMD-4022-36LJ

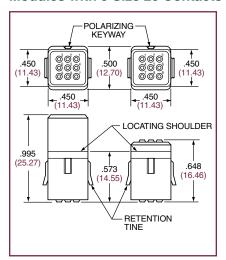


Socket Contact Size 22 Part number: LMD-4122-96LD

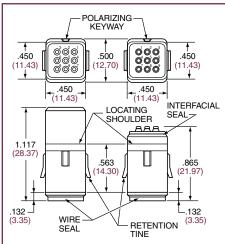


Contact Finish: Gold Plated

Modules with 9 Size 20 Contacts



Socket Pin Module Module Part number: Part number: LMD-3001-S LMD-3001-P

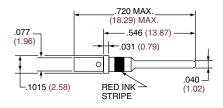


Sealed Socket Sealed Pin Module Module Part number: Part number: LMD-4001-P LMD-4001-S

Pin Contact Size 20 Part number: LMD-4020-96LD

Thermocouple

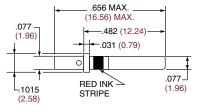
Part Number: LMD-4020-10()*



Socket Contact Size 20 Part number: LMD-4120-96LD

Thermocouple

Part Number: LMD-4120-10()*



Contact Finish: Gold Plated

*Complete thermocouple part number with code letter for desired contact material as follows:

P = Chromel R = Alumel

N = Constantan C = Copper

Solutions

GEN-X LRM (Line Replaceable Modules) Hybrids - Fiber Optics Hi Speed/RF/Power

Accessories

VITA VME 64x/ 60

High Density Hi Speed

standard Brush Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power/ Coax/Fiber Optics

Accessories/Install **Docking Conn.**

Rack & Pane Ruggedized

LMD/LMS

nrerconnects ectangular Other

Module part numbers are for black thermoplastic material. Consult Amphenol Aerospace for availability of any other module materials.



LMD Modular Connectors

MODULE CONTACT ARRANGEMENTS, CONT.

Solutions **Brush Contact** Pkg.

GEN-X

|Hybrids - Fiber Optics/ | Staggered/ LRM (Line Replaceable Modules) Speed/RF/ Ξ Accessories Options/

99 VME64× 60,

High Density HSB3 Ξ

Standard Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Codx Accessories/Install Conn./

Rack & Panel Ruggedized Brush

Docking (

LMD/LMS

Rectangular

(28.98).719 .819 (20.80) (18.26).156 (3.96) .156 (3.96) ौ .406 DIA. .406 DIA. RETENTION

.450

(11.43)

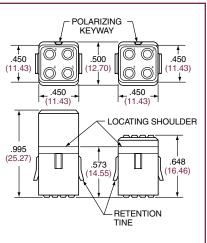
.450

(11.43)

1.141

from housings. Modules with 4 Size 16 Contacts

Modules and contacts for LMD connectors are sold separately



Socket Pin Module Module Part number: Part number: LMD-3005-S LMD-3005-P

KEYWAY

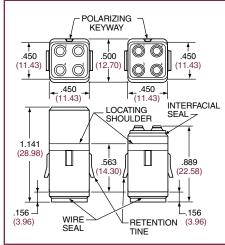
.500

(1270)

.450

LOCATING SHOULDER

(11.43)



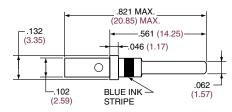
Sealed Socket Sealed Pin Module Module Part number: Part number: LMD-4005-S LMD-4005-P

Pin Contact Size 16

Part number: LMD-4016-96LD

Thermocouple

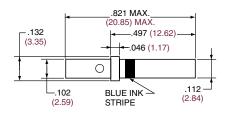
Part Number: LMD-4016-10()*



Socket Contact Size 16 Part number: LMD-4116-96LD

Thermocouple

Part Number: LMD-4116-10()*



Contact Finish: Gold Plated

*Complete thermocouple part number with code letter for desired contact material as follows:

P = Chromel

R = Alumel

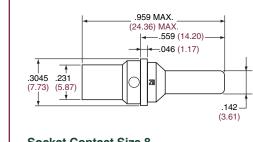
N = Constantan

C = Copper

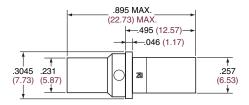
Modules with 1 Size 8 Contacts **Pin Contact Size 8** Part number: LMD-4008-36L OLARIZING

.450

(11.43)



Socket Contact Size 8 Part number: LMD-4108-36L



Contact Finish: Gold Plated

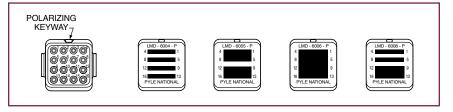
Module part numbers are for black thermoplastic material. Consult Amphenol Aerospace for availability of any other module materials.

Amphenol Aerospace

BUSSING MODULES - FOR PLURAL CIRCUIT NETWORKS

Bussing Modules were designed by Amphenol Pyle-National to provide a complete terminal junction system. This module conveniently and simply allows for a plurality of circuit network configurations, eliminated the need for "pigtails", termination strips or termination hardware. Nine bussing configurations are currently available* in either a standard or sealed module. Sealed modules have a rubber interfacial seal for increased environmental resistance. LMD Bussing Modules are currently available in black thermoplastic material.**

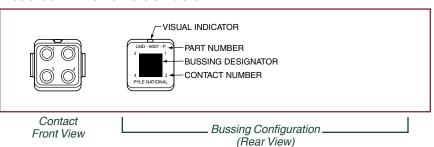
Modules with Size 22 Contacts



Modules with Size 20 Contacts



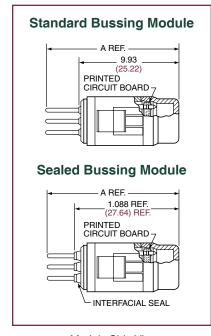
Modules with Size 16 Contacts



| LMD Bussing Module Part Number | | Contact | Bussing | A Def |
|-----------------------------------|------------------|---------|----------|---------|
| Standard Module | Sealed Module | Size | Circuits | A. Ref. |
| LMD-6001-P | LMD-6101-P | 20 | 3 | 1.326 |
| LMD-6002-P | LMD-6102-P | 20 | 2 | 1.326 |
| LMD-6003-P | LMD-6103-P | 20 | 1 | 1.326 |
| LMD-6004-P | LMD-6104-P | 22 | 4 | 1.256 |
| LMD-6005-P | LMD-6105-P | 22 | 2 | 1.256 |
| LMD-6006-P | LMD-6106-P | 22 | 1 | 1.256 |
| LMD-6007-P | LMD-6107-P | 16 | 1 | 1.326 |
| LMD-6008-P | LMD-6108-P | 22 | 3 | 1.326 |
| LMD-6009-P | LMD-6109-P | 20 | 3 | 1.326 |

^{*} For other circuit network configurations, consult Amphenol Aerospace.





Module Side View

Solutions

GEN-X

LRM (Line Replaceable Modules) Hybrids - Fiber Optics Hi Speed/RF/Power

Accessories

VITA 60, VME 64x/

Hi Speed

Brush Low Mating Force MIL-DTL-55302

|Hybrids - Signal/Power/ Coax/Fiber Optics

Accessories/Install **Docking Conn.**,

Rack & Pane Ruggedized

nterconnects ectangular

^{**} For availability of materials other than standard black thermoplastic, consult Amphenol Aerospace.



LMD Modular Connectors

DIODE MODULES & RELAY MODULES

Solutions **Brush Contact** Pkg.

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Power Hi Speed/RF/

99 VME64x 60,

High Density HSB3

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ **Fiber Optics** Codx

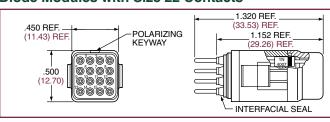
Accessories/Install Conn./ Docking

Rack & Panel Ruggedized Brush

Rectangular

Diode Modules provide a current protection system for Avionic instrumentation packages. Module configurations represent standard system and test application requirements.* Diode Modules eliminate dedicated PC boards and other assorted hardware. These modules are available in sealed type only, incorporating an interfacial seal for environmental protection, and are manufactured of black thermoplastic material.**

Diode Modules with Size 22 Contacts



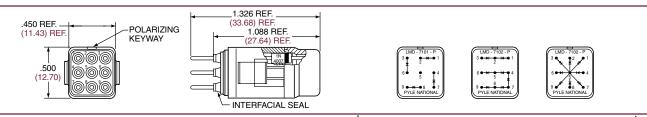


(Rear View)





Diode Modules with Size 20 Contacts



Contact Front View

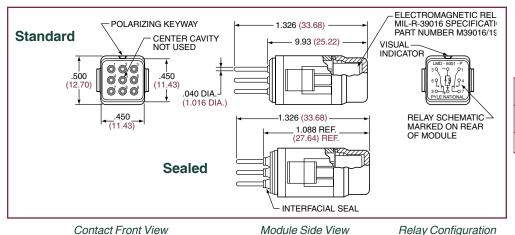
Module Side View

Diode Configuration (Rear View)

| LMD Diode Module Part Number | Contact Size | Circuit Description |
|---------------------------------|-----------------|---|
| LMD-7111-P | 22 | 8 discrete diodes |
| LMD-7112-P | 22 | 4 pair of diodes, each pair with common cathode |
| LMD-7113-P | 22 | 8 diodes with common cathode (pin #1) |
| LMD-7101-P | 20 | 4 discrete diodes |
| LMD-7102-P | 20 | 3 pair of diodes, ear pair with common cathode |
| LMD-7103-P | 20 | 8 diodes with common cathode (pin #5) |

Relay Modules incorporate an industry standard miniature relay per MIL-R-39016 specification part number 39016/19-036L* These modules eliminate the need for PC boards and all related hardware. These modules are available in unsealed and sealed types as shown below, and are manufactured of black thermoplastic material.**

RELAY MODULES



* For other circuit network configurations, consult Amphenol Aerospace.

** For availability of materials other than standard black thermoplastic, consult Amphenol Aerospace.



| LMD Relay Module Part Number | | | |
|----------------------------------|------------|--|--|
| Standard Sealed Module Module | | | |
| LMD-5001-P | LMD-5101-P | | |



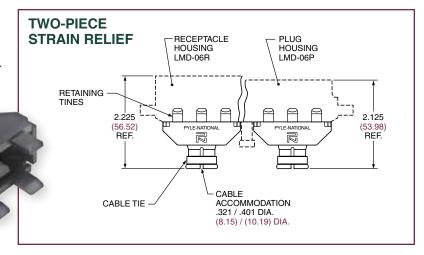
STRAIN RELIEFS, CRIMPING, INSERTION/REMOVAL TOOLS

Strain Relief for Internal Attachment of Wiring

Part number: LMD-5300-10A

Two-piece strain relief with cable tie included, for internal attachment to LMD 6 bay connector housings. Molded in black thermoplastic

material.



LMD TOOLS

| Crimping Tool for Size 22 Contacts | | Crimping Tool | Positioner | | |
|--|--------------------|---------------|--------------------|-----------------------|--|
| | | Part Number | For Pin Contact | For Socket Contact | |
| Amı | phenol/Pyle Number | TP-201401-H2 | TP-201409 | TP-201401-2-07 | |
| Milit | tary Number | M22520/2-01 | - | M22520/2-07 | |

| Wire Size | Crimp Tool Selector Setting |
|--------------|--------------------------------|
| 28 | No. 1 |
| 26 | No. 2 |
| 24 | No. 3 |
| 22 | No. 4 |

| Crimping Tool for Size 20 & 16 Contacts | | | |
|---|----------------------|------------------------------|-------------|
| | | Crimping Tool Part Number | Turret Head |
| | Amphenol/Pyle Number | TP-201354 | TP-201355 |
| | Military Number | M22520/1-01 | M22520/1-02 |

| Contact Size | Wire Size | Crimp Tool Selector Setting |
|-----------------|-----------|--------------------------------|
| | 24 | No. 2 |
| 20 | 22 | No. 3 |
| | 20 | No. 4 |
| | 20 | No. 4 |
| 16 | 18 | No. 5 |
| | 16 | No. 6 |

| Crimping Tool for Size 8 Contacts | | | |
|---|----------------------|------------------------------|-----------|
| | | Crimping Tool Part Number | Locator |
| | Amphenol/Pyle Number | TP-201393 | TP-201408 |
| | Military Number | _ | _ |

| For S | size 8 Contacts | | e 8 Contacts with 2 Wire Well |
|---------------------------------------|-----------------|--------------|----------------------------------|
| Wire Crimp Tool Size Selector Setting | | Wire Size | Crimp Tool Selector Setting |
| 10 | No. 5 | 14 | No.2 |
| 8 | No.7 | 12 | No.3 |

Contact Insertion/Removal Tools

| Contact Size | Color | Amphenol/Pyle Part Number | Military Part Number |
|-----------------|-------|------------------------------|-------------------------|
| 22 | Green | 10-538988-22D | MIL-I-81969/14-01 |
| 20 | Red | 10-538988-201 | MIL-I-81969/14-02 |
| 16 | Blue | 10-538988-016 | MIL-I-81969/14-03 |
| 8 | Red | TP-201406 | MIL-1-81969/29-02 |

LMD Module Removal Tool Part number: TP-201397

See photo on page 109 of module removal with this tool.

LMD tools can be purchased from Daniels Manufacturing Company.

Solutions

GEN-X

LRM (Line Replaceable Modules) Hybrids - Fiber Optics, Hi Speed/RF/Power Accessories

VITA 60, 66 VME 64x/

Brush Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power/ Coax/Fiber Optics

Accessories/Install. **Docking Conn.**,

Rack & Pane Ruggedized

nterconnects Rectangular Other

107



LMD Assembly Instructions

CRIMPING, INSERTION & REMOVAL OF CONTACTS

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/Power

,09

High Density

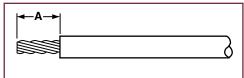
| Hybrids - Signal/Power/ | Standard Low Mating Force MIL-DTL-55302

Docking Conn./

Ruggedized

Amphenol recommends the tools listed on the preceding page for use with LMD connectors, and also the following procedures for wire preparation, crimping of wire and contact insertion and removal.

Wire Preparation



Strip wires to dimension "A" shown in table at right. Avoid cutting or nicking wire strands.

| Contact Size | Wire Size | Max. O. D. Insulation | Stripping Length Dimension "A" |
|-----------------------|-----------------|--------------------------|-----------------------------------|
| 22 | 20-24-26-28 AWG | .054 | .156 – .125 |
| 20 | 20-22-24 AWG | .083 | .185 – .155 |
| 16 | 16-18-20 AWG | .103 | .260 – .230 |
| 8 (with #12 crimp) | 12-14 AWG | .255 | .395 – .365 |
| 8 | 8-10 AWG | .255 | .395 – .365 |

Crimping Wire to Contacts

Follow steps 1-3 for proper contact crimping.



1. Fully insert wire into contact crimp pocket. Wire must be visible through wire inspection hole.



- 2. Insert contact into tool (use proper crimping tool as listed on preceding page). Crimp contact to wire. Tool will not open if contact is not fully crimped.
- 3. After crimping, wire should be visible through wire inspection hole.

Contact Insertion



Using proper insertion/removal tool as listed on previous page, slip wire into insertion end (colored end), placing crimp end of contact inside the slotted portion and contact shoulder against end of tool.



Align contact with the cavity at the rear face of the module. Carefully push the contact into the full depth of the cavity. Withdraw tool. A slight axial pull on the wire will confirm contact is locked in proper position.

Contact Removal



Snap the extraction end (white end) of the tool over the wire of the contact selected for removal. Carefully push the tool into the full depth of the contact cavity releasing the contact retaining collet. Hold the wire against the serrations on the tool, and withdraw the tool and the wired contact from the module.

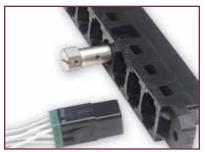
LMD Assembly Instructions

Amphenol Aerospace

MODULE INSERTION/REMOVAL & USE OF STRAIN RELIEF

Pin or socket modules, wired or unwired, can be inserted or intermixed in plug or receptacle housings. Select from standard module configurations shown on pages 103 & 104, or select the optional bussing, diode or relay modules offered, shown on pages 105 & 106. The next instructions illustrate the proper method of insertion and removal of modules within the LMD connector.

Module Insertion



Align the module with the proper cavity at the rear of the housing. The module keyway must be positioned to accept key in housing cavity. Carefully insert the module straight in to the cavity until fully seated and locked in place. A slight axial push on the front of the module or a pull on the cable bundle will confirm module is locked in proper position.



Select module to be removed and place the blades of removal tool into the removal slots at the front of the connector. Push the removal tool into the full depth of the cavity, releasing the module retention tines.



With the module removal tool fully inserted, push the extraction plunger to eject the module out of the rear of the connector.

Module Removal

LRM (Line Replaceable Modules Accessories

Hi Speed/RF/Power

Low Mating Force MIL-DTL-55302

Coax/Fiber Optics Accessories/Install Docking Conn.

ctangular

Assembly of Internal Strain Relief

Strain reliefs, if required, may be assembled to plug or receptacle connectors which have a full complement of modules installed. The following is instruction for assembling the internal attachment strain relief, part number LMD-5300-10A (see page 107).



Tape wire bundle in area of cable clamp, and build up diameter to approx. 3/8 inches, if required. Align self-locking tines of the strain relief housing with the cavities adjacent to each module. Push the strain relief housing into place until the self-locking tines snap and lock strain relief into position. Assemble opposite half of strain relief housing to connector and tighten tie-strap to provide clamping force on the wire bundle.

Opening Strain Relief to Service Modules and Contacts

Internal attachment strain reliefs may be opened to provide module and/or contact accessibility. To service connectors, first cut and discard tie-strap on strain relief. Open strain relief halves approx. 45° each by bending along integral flexible hinge. After servicing, close strain relief halves and install and tighten new tie-strap.

To completely remove strain relief from the housing in order to provide module access; first remove tie-strap, open strain relief halves 45° each, then remove module, then remove strain relief.





SIMPLE, LOW COST INTERCONNECTION DEVICE

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/Power

99 VME64x/ 60,

High Density HSB3

Hybrids - Signal/Power/ | Standard Brush Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install Docking Conn./ Ruggedized

LMS Modular Connectors

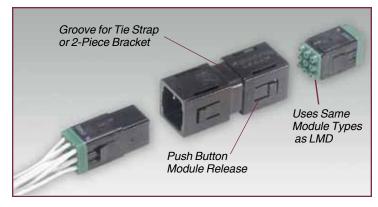
Amphenol's LMS in-line splice connector incorporates LMD modules and contacts. The LMS is a simple, compact, three-piece assembly which is used in the following applications:

- Instrument terminations
- Equipment terminations
- Wire harness terminations
- Test points

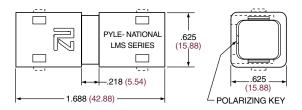
The LMS double-ended tool-less splice (part number LMS-01T-TL) incorporated an integral release mechanism for easy tool-less module removal. It is manufactured of black thermoplastic material* and is temperature rated at -55°C to +140°C (-67°F to +284°F). The LMS connector uses the same standard modules,

bussing modules, diode modules and/or relay modules as the LMD assemblies (see pages 103-105 for module and contact availability.

For availability of materials other than standard black thermoplastic, consult Amphenol Aerospace.



LMS Double-Ended **In-Line Splice Housing** Part Number: LMS-01T-TL

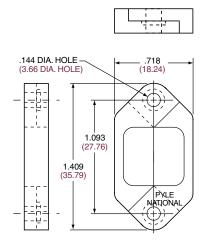


LMS Two-Piece Bracket for Panel Mounting





LMS Panel Mounting Bracket Part Number: LMS-B1-01



Amphenol Other Board Level and Rectangular Interconnects



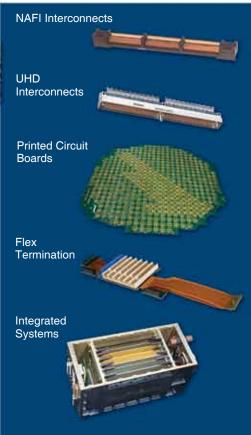


TABLE OF CONTENTS

Other Board Level and Rectangular Interconnects from Amphenol

| • Table of Contents 11 |
|--|
| Heat Sink & Metal Manufacturing 112, 113 |
| ARINC Rack & Panel, R27, R39, R58 Series |
| Connectors |
| Filter Rectangular Connectors, D-Sub, |
| Micro-D, Miicrominiature, Connectors 11 |
| Backplane Assemblies |
| • UHD Connectors |
| NAFI Connectors |
| Printed Circuit Boards |
| • Flex Termination |
| • Integrated Systems |
| Quadrax Hi Speed Contacts for PCB |
| Attachment |
| RADSOK® High Power Contacts for Board |
| Level Interconnects |
| High Frequency Contacts for Board Level |
| Interconnects |
| Cylindrical Interconnects for Printed |
| Circuit Board Attachment |
| Amphenol's Broad Product Offering of |
| This is a second of the second |

Quadrax Hi Speed Rectangular Contacts for PCB with RADSOI Attachment Contacts for I



Rectangular PCB Products with RADSOK® High Power Contacts for Industrial Applications

RADSOK®
Mil-Power Interconnects





- Medical Equipment
- Factory Automation
- IC Chip Testers
- · GPS Systems, Telecommunications
- Military & Commercial Avionics
- Military Vehicles





Heat Sink and Metal Manufacturing Capabilities

TO FIT CUSTOMER BOARD LEVEL NEEDS

Brush Contact Solutions

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/Power

99 VME64x/ 60,

High Density HSB3

Standard Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Fiber Optics Codx/

Accessories/Install Rack & Panel Ruggedized

Docking

Amphenol Aerospace has Extensive Heat Sink and Metal Machining Manufacturing Capability. Our experienced engineering group can design a custom heat sink to fit your board or work from your CAD models, assemblies, or step files.

Benefits of Amphenol's Design and **Manufacture of Custom Heat Sinks:**

- Amphenol's familiarity with major industry and military specifications.
- Amphenol has been leading the marketplace in LRM (Line Replaceable Module Connectors) and Rectangular Low Mating Force Connectors.
- Our LRM and VME64x products are used on major programs that include the following and more: F-35, F-16, F-15, F/A-22, F/A-18, B2, JTRS, EH101, Sincgars, ATACMS, M1A2 Tank, Grippen, F-117, Harpoon, LANTRIN, AH-64 APACHE, ASRAAM, ATFLIR
- This manufacturing and design excellence provides customers with the assurance that their custom or standard Amphenol rectangular connector will mate to their heat sink design.
- Amphenol is an ISO 9001 facility. Focus is always on quality with cost effectiveness and continuous improvement of processes.

Heat Sink Design Capabilities

- Provide manufacturing studies on prototype models, CAD models or drawing packages. (Consult Amphenol about acceptable CAD formats.)
- Provide rapid prototyping in house.
- Manufacture interface plates and other accessories; Design-in and install pins, studs and threaded inserts
- Provide extensive knowledge in geometric dimensioning and tolerancing techniques that can assist in optimizing your design to enhance manufacturability from the initial design phase (DFM).
- Provide ease of design for a variety of heat sink configurations and heat sink materials.
- Design flexibility for contact cavities for RF, digital I/O, high speed, fiber optic, power and low voltage data signal contacts.
- Provide in-process and final dimension checking

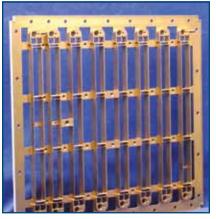


Heat Sink and LRM Connector Prototype



Variety of Heat Sinks manufactured by Amphenol





Interface Plate



Heat Sink and Metal Manufacturing Capabilities, cont.

Amphenol Aerospace

STATE-OF-THE-ART EQUIPMENT

At Amphenol, we have experience manufacturing a wide variety of custom heat sink designs. Our state-ofthe-art twin spindle machines with multi-axis control, unique fixturing, and indexing guarantee true position tolerancing on multiple faces of a machined piece. Other manufacturing features include glass scales and HSK heat shrink tool holders for greater accuracy. In addition: through-spindle probing for in-process checks, through-spindle high-pressure coolant system, single spindle mills with rotary tables, and 3-axis mills which supplement the twin-spindle machine operations. Other key benefits and features of Amphenol's manufacturing operations include:

- The ability to handle high or low run quantities.
- Machines set up and used exclusively for heat sink and related component milling.
- Temperature controlled environment to reduce the effect of thermal expansion/contraction.
- Capability to hold very precise positional, size and profile tolerances.
- Use of CAM software to translate solid models to machine instructions. This allows for a quick transition between design and manufacturing, and ensures parts are held to the proper dimensional
- CAM programs are optimized to each machine's capabilities which minimizes run time and maximizes quality.
- Parts can be selectively plated and selectively machined to suit customer requirements
- Amphenol has a preferred status with material suppliers which ensures timely procurement of raw materials.

Quality Assurance

- All dimensions are verified after machine setup, prior to production runs.
- Dimensions are checked by contact or optical Coordinate Measuring Machine (CMM).
- We import CAD/CAM files to our CMM's to guarantee parts are within the design's dimensional specifications.
- In addition to setup part checking, we also do 100% or sample part checking.



Heat sink and Metal Machining Production Area at Amphenol



Horizontal Manufacturing of Heat Sinks - Maximizes the Set-up and Production Efficiency for Metal Machining

Hi Speed/RF/Power

VITA 60,

Brush

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install Docking Conn.





ARINC Rack & Panel Connectors

FROM AMPHENOL CANADA DIVISION

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/ Hi Speed/RF/

60,

HSB3

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Coax/

Ruggedized

Docking

ARINC 404 & ARINC 600 Rack and Panel Connectors

Rack and panel ARINC 404 connectors meet or exceed MIL-C-81659 and ARINC Spec. 404. The ARINC 600 connector is the successor to the 404 for many avionic designs and offers lower mating force contacts, increased contact count and a front release, floating keying system. Other features of the ARINC 600 include:

- ARINC 600 connectors are a recognized standard rack and panel connector for aircraft applications with both environmental and non-environmental versions available.
- Designed to meet all relevant ARINC 600 connector specifications
- Front removable keying posts
- Up to 800 size 22 contact positions in one connector
- Contact options: standard contacts are power/ signal crimp rear release in sizes 12, 16, 20 and 22 in crimp or PCB; or shielded coax, concentric twinax, quadrax contacts; or fiber optics
- Filtered or non-filtered
- Waveguide connections

See Amphenol Canada* publication, ARINC 600 Rack and Panel Connectors, for complete information and how to order.

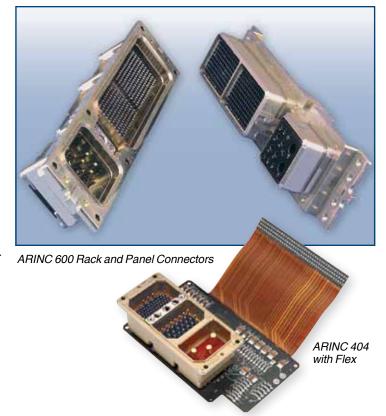
R27 Rack and Panel Connectors

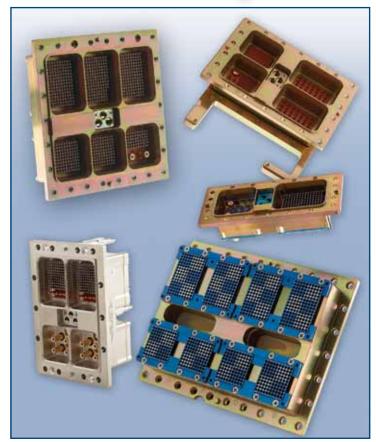
The R27 Series from Amphenol Canada is a robust rectangular connector designed to meet or surpass all the requirements of the ML-DTL-83527 specification and EN 3682 European Standard. Features of the R27 Series include:

- Well suited for harsh environments enhanced environmental sealing, robust and durable shells, EMI shielding spring
- Filtered or non-filtered
- Connectors, shells, inserts, termination modules and contacts are sold separately or fully assembled
- Interchangeable insert patterns with ARINC 600 models
- Contact options: standard contacts are power/ signal crimp rear release in sizes 12, 16, 20 and 22 in crimp or PCB; or shielded coax, concentric twinax, quadrax contacts; or fiber optics

See Amphenol Canada publication for R27 Series Connectors for complete information and how to order.







R27 Series Rack and Panel Connectors

Amphenol Aerospace

FROM AMPHENOL CANADA DIVISION

R39 Series with High Performance 38999 Features

The R39 series from Amphenol Canada* provides high performance in the severe environment demands of military specifications. Its lower profile translates into a smaller space-saving footprint. It delivers the same reliable, familiar benefits found in Amphenol's 38999 circular connectors: effortless installation, blind push-pull mating, extreme durability, quick mate. Features of the R39 Rectangular Connector series include:

- Low profile and space savings
- High density 127 position inserts or mixed inserts with power, RF or fiber-optics
- Uses same contacts and tooling as standard 38999 connectors
- Blind mate
- Rugged
- Filtered or non-filtered

See Amphenol Canada* publication R39 for complete information and how to order.

R58 Series Designed to Requirements of MIL-DTL-83733 and JN1122

The R58 series from Amphenol Canada* are high performance environmentresistant, rectangular connectors designed to exceed the requirements of MIL-DTL-83733 and to meet the EFA requirements of JN1122. Features of the R58 Series include:

- Well suited for hostile military aircraft applications where environment is an issue or shielding effectiveness and corrosion resistance is mandatory
- Available in 2 shell sizes with a variety of hard and spring mounting configurations
- Broad range of contact arrangements available from custom to 185 standard contacts
- Crimp contacts or PCB in sizes 12, 16, 20 and 22D. Coax, twinax, triax, quadrax and fiber optics also available
- Filtered version is also available (458 series)
- Shells are machined aluminum alloy with several finish options, including OD chromate over cadmium over electroless nickel finish.
- Insulators are high grade, plastic to MIL-M-14
- Silicone rubber is used for grommets, interfacial seals and peripheral seals See Amphenol Canada* publication, "Infinite Possibilities", Amphenol Rectangular and Filtered Products, for complete information and how to order.

R393 Series Low Profile Connectors with **High Speed RF Contacts**

A product line developed from the R39, the R393 contains 38999 Series III high speed RF contacts. These connectors have a low profile, light-weight design, and are ideal for a maximum number of high speed contacts using a small amount of space. Consult Amphenol Canada for more information and how to order. Features include:

- Qualified to BACC65BY and BACC65BW specifications
- Size 8 high speed RF 38999 contacts
- Environmental and filtered options available
- Multiple shell sizes, including custom geometry
- Captive hardware and backshells available

* Contact Amphenol Canada at: 605 Milner Avenue, Toronto, Ontario, Canada M1B 5X6 Phone: 416-291-4401 Fax: 416-292-0647 www.amphenolcanada.com



R39 High Performance Rectangular Connectors



R58 Series Rectangular Connectors



458 Series Filtered Rectangular Connectors



R393 Series Rectangular Connectors

LRM (Line Replaceable Modules Hi Speed/RF/Power

> VITA 60, VME 64x

Brush Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power, Coax/Fiber Optics

Accessories/Install Docking Conn.

Ruggeaizea

LWD/



Filter Rectangular Connectors, Micro-D, Microminiature & D-Sub Connectors

FROM AMPHENOL CANADA

Solutions **Brush Contac**

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/

90,

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Coax/ Conn./

Docking

Amphenol Canada Offers a Full Range of Rectangular Interconnects that **Provide Filter Protection**

Filter rectangular connectors are used to provide cost and space effective solutions to EMI problems in a wide range of military and commercial applications including avionics systems, satellites, missiles, communications, control systems and tempest equipment. Amphenol's unique solder-less construction which reduces stress on the ceramic elements and results in superior physical and thermal shock

Filtering is available in the following Amphenol Canada rectangular connectors:

- **ARINC 404 & ARINC 600**
- R39 Rectangular 38999
- 458 M83733 Style
- Micro-D
- D-Sub
- R27
- R64F Filtered Docking Connector
- D83 Compact D-Sub
- Filtered Headers and Custom Designs

D-Sub Connectors

Amphenol Canada supplies D-Subminiature Rectangular Connectors:

- SD308 Sealed D-Subs
- 308/481 Filtered D-Sub
- C308 Press-fit D-Subs (NAFI contact)

Features of D-Sub connectors include:

- Standard density and hi-density insert arrangements with pin and socket contacts
- Fixed screw machine contacts, available in solder cup, straight PCB, right angle PCB
- EMI filter D-Sub connectors use planar capacitors

Single piece machined aluminum allov Ferrite shell per QQ-A-225, plated in inductor accordance with Copper alloy 1) Electroless nickel per MIL-C-26074 or soldercup termination, gold 2) Tin per MIL-T-10727 or Monolithic 3) Cadmium per QQ-P-416 with clear plated per planar capacitor chromate or MIL-G-45204 Copper alloy 4) Gold per MIL-G-45204 over arrav crimp barrel electroless nickel per MIL-C-26074 termination, gold plated per MIL-G-45204. Beryllium copper contact springs, gold plated per MIL-G-45204. High temperature dielectric insert polyethersulfone thermoplastic per MIL-P-46185 Machined copper Beryllium copper EMI grounding alloy contact, gold plated per MIL-G-45204 Sealing and stress isolating elastomeric gaskets (3 places)



Custom Rectangular

Micro-D (M83513 Style) Connectors

A small connector solution which exceeds the requirements of military M83513, the Micro-D connector is provided by Amphenol. Features include:

- Rack and Panel mounting, or panel mount, cable mount or PCB mounting
- Used where space and weight are at a premium
- Wire harness, vertical and right angle PCB terminations
- Filtered or non-filtered
- Press-fit (NAFI contact)

Microminiature Connectors

Series 106 Microminiature Card Connectors were also designed to meet the requirements of MIL-DTL-83513. Features include:

- High density
- Board, panel and cable mounting for card-to-card and card-to-cable applications
- Employs a D-shape for correct mating. Jack screws and jack posts
- Wire harness, vertical and right angle PCB terminations

105 Series Microminiature Strip Connectors provided by Amphenol Phoenix* Features include:

- Single row strip line configuration
- Board, panel and cable mounting
- Guide pins, jack screws
- Wire harness, right angle PCB, surface mount terminations



D-Sub Rectangulars



Backplane Systems and Enclosures



FROM AMPHENOL BACKPLANE SYSTEMS DIVISION

For over 40 years, Amphenol Backplane Systems (ABS) has been a leading manufacturer of backplane assemblies and enclosures for military and aerospace applications. ABS combines a wide range of innovataive product and process technologies, advanced component manufacturing, and process control with highly focused, customer specific program management and testing at the assembly level. In addition, we provide expert design and unsurpassed applications engineering assistance at every step of the way.

Amphenol Backplane Systems production capabilities are the result of investment in new state-of-the-art equipment and software such as:

- Press-fit installation
- Through-hole soldering
- Automated hi-temp soldering
- Large-format surface mount soldering
- Aqueous cleaning
- Conformal coat (type UR and XY)
- Electrical test

For electrical testing, ABS offers Level I (bareboard), Level II (post assembly), and Level III (in-circuit) capabilities. Our industry leading large-format surface mount line with a capability of up to 29" X 60" circuits is well positioned for the largest backplanes in the industry as well as volume production of standard backplane products.

Our advanced manufacturing support software allows us to maintain our world class configuration control as well as create a state-of-the-art visual workplace to ensure

we are exceeding customer expectations. Our in-house capability for environmental testing such as Environmental Stress Screening (ESS) supports the increasing customer need for product assurance. We have also expanded our manufacturing capability to include:

- Enclosure and Value-added Assembly
- High-end Cable and Flex Assemblies
- Integrated Bus Systems
- Machined Enclosures and Metal Faceplates

In support of the continued need for leading-edge technology coupled with best cost manufacturing, we have established a qualified DoD Manufacturing Licensing Agreement (MLA) approved work center at our Amphenol Nogales, Mexico campus. This site is a duplication of our Nashua, New Hampshire manufacturing capability and will meet the needs of programs looking for a low cost option, while remaining in North America.

ABS MIL-Specificed qualifications include MIL-C-28859 (for components) and MIL-A-28870 (for assembled backplanes).

Amphenol's Solutions - The Pinnacle of Technology

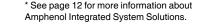
Some of the world's most demanding programs rely on Amphenol's packaging solutions, including:

- F-35
- F-22
- F-18
- MIDS/JTRS Radio
- Theatre High Altitude Air Defense Radar (THADD)
- AH-64 Apache
- 787 Dreamliner
- **Future Combat Systems**
- DDG-51
- DDG-1000

Integrated Systems Solutions* are found aboard commercial airliners, helicopters, Navy and Air Force fighters, C4I electronics, missiles, ground vehicles, Homelnad Security Systems, and Navy warships.



Backplane Incorporating LRM Modules with Brush Contacts and MT Fiber Optic Inserts



LRM (Line Replaceable Modules Hi Speed/RF/Power

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install Docking Conn.

> Rack & Panel Ruggedized

LMD/LMS







FROM AMPHENOL BACKPLANE SYSTEMS DIVISION

Brush Contac

Hybrids - Fiber Optics / Staggered LRM (Line Replaceable Modules) Ξ

VME64x / 60,

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Codx/ Conn./

Docking

UHD Series with Fork and Blade Contacts

Amphenol's wide range of board level interconnects also includes high density UHD (Ultra High Density) Series module and backplane connectors. These utilize fork and blade contacts in a staggered grid pattern for attachment to printed circuit boards. The staggered pattern is 80 contacts per inch, .025 pitch in 8 rows. They are SEM-E format and are qualified to: EIA 15-763, DESC 89065, IEEE 1101.1 to 1101.9. SU configurations are also available.

The UHD module connectors have surface mount blade contacts. and the mating UHD backplane connectors have solderless compliant press-fit tuning fork contacts. There are a wide range of high contact density patterns and the length and style can be tailored to meet customer requirements.

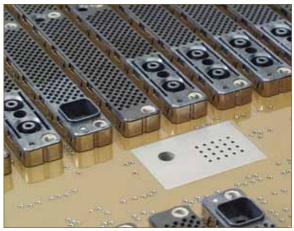
They are rigid pin terminated to the board or flex terminated to the board. Coax, fiber optics and power contacts can also be integrated into the connector configuration. Other options include EMI shielding and UHD interconnects can be provided in a stacking configuration. Module covers can be integrated into the connector system.

Extender board connector configurations are also available so that customers can have access to probe and test modules that are electrically connected to the backplane.

Standard configurations of UHD connectors are:

- 372 pin
- 300 pin multi-purpose (fiber optic, coax, power contacts can be intermixed
- 296 pin with 270V power contacts
- · 292 pin with coax
- 396 pin Futurebus + SEM-E
- 556 pin Futurebus + 10 SU (designs up to 680 contacts)

UHD Series connectors are provided by Amphenol Backplane Systems division of Amphenol. These connectors are a proven interconnect solution for advanced, high-reliability packaging requirements in markets of military and commercial aviation, space applications, shipboard applications, military vehicles, C⁴I electronics and ordnance. For more information see catalog 12-036 on-line at www.amphenol-abs.com.



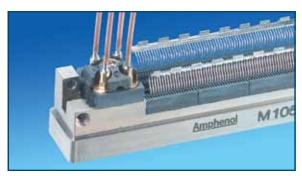
UHD Backplane Connectors on Board, Rigid Pin Termination, with Fiber Optics, Coax or Power Contacts



UHD Module Connector with Flex Termination



UHD Module Connector with Rigid Pin Termination



UHD Module Connector, Rigid Pin Termination plus Coax Contacts

NAFI Connectors with Fork & Blade Contacts, I/O NAFI with Rear Removable Crimp Contacts

Amphenol Aerospace

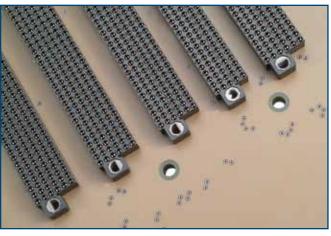
FROM AMPHENOL BACKPLANE SYSTEMS DIVISION

NAFI Series with Fork and Blade Contacts

Amphenol NAFI daughtercard and backplane connectors are another board level interconnect solution from Amphenol Backplane Systems. They provide a wide range of medium contact density patterns and meet MIL-C-28859 standards. Daughtercard termination is though-hole, using nickel/gold solder plated contacts. The mating interface is a blade contact which can be either parallel or perpendicular to the daughtercard.

The M Series of NAFI connectors are for through hole interconnection to printed circuit boards with rigid pin termination. Connector lengths and body styles can be tailored to meet specific needs. They are available with 2, 3, 4 and 5 rows of contacts, .100 X .100 pitch. Standard NAFI-style features such as guide pins and D-and V-shaped polarizing keys are available.

The FM Series of NAFI connectors are for surface mount interconnection to printed circuit boards with flex circuit termination. Up to 5 rows of contacts can be configured. The standard NAFI interface is maintained while the flexible circuit traces provide the link to the module. The flexible circuit termination allows for hand soldering or various automated surface mount soldering processes. To meet customer needs, connector lengths and body styles can be tailored, and the flex circuitry lengths and configurations also are designed per customer specifics. NAFI backplane connectors use solderless, compliant press-fit tuning fork contacts.



NAFI Backplane Connectors on Board



NAFI Daughtercard Connector with Flex Termination

I/O NAFI Series with Rear Removable Crimp **Termination**

Amphenol also provides an I/O NAFI interconnect that allows for terminating #22 and #26 gauge stranded wires to a backplane. It is available with 24, 36, 40 or 120 rear removable crimp-style blade contacts and includes captive hardware and polarizing features. The receptacle (tuning fork) connector can be placed where needed on either side of the backplane.

NAFI interconnects are used in military and commercial aviation, in space applications, shipboard and in military vehicles. For more information see catalog 12-036 from Amphenol Backplane Systems, on-line at www.amphenol-abs.com.



I/O NAFI Connector - for Terminating Stranded Wire to a Backplane

LRM (Line Replaceable Modules Hi Speed/RF/Power

Low Mating Force MIL-DTL-55302 Coax/Fiber Optics

Accessories/Install Docking Conn.

LMD/LMS





Printed Circuit Boards Capabilities

FROM AMPHENOL PRINTED CIRCUITS DIVISION

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules)

VITA 60,

| Hybrids - Signal/Power/ | Standard Low Mating Force MIL-DTL-55302

Docking Conn./

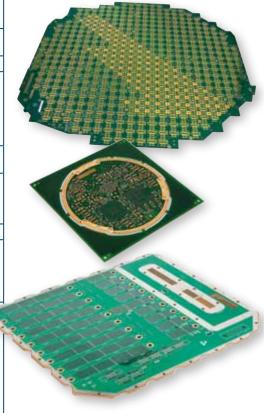
Amphenol Printed Circuits' (APC) Capabilities

Proven engineering and manufacturing expertise in the manufacture of printed circuit boards has been provided by the APC division of Amphenol for more than 25 years. Consistent quality and reliability for demanding high bandwidth systems and mission critical applications is met along with optimization in material handling. APC provides tightly controlled processes for prototype through productions of printed circuit boards. The chart below shows the Printed Circuit Board capability of Amphenol Printed Circuits.

| Circuit Board capability of I | Ampnenoi Printed Circuit | 3. | |
|------------------------------------|--|---|-------|
| DESIGN FORMATS | Mentor PADS | Cadence Zuken | |
| MANUFACTURING FORMATS | ODB++ (preferred) DXF Gerber 274X Autoplot Excellon | HPGLDPFGerber 274DIPC D 356 | |
| MAXIMUM PANEL SIZE | • 24" x 54" (609.5mm x 1371.5mm) • 30" x 44" (762.0mm x 1117.5mm) • 36" x 42" (914.4mm x 1066.8mm) | | |
| MAXIMUM PANEL THICKNESS | .500" (12.7mm) | | |
| LAYER COUNT | Up to 64 | | |
| INTERCONNECT FORMATION TYPES | Back drilled Dual Diameter Thru Hole* with conductive and | Blind (laser & med Electrically isolate Buried SMT | |
| | non-conductive via fill | | |
| ASPECT RATIO - DRILLED SIZE | Compliant holes > + 0.225 (drilled size 17:1) Via holes < .022 (drilled size 13:1) | | |
| FINISHED HOLE SIZE | Compliant Pinned: 0.018" (0.457mm) Via (A/R dependent): 0.008" (0.203mm) Buried Vias: 0.006" (0.152mm) Microvias (up to 3 electrical layers) (0.101mm) | | |
| BLIND VIA ASPECT RATIO | 1.25:1 | | |
| INTERNAL FEATURES | Lines: 0.003" (0.0762mm) .5 oz. copper Spacing: 0.003" (0.0762mm) .5 oz. copper Buried Resistors: No Buried Capacitance: No Minimum Core Thickness: 0.0001" (0.0254mm) | | |
| EXTERNAL FEATURES | • Lines: 0.004" (0.1016mm) .5 oz. copper • Spacing: 0.004" (0.1016mm) .5 oz. copper | | Ę |
| MATERIALS* | Low Tg FR4 (including phenolic cure) Getek Nelco 4000-13 & Nelco 4000-13 SI Rogers 4350/FR4 BT | High Tg FR4 (incl phenolic cure) Isola FR408 Rogers 4350 Polymide Cyanate Ester Megatron 6 | uding |
| COPPER PROCESSING | 1/4 oz 10 oz. copper (U/L | 7 oz.) | |
| IMPEDANCE SINGLE & DIFFERENTIAL | • ±10% • ±7.5% • ±5.0% | | |
| SURFACE FINISHES | Electrolytic Ni/Au HASL Immersion Tin Reflowed Tin/Lead | ENIGImmersion SilverOSP-Entek 106 | |
| CERTIFICATIONS | • IPC A 600 Class I, II & III • AS 9100-B / ISO 9001:2000 • ITAR Registration • MIL PRF 31032/2a | • IPC-6012 Class I, • ISO 14001:1996 • MIL-PRF-31032/II • MIL-P-55110 | |



Variety of Printed Circuit Boards from APC



For more information contact: Amphenol Printed Circuits, Inc. 91 Northeastern Blvd. Nashua, NH 03062 Phone: 603-324-4500 www.amphenolprintedcircuits.com

Please contact APC for the availability of additional materials.



TIGHT FITTING, SOLDERLESS TERMINATION TO BOARDS

Flexible and Rigid-Flex Capabilities

Amphenol Printed Circuits Division is a world leader in printed circuits, manufacturing highly complex Backplanes, Daughter-Cards, Flex and Rigid-Flex assemblies. Located for over 30 years in New Hampshire, APC has been delivering high quality circuits to the Defense and high-end Commercial markets, on time and within budget. While manufacturing a highly diversified product line specializing in technically challenging Rigid-Flex assemblies, we are also able to deliver low cost, lower layer count Flex and their assemblies, in today's pricecompetitive environment. Often an afterthought, Flex and Rigid-Flex allows designers to shrink packaging and think around corners. Below is a list of some of our capabilities.

| DESIGN FORMATS | DXF Gerber | • IGES • Pads | |
|--|--|--|--|
| PANEL SIZE | • Gerber • Pads • 12" x 18" (304.8mm x 457.2mm) • 18" x 24" (457.2mm x 609.6mm) • 24" x 24" (609.5mm x 609.5mm) • 24" x 36" (609.5mm x 914.4mm) • 24" x 54" (609.5mm x 1371.5mm | | |
| PANEL THICKNESS | .003"225" (0.0762mm - 5.715mm) | | |
| LAYER COUNT | 1-30+ | | |
| INTERCONNECT FORMATION TYPES | Thru Hole Buried Blind | SMT Filled Via's Dual Diameter | |
| FINISHED HOLE SIZE | Compliant Pinned (rigid zone only): 0.018" (0.457mm) Via (A/R dependent): 0.008" (0.203mm) Buried Vias: 0.006" (0.152mm) Microvias (up to 3 electrical layers): 0.004"006" (0.101mm) | | |
| BLIND VIA ASPECT RATIO | 1.25:1 | | |
| INTERNAL FEATURES (COPPER WEIGHT DEPENDENT) | • Trace: 0.003" (0.0762MM) • Spacing: 0.003" (0.0762mm) | | |
| MATERIALS | Polyimide - Std. Acrylic Polymide - FR Polymide - AP Polymide - GI Silver Epoxy Shielding | Copper Epoxy Shielding Soldermask FR-4/-24, 26 and 28 LCP FEP | |
| COPPER PROCESSING | 1/4 oz400" (10.16mm) | | |
| IMPEDANCE SINGLE & DIFFERENTIAL | • ±10% • ±7.0% | | |
| SURFACE FINISHES | HASL Reflowed Tin/Lead ODP-Entek 106 ENIG | Immersion Tin Immersion Silver Bright Tin Ni/Au | |
| ASSEMBLY CAPABILITIES | Full Turn-Key Thru-Hole - Wave & Manual SMT - Pick & Place | Wire-BondCrimpRoHS Compliance | |
| ASSEMBLY FINISHING | Conformal Coat - UR, Acrylic, Parylene, Flouropel Glop Top | | |
| TEST CAPABILITIES | Overmolding Impedance Testing Hi-Pot up to 5, 000 VDC 2,000 + Points per Circuit Insulation Resistance up to 1,000 VDC | Four Wire Kelvin .001 ohm to 1 ohm Bed of Nails Flying Probe Flex Cycling Environmental Functional Test | |
| CERTIFICATIONS | IPC 6013 Class I, II III: Types 1-5 MIL-P-50884 Types 1-5 ITAR Registration | AS9100 CertificationIPC-601UL94VOISO 9001:2000 | |

Flex circuitry is used in a wide variety of Amphenol board level and rectangular interconnects, as shown throughout this catalog:

Flex Circuitry with Rectangular Interconnects

and PC Boards

- Flex incorporated into LRM assemblies, (see pages 10, 25 and 31-35)
- ARINC 404 connector with Flex, (see page 114)
- UHD and NAFI connectors with Flex (see pgs. 118 & 119))

Flex Circuitry used in cStack™ Technology

Flex is a key component of the cStack™ technology used in Amphenol's high speed Gigastak™ and Digastak™ connectors, (see page 35). Amphenol InterCon produces cStack™ flex circuit assemblies that combine low cost termination with high speed, impedance controlled interconnection performance. The patented cStack™ stacking connector* used to terminate these assemblies provides high signal integrity interconnection technology, because of the connector's low (.048 inch) profile between flex and board. Flex circuitry for all cStack™ flex assemblies can be electrically and mechanically customized to exactly fit system specifications.



cStack™ Flex Circuits

LRM (Line Replaceable Modules) Hi Speed/RF/Power

VITA 60, 66

Low Mating Force MIL-DTL-55302

Coax/Fiber Optics

Accessories/Install Docking Conn.,

Rack & Panel

LMD/LMS

US patent number 6.176,707 and 6.217,342 Other patents pending.



THE LEADING CHOICE FOR PACKAGING SOLUTIONS

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules)

60,

Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/

Conn./ Docking (

Integrated System Packaging

Amphenol is the leading manufacturer of integrated system solutions for the military and aerospace markets. Amphenol Integrated Systems is the synergistic combination of key Amphenol divisions:

- Amphenol Backplane Systems
- **Amphenol Printed Circuits**
- Amphenol Aerospace Operations Board Level Products
- Amphenol Borisch

We have over 60 years of experience in the military and aerospace market and our commitment to the industry is exemplified in everything we do.

We understand the relationship between the interconnect, the printed circuit board, the backplane and the chassis, and we use that knowledge to provide complete solutions.

Amphenol Products- Peformance in the Most Demanding Environments

Amphenol can provide system solutions - everything you need inside and outside the box - including products that will perform in harsh environmental conditions: High performance interconnect products, printed circuit boards, backplane assemblies, flex circuitry, heat-sinks and metal enclosures.

Amphenol also provides value added assembly including bussing; full system assembly including chassis build and sub-system integration and testing.

Amphenol leads the industry by offering the elements necessary for success in the military and aerospace OEM supply chain:

- Design and Modeling
- Applications Engineering
- Fabrication
- Value-added Assembly

Coupled with the largest interconnect offering in the market, Amphenol supports all of your system-level needs.

The Engineering Edge

Amphenol Integrated Systems tackles problems such as PWB routing, signal integrity, mechanical robustness, and thermal reliability concurrently rather than independently by value-added applications engineering support. Solving complex packaging challenges depends on making sure that environmental, mechanical, and electrical factors are all addresses at the system-level. By taking this system-level perspective and focusing on these factors, Amphenol Integrated Systems is able to meet your program's most challenging packaging requirements. We are an extension of your design team, providing expert design and applications engineering assistance every step of the way to ensure program success.

See page 117 for information on Amphenol Backplane Systems capabilities for backplanes and advanced product systems and testing. See also pages 4 & 5 in the introduction section of this catalog for more information on Package Solutions,

Amphenol Aerospace at 800-678-0141, Amphenol Backplane Systems at 888-318-3553



Above: An example integrated system box that includes the following Amphenol interconnect products.

- Circulars: D38999 cylindrical connectors with MT fiber optics, RJ Field connectors
- Rectangulars: LRM interconnects, NAFI connectors, **UHD** connectors
- Rectangulars: ARINC 600 connectors, Micro-D Subminature connectors
- Rectangulars: HDB3 high density brush contact connectors
- Backplane Systems, Flex circuitry, metal enclosure



Quadrax High Speed Contacts for Board Level Interconnects

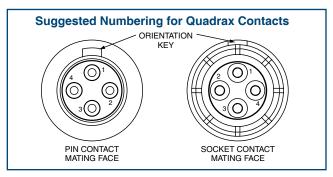
Amphenol Aerospace

HIGH SPEED QUADRAX, COMPLIANT PIN TERMINATION

Quadrax Contacts for Board Level Connectors

Amphenol supplies size 8 compliant pin Quadrax PCB contacts which provide several advantages for high data transfer rates, low power consumption and excellent EMI compatibility.

- Four strategically spaced inner contacts form two 100 or 150 Ohm matched impedance differential pairs
- Outer contact has rugged wall section for durability
- Same as used in cylindrical 38999 connectors See Amphenol Combined Circular Connector catalog/PCB contact section for more information on quadrax contacts and cables.



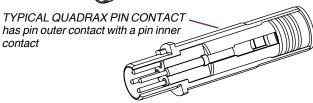
Quadrax Contacts are gold plated, crimp termination

Finish of mating contacts parts: supplied with 0.000050 min. gold over nickel on mating parts. Consult Amphenol for availability of other finishes.

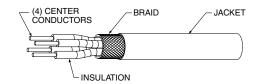
Quadrax Size 8 Contact Performance:

- Bandwidth: Up to 3 Gigahertz
- Data Rate: Exceeding 3 Gbits/sec.
- Voltage Rating: 500 Vrms max. @ sea level
- Dielectric Withstanding Voltage: 1000 VAC rms between all inner contacts @ sea level 500 VAC rms between inner and outer contacts @ sea level





Cable Illustration Quadrax Contact





Board Level Interconnects with Quadrax Contacts

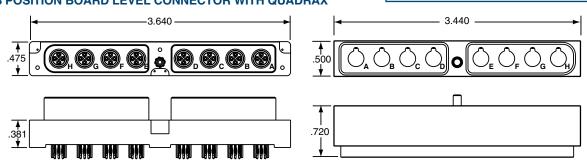
Compliant Pin Quadrax size 8 contacts are available with hole diameters:

.025 ±.002 PTH Quadrax contact

.040 ±.003 PTH shell grounding

Accomodates backplane .125 inch min. thickness (Consult Amphenol Aerospace for availability of additional connector configurations.)

8 POSITION BOARD LEVEL CONNECTOR WITH QUADRAX



Hi Speed/RF/Power

VITA 60,

Low Mating Force MIL-DTL-55302

Accessories/Install **Docking Conn.**

MD/



HIGH POWER APPLICATIONS

Brush Contact Solutions

LRM (Line Replaceable Modules) Hybrids - Fiber Optics/ Ξ

99 VME64x/ 60,

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Fiber Optics Codx/ Accessories/Install

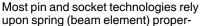
Conn./

Docking

Ruggedized

The RADSOK® Design:

RADSOK® technology is based upon a stamped and formed flat grid, uniquely twisted into a hyperbolic geometry to provide robust, high density contact to the mating pin



ties of the contact elements, which tend to weaken over time. Unlike most other pin and socket solutions, the RADSOK® also utilizes the tensile strength properties of the flat, high conductivity alloy grid. This provides the high normal forces required for conductivity while also providing large conductive surface area. Correspondingly low voltage drop and low temperature rise are also achieved while maintaining low insertion forces.

RADSOK® Key Features:

- Socket cylinder within female contact has several equally spaced longitudinal beams twisted into a hyperbolic shape
- · As male pin in inserted, axial members in the female half deflect, imparting high current flow across the connection with minimal voltage loss.
- The hyperbolic, stamped grid configuration ensures a large, coaxial, face-to-face surface area engagement.
- Ideal for crimp termination applications requiring repeated mating cycles and high current with low milli-volt drop.

RADSOK® Advantages:

High Reliability

Unique RADSOK® design and construction technology create an electrical contact interface that exceeds typical interconnect requirements. Applications in aerospace, medical, industrial, automotive, mining, offshore, and other harsh environments depend on high reliability of the Amphenol RADSOK® technology.

Low Contact Engagement/ Separation Forces The hyperbolic lamella socket contact construction distributes normal forces over a high percentage of the mating pin surface. This creates a smooth, even engagement effort. This force distribution also contributes to excellent performance in vibration applications with resistance to typical fretting corrosion.

Low Contact Resistance

The large interface area between the socket lamella and pin surface result in very low contact resistance, enabling the RADSOK® contacts' high current ratings compared to traditional power contact designs.

High Mating Cycle Durability

RADSOK® contacts with typical silver plating finishes have demonstrated survival of 20,000 mating cycles. Specialized plating and contact lubricants can extend cycle life to 200,000 matings or higher. Even with continuous exposure to harsh environmental abuse (salt, sand, and high humidity), RADSOK® contacts have been tested to maintain low contact resistance beyond 10,000 mating cycles.

The RADSOK® (RADial SOcKet) High Amperage, Low Insertion Force Electrical Terminal provides value to your purchasing, engineering, quality and manufacturing objectives.

RADSOK® Technology brings power to the board in a wide variety of applications such as:

- · Replacement of ring terminals (lugs) on threaded studs
- High current PCBs
- Communication towers
- Backplane power
- Uninterrupted power supplies
- Fuel cell connectors
- Hybrid electric vehicles
- AC inductive drive motors
- Power distribution modules
- Busbar terminations (plug-in hardware/modules)
- "Pluggable" breakers
- Battery terminals
- Contacts with RADSOK® technology give 50% more ampacity.
- RADSOK® contacts can be designed to fit any housing.
- Combinations of RADSOK® and high speed copper contacts in the same interconnect package

RADSOK® Technology brings high power to Military and Aerospace applications:

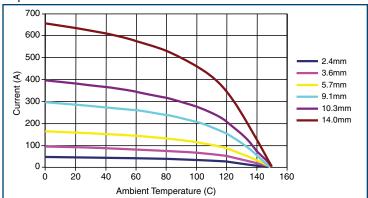
- Naval
- Military & Commercial Avionics
- Military Vehicles
- Missiles and Ordnance
- C4I

There are many developing military applications of RAD-SOK® technology - combinations of RADSOK® and high speed copper contacts in the same interconnect package has become a requirement in

rectangular as well as circular connectors.

RADSOK® Derating Chart - Temp. vs. Current

Based on single conductors in free air. Wire cross-section same size as pin contact cross-sectional area.





HIGH POWER FOR BOARD LEVEL CONNECTORS

Amphenol offers high current single-point connections for PC boards with RADSOK® contacts:

- PowerBlok™
- RADSERT™
- PGY™

The compact footprint design of these products can supply up to 120 Amp to the board which preserves surface area and provides more flexibility in board design.

- PowerBlok is available in a 3.0mm (70 AMPS) which is press-fit into the PCB
- RADSERT's are available in 2.4mm (35 AMPS) and 3.6mm (70 (AMPS). Offered in solder or press-fit styles, and available for many board thicknesses.
- RADSOK PGY's are available in 3.6mm (70 AMPS) and 5.7mm (120 AMPS). Pgy's are connected to the PDB through a solder reflow process.

Standard and Custom-Developed Solutions

- In addition to the various standard sizes of RADSOK® components, custom-developed solutions are also available. Amphenol has the global design, engineering and manufacturing resources to provide RADSOK® sockets pressed into busbars, crimped to cables, assembled into connectors, assembled into customer or Amphenol designed specialized electrical devices, or as stand-alone components. Amphenol also manufactures a full compliment of mating pin contacts for any application.
- Steady-state current capacities for standard RADSOK® products range from 50 amps to over 1000 amps.
- Amphenol connectors with RADSOK® contacts are offered with a variety of positive-locking features that insure and maintain fully-mated connections.
- Sealing (Sealtac $^{\text{TM}}$) and high voltage hot break options are available within the RADSOK® itself or within a very wide range of IP rated connector housings to provide environmental protection to the contact area.



RADSOK® contacts in LRM connectors: see page 30 of the LRM Section.

RADSOK® contacts in Ruggedized Rack and Panel Connectors - see pages 97 & 98.

Rectangular Connectors for High Power Applications

Amphenol's offers new Power Interconnects for your high power applications featuring RADSOK® technology. This multi-pole family of connectors is designed for 1750 VRMS or 2450 VDC at 400 A continuous.

Design features include:

- Easy to identify shell polarization
- Split-insert construction for ease of assembly of contacts
- Shell to shell bottoming for electrical conductivity/EMI protection
- Customer programmable keying and a latch with snap detent for solid engagement locking
- Also offered in a low profile right angle 90 degree back shell option with over mold capabilities, helping ease the strain of tight fitting applications.
- Offered in standard plating options as well as Durmalon finish*
- Consult Amphenol Aerospace for more information on cadmium alternative, Durmalon finish.







New Mil-Power Group of Connectors

LRM (Line Replaceable Modules Hi Speed/RF/Power

VITA 60

Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power, Coax/Fiber Optics

Accessories/Install Docking Conn.

Ruggedized

LMD/



RF High Frequency Contacts for LRM Interconnects

FROM SV MICROWAVE, AMPHENOL DIVISION

Pin Contact, SMPM RF

used in LRM Interconnects

Brush Contact Pkg. Solutions

|Hybrids - Fiber Optics/ | Staggered/ LRM (Line Replaceable Modules) Hi Speed/RF/ Options/ Accessories

99 VME64x/ 60,

High Density HSB3

Hybrids - Signal/Power/ | Standard Low Mating Force MIL-DTL-55302 Fiber Optics Codx

Accessories/Install Docking Conn./

Rack & Panel Ruggedized Brush

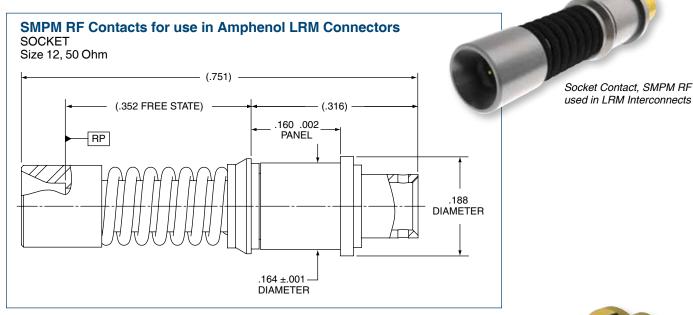
Rectangular

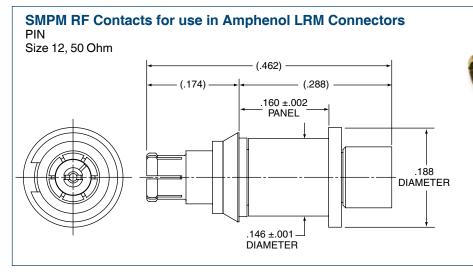
RF High Frequency Contacts Available for LRM Connectors

Amphenol divisions of SV Microwave and Amphenol Aerospace work together to provide connectors with high frequencies. SV Microwave division of Amphenol is a world leader in the design and manufacture of RF/MW connectors and components. They provide high frequency contacts with a unique "Float Mount" technology which allowsfor consistent microwave performance while maintaining tight mechanical tolerances. These contacts exhibit superior electrical performance and will maintain an accurate phase length when mated.

System design and platform needs have required smaller packaging with RF, D/C signal and power all in close proximity. SV Microwave's proven designs and blindmate technology have enabled the integration of multiport RF signals into single housings for gang mating capability. For more information, consult SV Microwave.*

SMPM contacts shown on this page are available for use in LRM interconnects (as shown in staggered grid patterns on page 29 in the LRM section of this catalog).





SV Microwave Phone: 561-840-1800

Website: www.svmicrowave.com

Cylindrical Interconnects for **Printed Circuit Board Attachment**

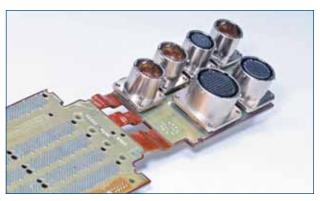
Amphenol Aerospace

PC TAIL OR COMPLIANT PIN TERMINATION

Cylindrical Connectors with PC Tail Contacts

Amphenol Aerospace is the leader in interconnect systems for aerospace/harsh environment applications. MIL-DTL-38999, MIL-C-26482, MIL-5015 as well as proprietary cylindricals can incorporate pc tail contacts. Jam nut (D hole) or panel mount (four hole) styles are solder mounted to printed circuit boards. PCB contacts are available in sizes 16, 20 and 22D.

Considerations must be made for length of PCB tails and any mechanical methods needed to stabilize the board. Commonly used tail diameters and tail stick-out dimensions are given in amphenol's combined Circular Interconnect Catalog/Printed Circuit Board section. PCB contacts are available in coax, twinax, triax and quadrax types. Cylindrical connectors can be attached to boards with flex termination which creates a self-locking terminal pad and eliminates the need for an additional interconnect to the PC board.



Cylindrical Connectors on PC Board

MIL-DTL-38999 with Special Stand-off Shell Configuration and Quadrax Contacts with PC Tails





Cylindrical Connectors with Flex Circuitry. Flex is designed to geometrically fit the shape of the connector to board package. It is strong and rigid, yet the circuit body is highly flexible.



Alignment Discs on PC tail connectors provide simplified installation of contacts to PCB boards.

Cylindrical Press Fit Connectors with Compliant Pins

MIL-DTL-38999 connectors can be supplied with compliant pin contacts for solderless mounting on printed circuit boards. Compliant pins engage the plated through holes in the PC board without the need for soldering which provides for high speed, low cost board assembly. They accommodate boards with minimum of 0.090 inch thickness and 0.040 ±.003 plated through holes. Both pin and socket contacts are available in any MIL-DTL-38999 Series I, II or III insert pattern having contact size 16, 20 or 22D. Connectors are sold completely assembled or are available fully pre-assembled on a blackplane assembly.

For more information on Press Fit connectors see Amphenol's Combined Circular Interconnect catalog/Options & Others sect., on-line at www.amphenol-aerospace.com.



Cylindrical Connectors with Compliant Pin Contacts

LRM (Line Replaceable Modules Hi Speed/RF/Power

Low Mating Force MIL-DTL-55302 |Hybrids - Signal/Power/ Coax/Fiber Optics

Accessories/Install Docking Conn.





Amphenol's Broad Product Offering of Circular Interconnects

SOLUTIONS FOR A WIDE RANGE OF APPLICATIONS

Brush Contac

|Hybrids - Fiber Optics/ |Staggered/ LRM (Line Replaceable Modules) Speed/RF/ Ξ

VME64x/ 60,

HSB3

Brush Low Mating Force MIL-DTL-55302 Hybrids - Signal/Power/ Fiber Optics Codx

Conn./

Docking

Ruggedized

When you come to Amphenol, you are connected to the broadest range of interconnection products in the marketplace.

Amphenol has become the leader in interconnection products through its long history of engineering expertise for product solution solving. The Board Level and Rectangular interconnects shown in this catalog are only a part of the very wide range of interconnects - there is also the whole world of Circulars. Many of the military specifications for cylindrical connectors were developed by Amphenol, formerly Bendix Connector Operations, at the Sidney, NY facility.

Circular Products offered by Amphenol Aerospace include the major mil-spec cylindricals and commercial versions, plus many interconnects that meet special applications. Also within the circular interconnect offering from Amphenol, through the Amphenol Industrial Operations division, are many commercial types of connectors.

The following list is a brief overview of Circular Interconnect products offered by Amphenol Aerospace and Amphenol Industrial Operations. There is a vast array of products - many series within MIIspecs, and many options within series.

- MIL-DTL-38999 Series I, II and III
- MIL-DTL-5015 and 5015 types: 97 Series Commercial, GT and ACA-B Reverse Bayonet Connectors
- MIL-DTL-26482, Series I & 2
- MIL-DTL-83723. Series III
- Hermetic Connectors
- Filter Protection Connectors
- Fiber Optic Connectors
- **Energy Suppression Connectors**
- High Power Connectors including products with RADSOK® high amperage contacts
- Plus a wide range of contacts for circulars:
 - Standard 500 cycle and 1500 cycle, M39029 type power and signal
 - Crimp for front or rear release connector applications
 - Solder type fixed contacts
 - · High frequency shielded coax, triax, twinax contacts
 - · High-speed quadrax and differential twinax contacts
- Wide range of Accessores for use with Circular Connectors



We invite you to see our Combined Circular Interconnects catalog online at www.amphenol-aerospace.com

Also see the many circular interconnects offered by Amphenol Industrial Operations at www.amphenol-industrial.com.

Contact us at: Phone: 607-563-5011 or 800-678-0141



The product breadth of Amphenol for Circular Interconnects represents the Amphenol expertise to provide almost any interconnection solution. Amphenol divisions work in synergy to provide our customers with what they need for their specifc performance requirements. It is this synergy and team driven effort that has made Amphenol the interconnect technology provider of choice to industry leading companies throughout the world. With a broad and diverse product portfolio, Amphenol is able to develope the right solutions for our customers across the diverse segments of the rapidly expanding electronic market.

Military/Aerospace Markets - Amphenol Circular Interconnects

Military Avionics.. Commercial Avionics.. Military Vehicles.. UAVs.. Missiles/Missiles Defense.. Naval.. C41.. Space

Industrial Markets - Amphenol Circular Interconnects

Rail/Mass Transit.. Process Control.. Wind & Solar Energy... Heavy Equipment . . Telecommunications . . Power Generation . . Petro-Chemical